

Features

- Register-configurable CapSense® controller
 - Does not require firmware or device programming
 - Ten-button solution configurable through I²C protocol
 - Ten general purpose outputs (GPOs)
 - GPOs are linked to CapSense buttons
 - GPOs support direct LED drive
- SmartSense™ Auto-Tuning
 - Maintains optimal button performance even in noisy environment
 - CapSense parameters dynamically set in runtime
 - Saves time and effort in device tuning
 - Wide parasitic capacitance (C_P) range (5 pF–40 pF)
- Advanced features
 - Robust sensing even with closely-spaced buttons – Flanking Sensor Suppression (FSS)
 - User-configurable LED effects
 - On-system power-on
 - On-button touch
 - LED ON Time after button release
 - Standby Mode LED Brightness
 - Buzzer Signal Output
 - Supports analog voltage output (requires external resistors)
 - Attention line interrupt to host to indicate any CapSense button status change
 - CapSense performance data through I²C interface
 - Simplifies production-line testing and system debug
- Noise Immunity
 - Specifically designed for superior noise immunity to external radiated and conducted noise
 - Low radiated noise emission
- System diagnostics of CapSense buttons – reports faults at device power-up
 - Button shorts
 - Improper value of modulating capacitor (C_{MOD})
 - Parasitic capacitance (C_P) value out of range
- EZ-Click™ Customizer tool
 - Simple graphical configuration options
 - Dynamically configures all features
 - Configurations can be saved and reused later
- I²C interface
 - No clock stretching
 - Supports speed of up to 100 kHz
- Wide operating voltage range
 - 1.71 V to 5.5 V – ideal for both regulated and unregulated battery applications

- Low power consumption
 - Supply current in run mode as low as 23 μA^[1] for each button
 - Deep sleep current: 100 nA
- Industrial temperature range: –40 °C to +85 °C
- 32-pin Quad Flat No-leads (QFN) package (5 mm × 5 mm × 0.6 mm)

Overview

The CY8CMBR2110 CapSense Express™ capacitive touch sensing controller saves time and money, quickly enabling a capacitive touch sensing user interface in your design. It is a register-configurable device and does not require any firmware coding or device programming. In addition, this device is enabled with Cypress's SmartSense Auto-Tuning algorithm which eliminates the need to manually tune the user interface during development and production ramp. This speeds the time to volume and saves valuable engineering time, test time, and production yield loss.

The EZ-Click Customizer tool is a simple graphical interface for configuring the device features, through the I²C interface. One configuration can be used to configure multiple samples in different boards.

The CY8CMBR2110 CapSense controller supports up to ten capacitive sensing buttons and ten GPOs. The GPO is an active low output controlled directly by the CapSense input making it ideal for a wide variety of consumer, industrial, and medical applications. The wide operating range of 1.71 V to 5.5 V enables unregulated battery operation, further saving component cost. The same device can also be used in different applications with varying power supplies.

This device supports ultra low-power consumption in both run mode and deep sleep modes to stretch battery life. In addition, this device also supports many advanced features, which enhance the robustness and user experience of the end solution. The key advanced features are Noise Immunity and Flanking Sensor Suppression (FSS). Noise Immunity improves the immunity of the device against radiated and conducted noise, such as audio and radio frequency (RF) noise. FSS provides robust sensing even with closely-spaced buttons. FSS is a critical requirement in small form-factor applications.

Power-on LED effects provide visual feedback to the design at system power-on. Button-controlled LED effects provide visual feedback on a button touch. These effects improve the aesthetic value of the end product. Buzzer Signal Output provides audio feedback on a button touch. System diagnostics test for design faults at power-on and report any failures. This simplifies production-line testing and reduces manufacturing costs. CapSense data output through I²C gives critical information about the design, such as button C_P and signal-to-noise ratio (SNR). This further helps in system debug and production-line testing.

Note

1. 23 μA per button (4 buttons used, 180 button touch per hour, average button touch time of 1000 ms, buzzer disabled, Button Touch LED Effects disabled, 10 pF < C_P of all buttons < 20 pF, Button Scan Rate = 541 ms, with power consumption optimized, Noise Immunity level Normal, CSx sensitivity Medium).

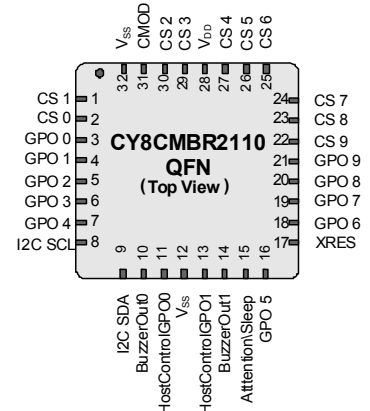
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Pinout

Table 1. Pin Diagram and Definitions – CY8CMBR2110

| Pin | Label | Type ^[2] | Description | If Unused |
|-----|------------------|---------------------|---|-----------------|
| 1 | CS1 | AI | CapSense button input, controls GPO1 | Ground |
| 2 | CS0 | AI | CapSense button input, controls GPO0 | Ground |
| 3 | GPO0 | DO | GPO activated by CS0 | Leave open |
| 4 | GPO1 | DO | GPO activated by CS1 | Leave open |
| 5 | GPO2 | DO | GPO activated by CS2 | Leave open |
| 6 | GPO3 | DO | GPO activated by CS3 | Leave open |
| 7 | GPO4 | DO | GPO activated by CS4 | Leave open |
| 8 | I2C SCL | DIO | I ² C Clock line | N/A |
| 9 | I2C SDA | DIO | I ² C Data line | N/A |
| 10 | BuzzerOut0 | DO | Buzzer output pin 0/GPO controlled by register settings | Leave open |
| 11 | HostControlGPO0 | DO | GPO controlled by Register settings | Leave open |
| 12 | V _{SS} | P | Ground | N/A |
| 13 | HostControlGPO1 | DO | GPO controlled by Register settings | Leave open |
| 14 | BuzzerOut1 | DO | Buzzer output pin 1/GPO controlled by register settings | Leave open |
| 15 | Attention/Sleep | DIO | Used to control I ² C communication, device power consumption, and device operating mode | V _{DD} |
| 16 | GPO5 | DO | GPO activated by CS5 | Leave open |
| 17 | XRES | DI | Device reset, active high, with internal pull down | Leave open |
| 18 | GPO6 | DO | GPO activated by CS6 | Leave open |
| 19 | GPO7 | DO | GPO activated by CS7 | Leave open |
| 20 | GPO8 | DO | GPO activated by CS8 | Leave open |
| 21 | GPO9 | DO | GPO activated by CS9 | Leave open |
| 22 | CS9 | AI | CapSense button input, controls GPO9 | Ground |
| 23 | CS8 | AI | CapSense button input, controls GPO8 | Ground |
| 24 | CS7 | AI | CapSense button input, controls GPO7 | Ground |
| 25 | CS6 | AI | CapSense button input, controls GPO6 | Ground |
| 26 | CS5 | AI | CapSense button input, controls GPO5 | Ground |
| 27 | CS4 | AI | CapSense button input, controls GPO4 | Ground |
| 28 | V _{DD} | P | Power | N/A |
| 29 | CS3 | AI | CapSense button input, controls GPO3 | Ground |
| 30 | CS2 | AI | CapSense button input, controls GPO2 | Ground |
| 31 | C _{MOD} | AI | External modulating capacitor, recommended value 2.2 nF (±10%) | N/A |
| 32 | V _{SS} | P | Ground | N/A |

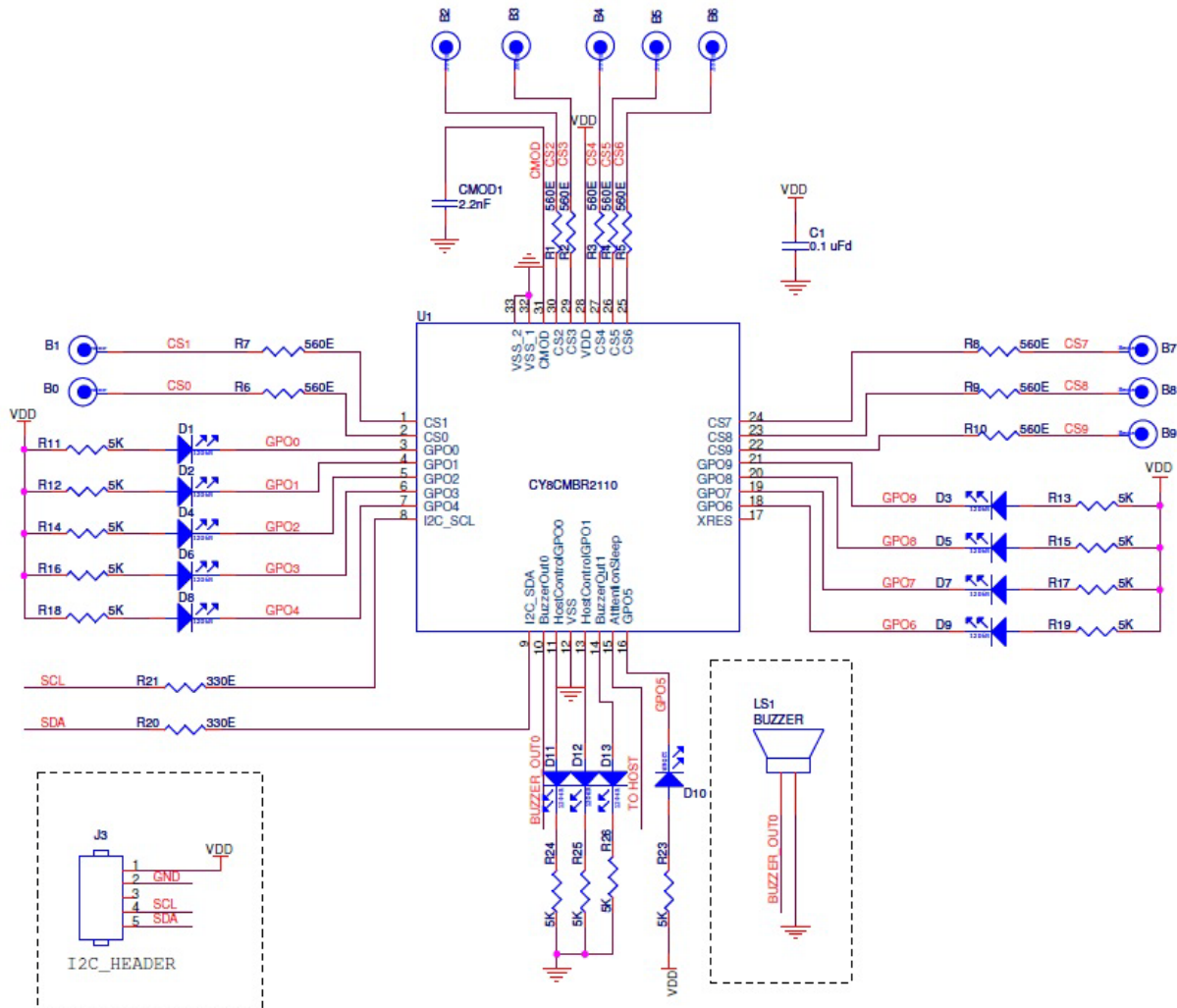

Note

- AI – Analog Input; DI – Digital Input; DO – Digital Output; DIO – Digital Input / Output; P – Power

Typical Circuits

Schematic 1: Ten Buttons with Ten GPOs

Figure 1. CY8CMBR2110 Schematic 1

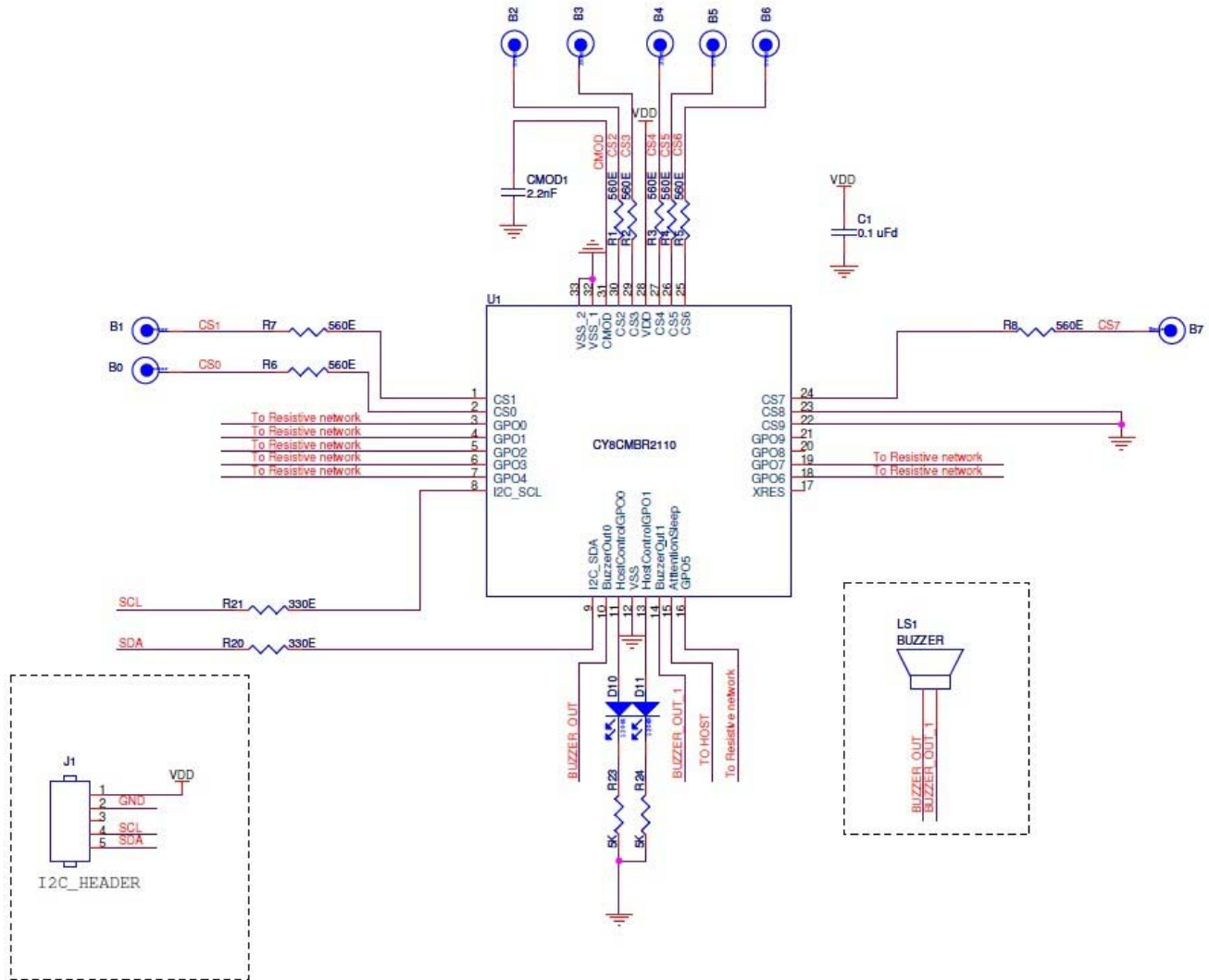


In Figure 1, the device is configured in the following manner:

- CS0–CS9 pins: 560 Ω to CapSense buttons
 - Ten CapSense buttons (CS0–CS9)
- GPO0–GPO9 pins: LED and 5 kΩ to V_{DD}
 - CapSense buttons driving 10 LEDs (GPO0-GPO9)
- C_{MOD} pin: 2.2 nF to ground
 - Modulating capacitor
- XRES pin: Floating
 - For external reset
- BuzzerOut0 pin: To buzzer
 - AC buzzer (1-pin)
 - Buzzer second pin to Ground
- BuzzerOut1 pin: LED and 5 kΩ to Ground
 - Used as Host Controlled GPO
- HostControlGPO0, HostControlGPO1: LED and 5 kΩ to Ground
 - Two Host Controlled GPOs
- HostControlGPO0, HostControlGPO1: Floating
 - Host Controlled GPOs disabled
- I2C_SDA, I2C_SCL pins: 330 Ω to I²C header
 - For I²C communication
- Attention/Sleep pin: To host
 - For controlling I²C communication, power consumption, and device operating mode

Schematic 2: Eight Buttons with Analog Voltage Output

Figure 2. CY8CMBR2110 Schematic 2



In Figure 2, the device is configured in the following manner:

- CS0–CS7 pins: 560 Ω to CapSense buttons; CS8, CS9 pins: Ground
 - Eight CapSense buttons (CS0–CS9)
 - CS8 and CS9 buttons not used in design
- GPO0–GPO7: To external resistive network
 - Eight GPOs (GPO0–GPO7) used for Analog Voltage Output
 - GPO8 and GPO9 not used in design
- C_{MOD} pin: 2.2 nF to ground
 - Modulating capacitor
- XRES pin: Floating
 - For external reset
- BuzzerOut0 and BuzzerOut1 pins: To AC buzzer
 - AC Buzzer (2-pin)
- HostControlGPO0, HostControlGPO1 pins: LED and 5 kΩ to ground
 - Two Host-controlled GPOs
- I2C_SDA, I2C_SCL pins: 330-Ω to I²C header
 - For I²C communication
- Attention/Sleep pin: To Host
 - For controlling I²C communication, power consumption, and device operating mode

Configuring the CY8CMBR2110

EZ-Click Customizer Tool

The EZ-Click Customizer tool is a simple and intuitive graphical user interface for efficiently configuring the device. It takes all the required parameters and configures the device accordingly, using I²C communication. The configuration can be saved locally on the computer and later re-used by the tool for another design. The tool can also be used to generate a configuration file, which can be used through Bridge Control Panel (refer to [AN2397 - CapSense Data Viewing Tools](#)) or by the host (in the host firmware) to configure the device. For more details, refer to the [EZ-Click Customizer Tool User Guide](#).

Configuring the Device using a Host Processor

CY8CMBR2110 can be configured by a Host processor. The advantages of using a host processor to configure are listed below.

- In-system configuration - no need to take the device (chip) out of the board.

- Run time configuration - modifying the features dynamically by a host processor.

To configure the device using a Host processor, there is a comprehensive list of APIs and these APIs are to be called from the Host processor in a specific order. These APIs use I2C communication to configure the device features. You can download the source code from <http://www.cypress.com/?rID=74590>.

For more details refer to [CY8CMBR2110 CapSense® Design Guide](#).

Third-party Programmer

To configure large number of devices, Cypress recommends a third-party vendor to perform automated programming on the devices. For this, you must give the hex file of your configuration, generated by EZ-Click Customizer Tool to Hilo systems (a third-party programmer).

Contact <http://www.hilosystems.com.tw/en/index.aspx> for further information.

Device Features

CapSense Buttons

- Supports up to 10 CapSense buttons
- Ground the CSx pin to disable CapSense button input
- Connect a 2.2-nF ($\pm 10\%$) capacitor on the C_{MOD} pin for proper CapSense operation
- For proper CapSense operation, ensure C_P of each button is less than 40 pF

SmartSense Auto-Tuning

- Supports auto-tuning of CapSense parameters
- Does not require manual tuning; all parameters are automatically tuned by the device
- Reduces the design cycle time
 - No manual tuning
- Ensures portability of the user interface design
- Compensates printed circuit board (PCB) variations, device process variations, and PCB vendor changes

General Purpose Outputs (GPOs)

- GPOx pin outputs are strong drive^[3]
- The GPOx is controlled by the corresponding CSx
- Active low output – supports sinking configuration for LEDs (see Figure 3)
- If CSx is disabled (grounded), then the corresponding GPOx must be left floating
- After power-up on the GPOx, a 5-ms pulse is sent after 350 ms (if Noise Immunity level is “Normal”) and 1000 ms (if Noise Immunity level is “High”), if the CSx fails the System Diagnostics

Figure 3. Example of GPO0 Driven by CS0

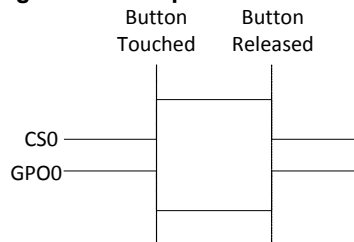


Table 2. CY8CMBR2110 Advanced Features

| Feature | Benefits |
|---|---|
| Toggle ON/OFF | Button retains state after touch (ON/OFF) |
| Flanking Sensor Suppression (FSS) | Avoids multiple button trigger in a design with closely-spaced buttons |
| Noise Immunity | Improves device immunity to external noise (such as RF noise) |
| Automatic Threshold | Configurable finger threshold for different noise settings |
| LED ON Time | Gives an LED effect on button release |
| Button Auto Reset | Disables false output trigger when the conducting object is placed close to the button |
| Power-on LED Effects and Button Touch LED Effects | Provides visual effects to design at power-on and button touch |
| Standby Mode LED Brightness | Used for LED backlighting |
| Latch Status Read | No button touch missed by host processor |
| Attention/Sleep Line to Host | Provides device interrupt to host. Host can use this to read data from the device. Also controls device operating mode. |
| Analog Voltage Support | External resistors can be used with GPOs to generate analog voltage output |
| Sensitivity Control | Maintains optimal button performance for different overlay and noise conditions |
| Debounce Control | Prevents false trigger of buttons |
| Buzzer Signal Output | Provides audio feedback on button touch |
| Host Controlled GPOs | GPO pins, which can be controlled by the host processor through I ² C |
| System Diagnostics | Supports production testing and debugging |
| Low-Power Sleep Mode and Deep Sleep Mode | Low power consumption |

Note

3. When a pin is in strong drive mode, it is pulled up to V_{DD} when the output is HIGH and pulled down to Ground when the output is LOW.

Toggle ON/OFF

- Toggles the GPO state at each button touch (see [Figure 4](#)).
- Use for mechanical button replacement (for example, wall switch).
- Toggle feature can be enabled on each CapSense button individually.

Flanking Sensor Suppression (FSS)

- Allows only one button to be in the TOUCH state at a time. You can distinguish TOUCH states for closely spaced buttons.
- If a finger contacts multiple buttons, only the first one to sense a TOUCH state turns ON.
- Also used in situations when a button can produce opposite effects. For example, an interface with two buttons for brightness control (UP or DOWN).
- FSS can be enabled for each button individually. This helps to enable FSS only for those buttons which are closely spaced. For example, if a design has ten buttons with six buttons closely-spaced, FSS can be enabled just for those six buttons.
- FSS action can be explained for the following scenarios:

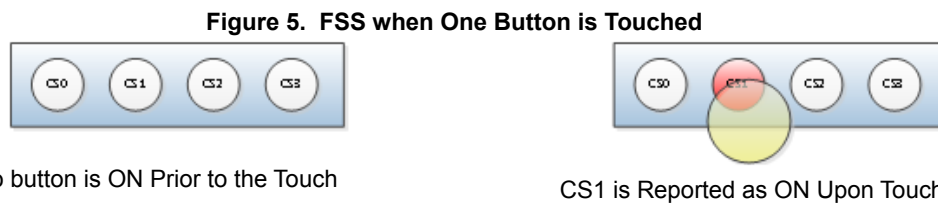
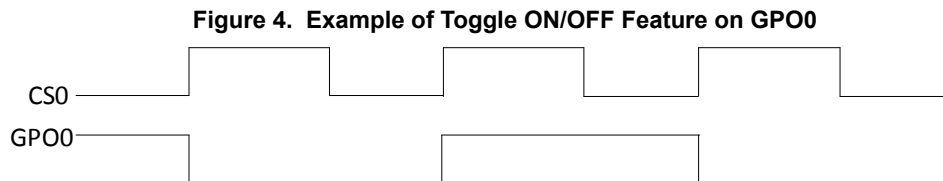
1. When only one button is touched, it is reported as ON (see [Figure 5](#)).
2. When more than one button is detected as ON, and previously one of those buttons was touched, then the button touched previously is reported as ON (see [Figure 6](#)).

Noise Immunity

- Improves the immunity of the device against external radiated and conducted noise.
- Reduces the radiated noise emission.
- Possible Noise Immunity levels are “Normal” and “High”.
- Select “High” only in a high-noise environment because it increases device power consumption and response time.

Automatic Threshold

- Button Signal is compared to Finger Threshold for GPO output
- Finger Threshold is configurable; valid range is 50-245 counts
- Used to determine button ON/OFF state for different noise conditions
- You can configure Finger Threshold to be set automatically
- To learn more about Finger Threshold, refer to Section 2.3 in [Getting Started with CapSense](#)



LED ON Time

- Provides a variable amount of LED ON time (upto 5100 ms) after a button is released.
- The GPOx is driven low for a specified interval after the corresponding CSx button is released (see Figure 7).
- When a button is reset (refer to Button Auto Reset on page 10), LED ON Time is not applied on the corresponding GPO.
- Applicable to the GPO of the last button released

- In Figure 8, GPO0 goes high prematurely (prior to LED ON Time expiration) because CS1 button is released. Therefore, the LED ON Time counter is reset. Now, the GPO1 remains low for LED ON Time after releasing CS1.
- LED ON Time can range from 0-5100 ms.
- LED ON Time resolution is 20 ms.
- LED ON Time is disabled if Toggle ON/OFF is enabled.

Figure 7. Example LED ON Timing Diagram on GPO0

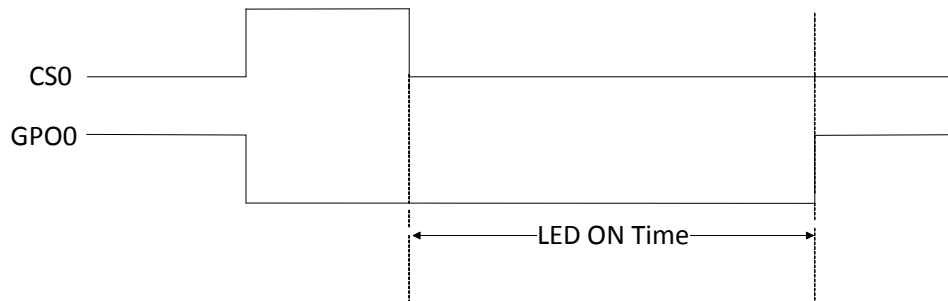
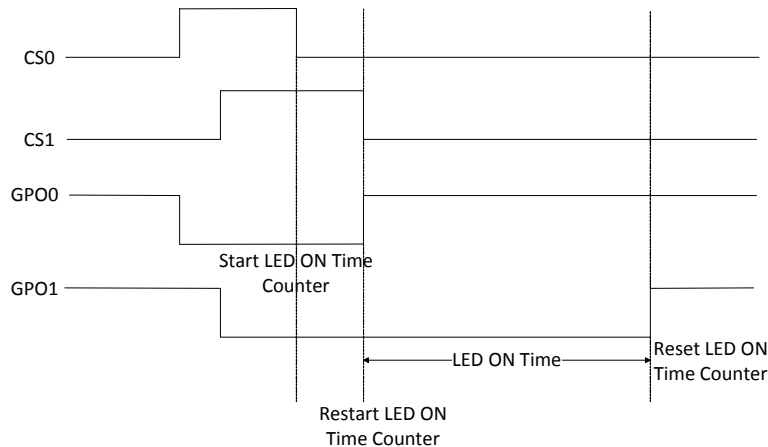


Figure 8. Example LED ON Timing Diagram on GPO0 and GPO1



Button Auto Reset

- Prevents a stuck button due to a metal object placed close to that button.
- Useful when the button is kept ON only for a specific period of time.
- If enabled, button is considered OFF after the Button Auto Reset period, even though the button continues to be touched. See [Figure 9](#).
- Auto Reset period can be set to 5 or 20 seconds.

Power-on LED Effects

- Provides a visual effect at device power-up.
- After power-on, all the LEDs show dimming and fading effects for an initial time.
- Seen on GPOx when CSx is enabled.
- The GPOs are configured in groups to have the same parameters.
- The groups are:
 - GPO1, GPO2, GPO3
 - GPO4, GPO5, GPO6
 - GPO7, GPO8, GPO9
- GPO0 can be configured separately. Useful in designs with a special use for CS0 button, such as a power button.
- All CapSense buttons are disabled during this time.

- If any CapSense button (CSx) fails the Power-on Self Test, then these effects are not seen on the corresponding GPOx.
- To know more about Power-on Self Test, refer [System Diagnostics on page 17](#).
- The following parameters are set for LED effects:
 - Low brightness – Minimum LED intensity
 - Low-brightness time – The time period for which the LED remains in a low-brightness state
 - Ramp-up time – The time period during which the LED transitions from low brightness to high brightness
 - High brightness – Maximum LED intensity
 - High-brightness time – The time during which the LED stays in a high-brightness state
 - Ramp-down time – The time it takes the LED to go from high brightness to low brightness
 - Repeat rate – The number of times the effects are repeated
- Brightness levels can range from 0 to 100 percent.
- The time range can be 0 to 1600 ms.
- High-brightness level must be more than low-brightness level.
- The effects are seen after the device initialization time from power-on. This time is less than 350 ms (if the Noise Immunity level is “Normal”) and less than 1000 ms (if the Noise Immunity level is “High”).
- The pattern can be set to occur sequentially or concurrently on all the GPOs (see [Figure 10](#) and [Figure 11 on page 11](#)).
- During Power-on LED Effects, the device ACKs I²C communication but all write commands are ignored. The Host can only read Operating mode data.

Figure 9. Example of Button Auto Reset on GPO0

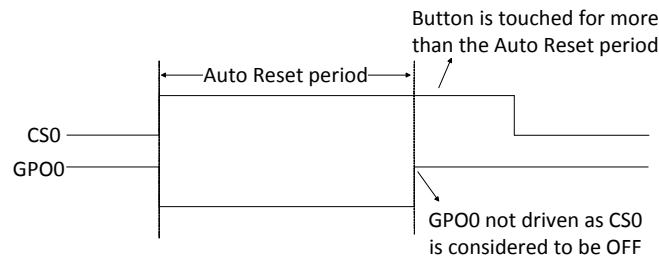


Figure 10. Example Power-on LED Effects (Concurrent on all GPOs) with Repeat Rate = 1^[4]

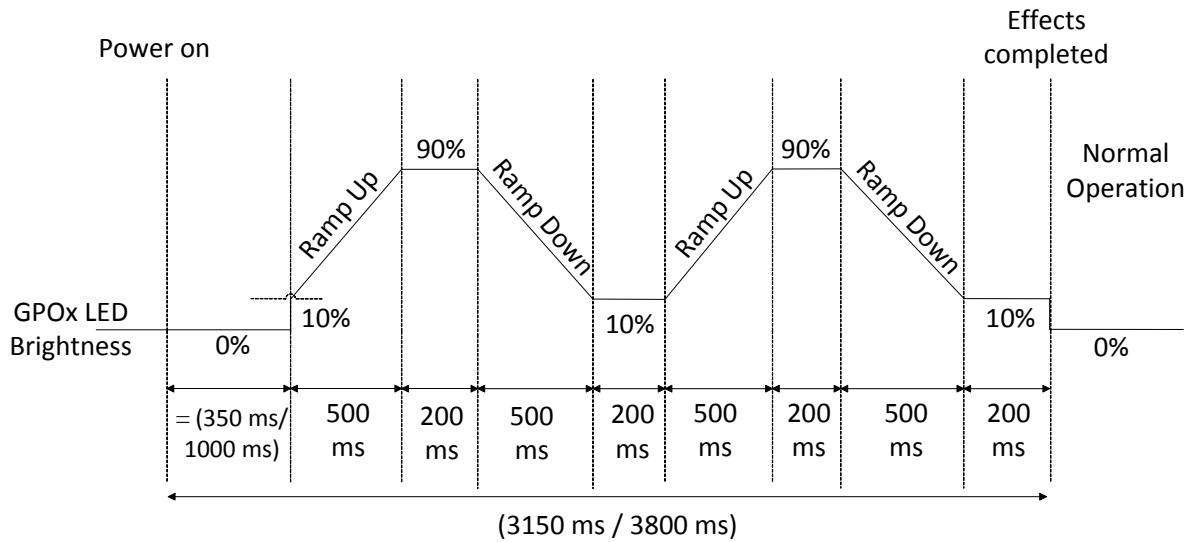
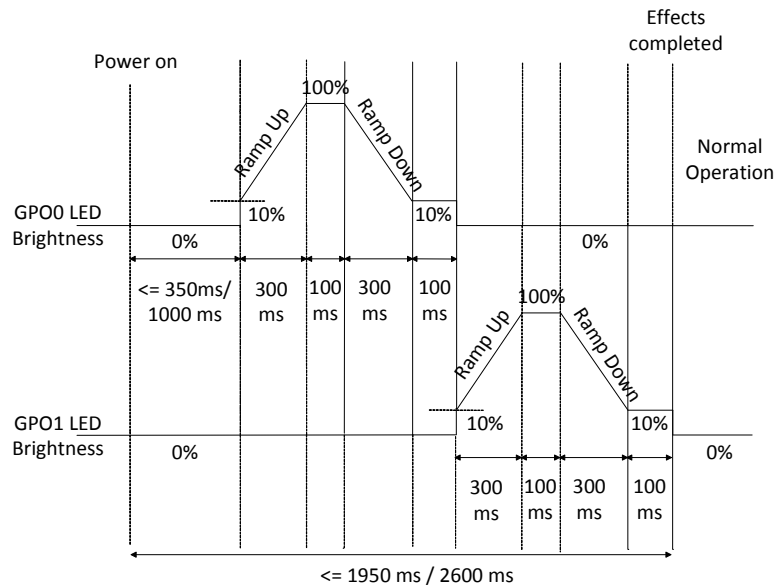


Figure 11. Example Power-on LED Effects (Sequential) with Two-Button Design and Repeat Rate = 0^[5]



Notes

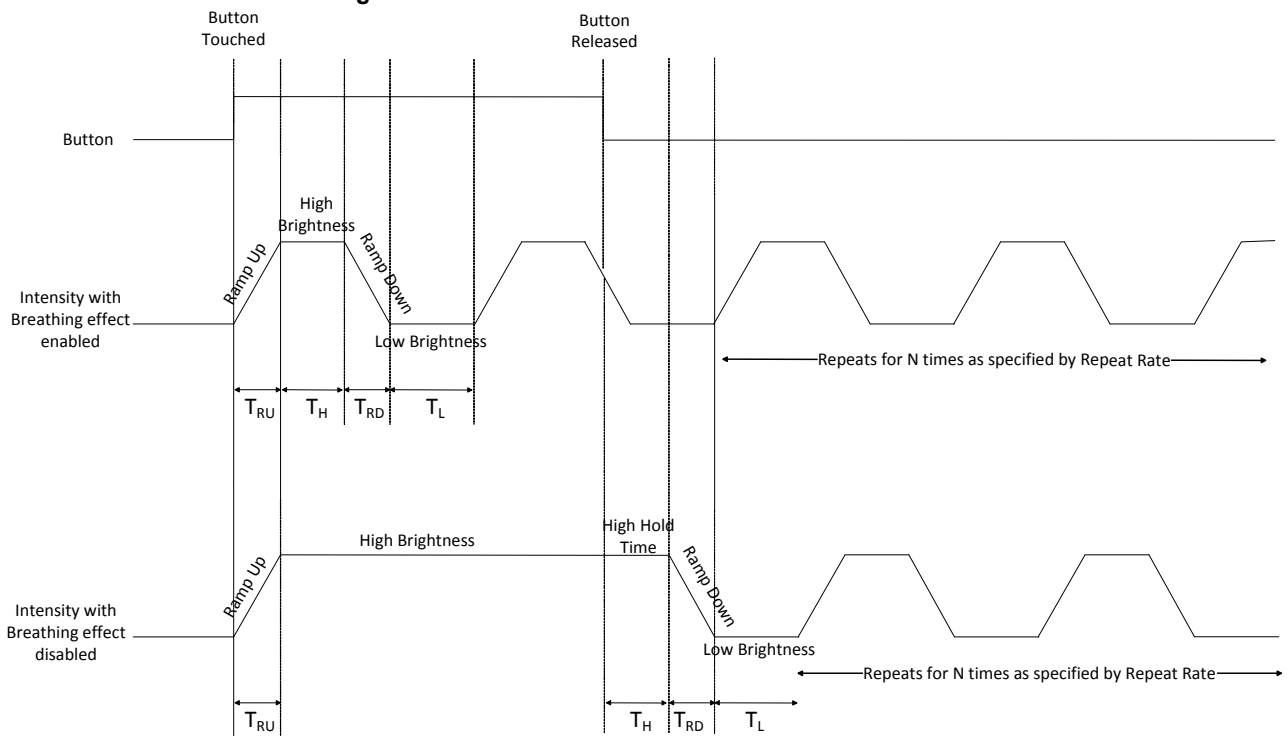
- 4. Ramp up time = 500 ms; High brightness = 90%; High brightness time = 200 ms; Ramp down time = 500 ms; Low brightness = 10%; Low brightness time = 200 ms; Repeat rate = 1
- 5. Ramp up time = 300 ms; High brightness = 100%; High brightness time = 100 ms; Ramp down time = 300 ms; Low brightness = 10%; Low brightness time = 100 ms; Repeat rate = 0

Button Touch LED Effects

- Provides a visual feedback on a button touch. Improves the aesthetic value of the design.
- Seen on GPOx when CSx is touched.
- The GPOs are configured in groups to have the same parameters. The groups are:
 - GPO1, GPO2, GPO3
 - GPO4, GPO5, GPO6
 - GPO7, GPO8, GPO9
- GPO0 can be configured separately. Useful in designs with a special use for the CS0 button, such as the power button.
- The following parameters can be set for the effects:
 - Low brightness – Minimum LED intensity
 - Low-brightness time – The time period during which LED remains in a low-brightness state
 - Ramp-up time – The time period during which the LED transitions from low brightness to high brightness
 - High brightness – Maximum LED intensity
 - High-brightness time – The time during which the LED stays in a high-brightness state
 - Ramp-down time – The time it takes the LED to go from high brightness to low brightness
 - Repeat rate – The number of times the effects are repeated
- Brightness levels can range from 0 to 100 percent.
- The time range can be 0 to 1600 ms.
- High-brightness level should be more than the low-brightness level for proper visual effects.

- Button Touch LED effects can be of two types (see [Figure 12 on page 12](#)):
 - Breathing effects: When the breathing effect is enabled, LED intensity changes from Standby Mode LED Brightness to Low Brightness immediately after a button touch. It then ramps up to high-brightness and stays for high brightness time. It then ramps down to low brightness and stays for low brightness time. This effect repeats for the duration during which the button is touched. When the button is released, the LED effects cycle that is in progress, continues. After this cycle completes, the LED effects cycle may repeat depending on the Repeat Rate.
 - Non-breathing effects: When the breathing effect is disabled, the LED intensity changes from Standby Mode LED Brightness to Low Brightness immediately after a button touch. It then ramps up to high brightness and stays there for the duration during which the button is touched. When the button is released, the LED maintains its state for high brightness time. It then ramps down to low brightness and stays for low brightness time. This effect may then repeat depending on the repeat rate.
- If the Button Touch LED Effects are active on one GPOx and the corresponding CSx is touched again, then the pattern restarts on GPOx.
- If the Toggle ON/OFF effect is also enabled, the LEDs toggle between Standby Mode LED Brightness and High Brightness on successive button touches (see [Figure 13 on page 13](#)).
- If Button Touch LED Effects are enabled, the LED ON time is automatically disabled.
- When the device goes to Deep Sleep, ongoing Button Touch LED Effects are immediately disabled.

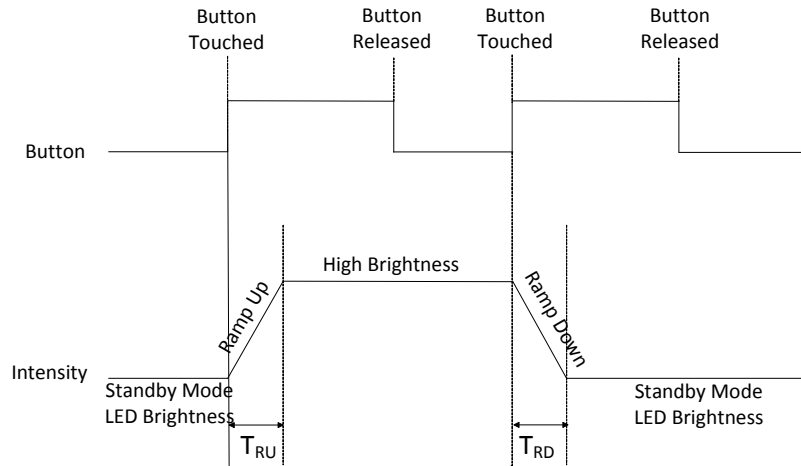
Figure 12. Button Touch LED Effect Pattern^[6]



Note

6. T_{RU} – Ramp Up Time; T_{RD} – Ramp Down Time; T_H – High Brightness Time ; T_L – Low Brightness Time

Figure 13. Button Touch LED Effects with Toggle Enabled

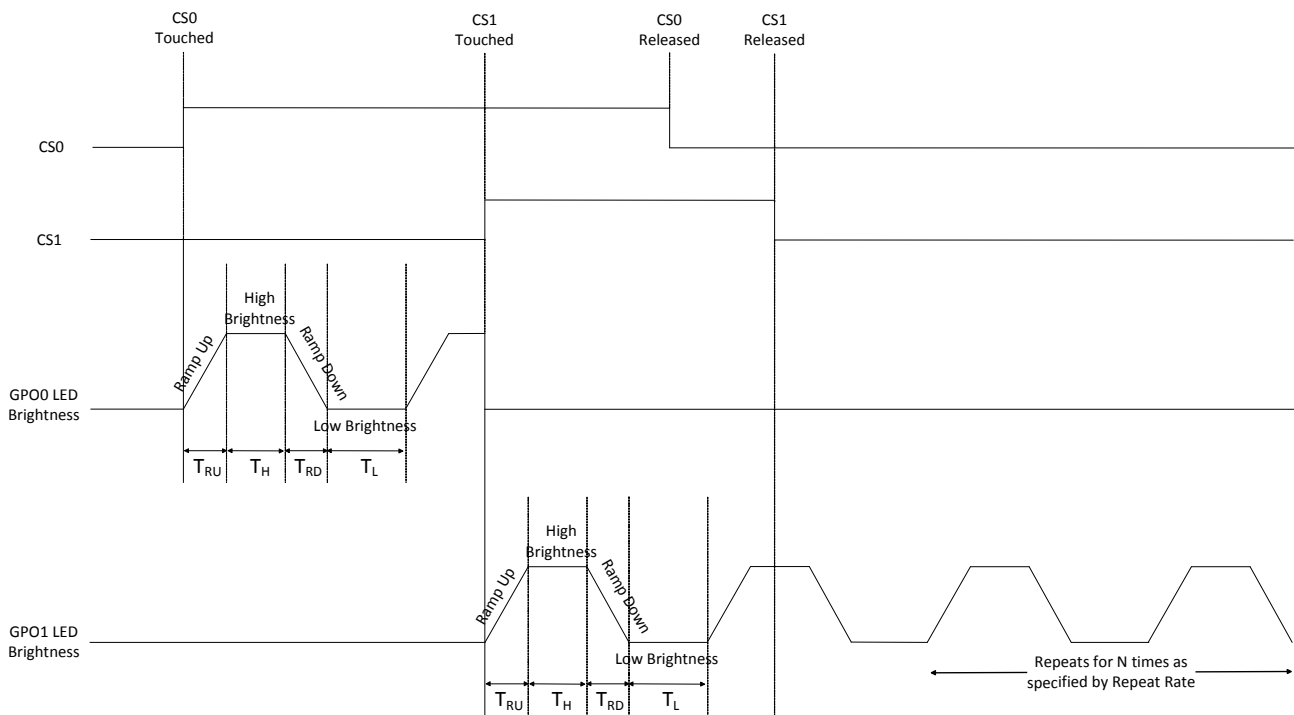


Last Button LED Effect

- Button Touch LED Effects can be configured to be interrupted on one GPO if any other button is touched.
- The effects reset on the first GPO and start on the GPO associated with the last button touched (see Figure 14).
- This feature is disabled by default.

- If Toggle ON/OFF is also enabled for some buttons, Last Button LED Effect is disabled for those buttons.
- If the Flanking Sensor Suppression (FSS) feature is also enabled, and two buttons are touched simultaneously, the Last Button LED Effect does not apply because the second button touched does not turn ON.

Figure 14. Button Touch LED Effects (Breathing) with Last Button LED Effect Enabled



Standby Mode LED Brightness

- Provides a better visual feedback for buttons when in OFF state. Improves the aesthetic value.
- The LED associated with GPOx is in Standby Mode LED Brightness after the conclusion of Button Touch LED Effects, when CSx is OFF.
- Standby Mode LED Brightness can be configured to be 0%, 20%, 30%, or 50%.
- Standby Mode LED Brightness increases device power consumption because the device does not go to Low Power Sleep.
- Standby Mode LED Brightness is disabled when the device goes to Deep Sleep.

Latch Status Read

- Host processor can check the CapSense button status by reading the Register Map through I²C communication.
- When a button is touched, the device generates an interrupt to host through the Attention/Sleep line. Host can then read CSx status.
- If the interrupt is not serviced immediately, and the button is released before the interrupt is serviced, the host can miss that button touch.
- To avoid missing any button touch, the host should read both current status (CS) and latch status (LS).
- CS is stored in the Button_Current_Stat0 and Button_Current_Stat1 registers in [Operating Mode](#).
- LS is stored in the Button_Latch_Stat0 and Button_Latch_Stat1 registers in [Operating Mode](#).
- To know more about these registers, refer to [Operating Mode](#).
- [Table 3 on page 14](#) lists the various possibilities of button touch acknowledge/miss. These are shown in [Figure 15](#) and [Figure 16](#).

Table 3. Latch Status Read

| Current Status (CS) | Latch Status (LS) | Comments |
|---------------------|-------------------|---|
| 0 | 0 | CSx is not touched during the current I ² C read; Host has already acknowledged any previous CSx touch in the last I ² C read. |
| 0 | 1 | CSx was touched before the current I ² C read; this CSx touch was missed by the host. |
| 1 | 0 | CSx was touched and acknowledged by the host during the previous I ² C read; the same CSx is still touched during the current I ² C read. |
| 1 | 1 | CSx is touched during the current I ² C read. |

Figure 15. Latch Status Read 1

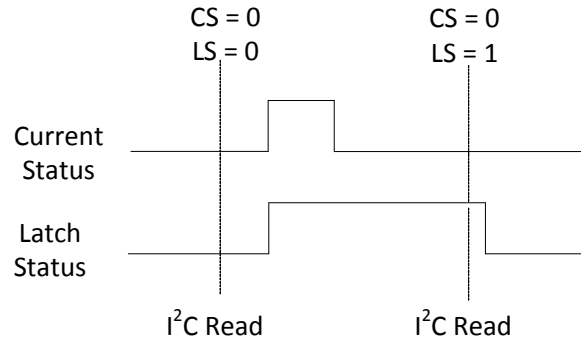
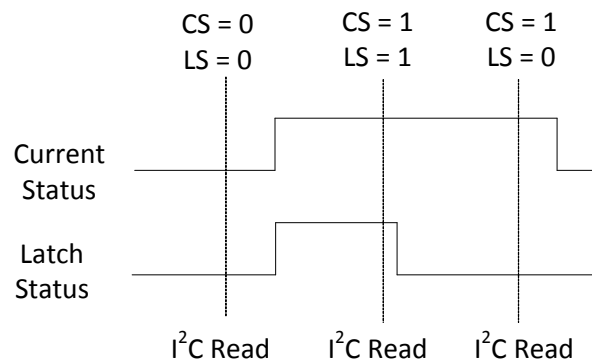


Figure 16. Latch Status Read 2



Attention/Sleep Line to Host

- Bidirectional active low line; can be controlled by both the device and the host.
- The Attention/Sleep line is in the Open Drain Low Drive mode
- The device is in the low-power Sleep mode by default (if the attention/sleep line is high). For more information, refer to the section [Low-Power Sleep Mode on page 21](#).
- The device cannot go to the low-power Sleep mode if the attention/sleep line is low.
- Attention/Sleep line should be pulled low only if required, to reduce device power consumption.

Attention/Sleep line can be used for the following functions:

Device Interrupt to Host

- On any button touch, the device pulls the Attention/Sleep line low to indicate an interrupt to the host (see [Figure 17 on page 15](#)).
- If more than one button is touched simultaneously, the attention line is pulled low for the entire duration of any button touch (see [Figure 18 on page 15](#)).
- The Attention/Sleep line goes high when the button is released.

Figure 17. Attention/Sleep Line with CSx Buttons Touched Separately

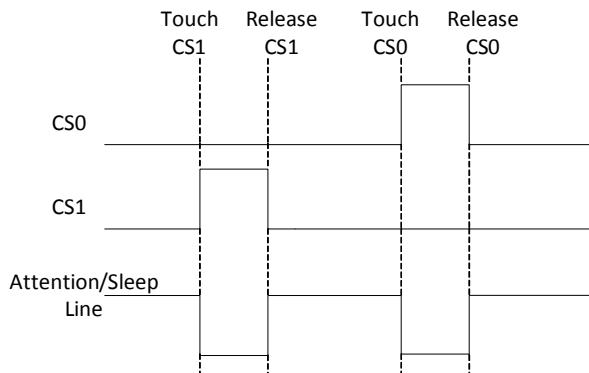
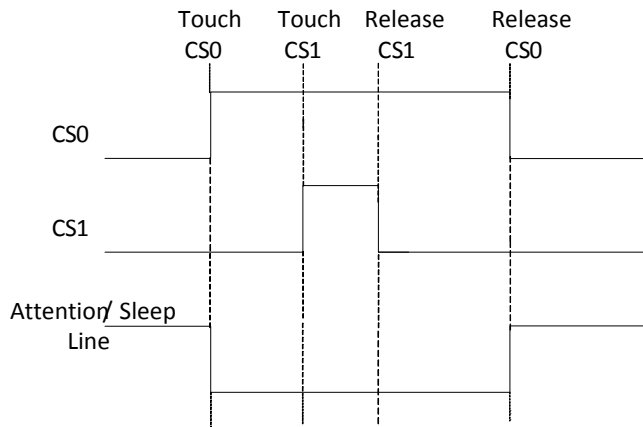


Figure 18. Attention/Sleep Line with CSx Buttons Touched Simultaneously



I²C Communication

- Attention/Sleep line should be pulled low before any I²C communication is initiated.
- If the Attention/Sleep line is high, the device may NACK I²C communication.
- When the Attention/Sleep line is low, the device may NACK I²C communication, but very infrequently.

Deep Sleep mode

- To enable the Deep Sleep mode, the host needs to set the “Deep Sleep” bit in Host_Mode register (in the Operating Mode). The host needs to wait for 50 ms and then pull Attention/Sleep line high.
- Host should pull the Attention/Sleep line low for the device to wake up from deep sleep.
- For more information, refer to the section [Deep Sleep Mode on page 21](#).

Analog Voltage Support

- A general external resistive network with a host processor is shown in [Figure 19](#).
- Host can be configured to perform different functions based on the voltage level at input pins. This is controlled by switches.
- These switches can be controlled by CapSense buttons.
- If enabled, GPOs replace these switches in the network.
- GPOs are in the Open Drain Low Drive mode.
- GPOs cannot be used for the resistive network and LED drive simultaneously.
- If only one button needs to be ON for analog voltage support, FSS should be enabled.
- For CY8CMBR2110, a simple external resistive network is shown in [Figure 20](#).

Figure 19. General External Resistive Network

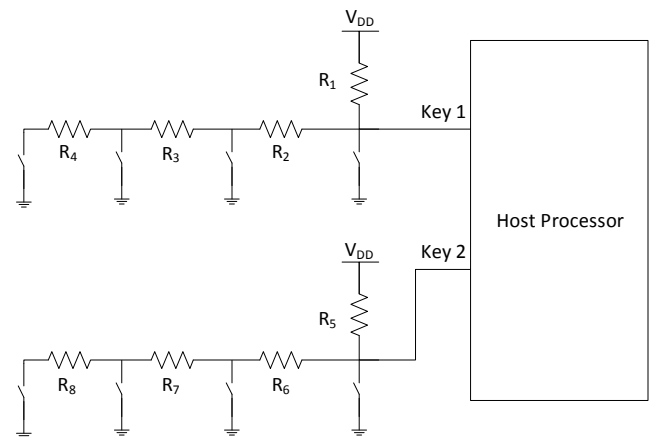
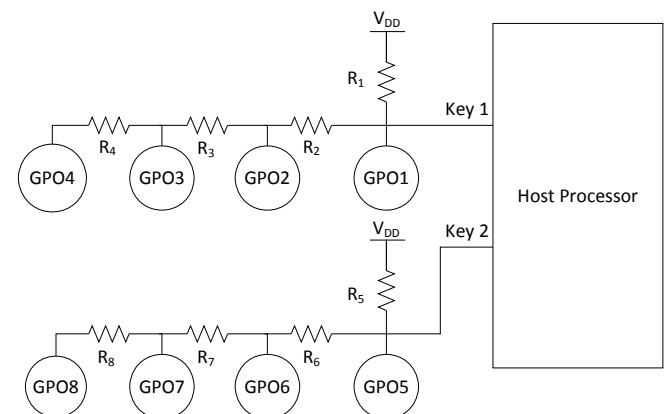


Figure 20. Analog Voltage Support for CY8CMBR2110



Sensitivity Control

- Sensitivity of each button can be set individually.
- Use higher sensitivity setting when the overlay thickness is higher or if the button diameter is small.
- Use a lower sensitivity setting when power consumption needs to be low.
- Possible sensitivity settings are “High”, “Medium”, and “Low”.

Debounce Control

- Avoids false triggering of buttons due to noise spike or any other glitches in the system.
- Specifies the minimum time for which a button has to be sensed as touch, for an output trigger. Debounce value can range from 1 to 255.
- Debounce value can be set separately for CS0 and combined for CS1 to CS9. This is useful for additional functions, such as, linking system reset to touch time corresponding to CS0 Debounce.
- The device Response Time depends on the button debounce. Refer to [Response Time on page 22](#).

Table 4 lists some examples of device Response Time for different debounce values.^[7]

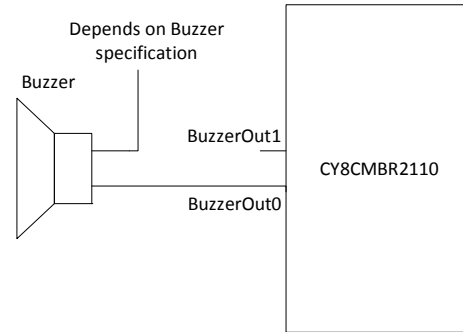
Table 4. Example Response Times for Debounce Values

| Debounce Value | Response Time for Consecutive Button Touch (ms) |
|----------------|---|
| 1 | 70 |
| 4 | 105 |
| 7 | 140 |
| 10 | 175 |
| 100 | 1225 |
| 200 | 2380 |
| 255 | 3010 |

Buzzer Signal Output

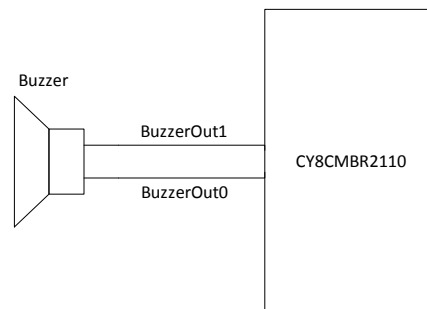
- Gives audio feedback for a button touch. For more details, refer to [Response Time on page 22](#).
- Buzzer signal output can have two configurations: AC 1-pin and AC 2-pin.
- In the AC 1-pin buzzer configuration, the buzzer must be connected to the BuzzerOut0 pin (see [Figure 21](#)). A square wave of the given frequency and duty cycle is driven on this pin. The BuzzerOut1 pin can either be left floating or configured as a Host-controlled GPO.

Figure 21. AC 1-Pin Buzzer Configuration



- In AC 2-pin buzzer configuration, connect the buzzer between the BuzzerOut0 and BuzzerOut1 pins (see [Figure 22](#)). Two out-of-phase square waves of the given frequency and duty cycle are driven on these pins.

Figure 22. AC 2-Pin Buzzer Configuration



- If the buzzer is not used, then both the pins can be used as Host-controlled GPOs. [Table 5](#) shows the possible buzzer settings.
- The idle state of the buzzer pin can be configured to be either V_{DD} or Ground.
- The buzzer pin is driven to the idle state when no button is touched, or after the Buzzer ON Time elapses, even when the button is kept touched (see [Figure 23](#)).
- The buzzer signal frequency is configurable and can assume one of the following values (in kHz) – 1.00, 1.14, 1.33, 1.60, 2.00, 2.67, 4.00
- The buzzer output is driven for the configured time and does not depend on the button touch time.
- Buzzer ON Time has a range of (1 to 127) × Button Scan Rate constant. To know more about Button Scan Rate constant, refer to [Power Consumption and Operating Modes on page 21](#).
- Buzzer Signal Output is strong drive.
- The output is driven commonly by all the CS_x buttons.
- Buzzer output restarts if any button is touched before the Buzzer ON time expiration (see [Figure 24](#)).

Note

7. 8-buttons, Noise Immunity level Normal, Response Time optimized design.

Figure 23. Buzzer Time-out

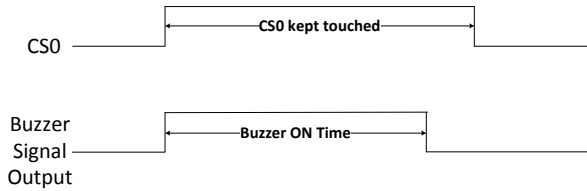


Figure 24. Buzzer Terminated and Restarted

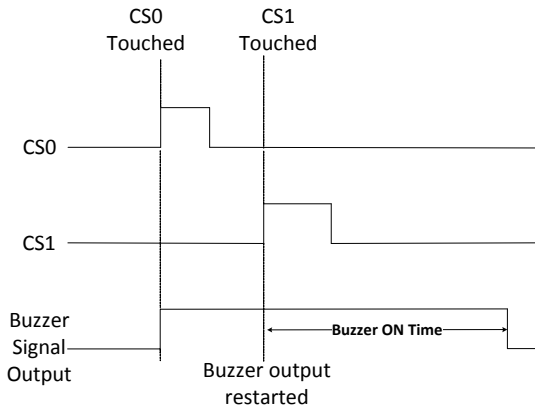


Table 5. Buzzer and Host-Controlled GPO Settings

| Buzzer Configuration | BuzzerOut0 Pin | BuzzerOut1 Pin | Max Available Host Controlled POs |
|----------------------|-------------------------------|-------------------------------|-----------------------------------|
| No Buzzer | Floating/Host Controlled GPO3 | Floating/Host Controlled GPO2 | 4 |
| AC 1-pin buzzer | Buzzer pin 0 | Floating/Host Controlled GPO2 | 3 |
| AC 2-pin buzzer | Buzzer pin 0 | Buzzer pin 1 | 2 |

Host Controlled GPOs

- Two GPO pins (HostControlGPO0, HostControlGPO1) are available whose logic states can be controlled by the host.
- If the buzzer is not used, then up to two more host-controlled GPOs are available (using BuzzerOut0 and BuzzerOut1 pins).
- The Host can control these GPOs in the Operating mode, Production Line Test mode, and Debug Data mode.
- Host-controlled GPOs are in LOW state at power-on.
- Host-controlled GPO settings cannot be saved to flash and must be configured after reset.

- HostControlGPO1 has a positive going pulse of 16 ms during power-on.
- These outputs are in strong drive mode.
- Table 5 shows the maximum available Host-Controlled GPOs, depending on the buzzer configuration.

System Diagnostics

- A built-in Power-on Self Test (POST) mechanism performs some tests at power-on reset (POR), which can be useful in production testing.
- If any button fails these tests, a 5-ms pulse is sent out on the corresponding GPO within 350 ms (if Noise Immunity level is “Normal”) or 1000 ms (if Noise Immunity level is “High”) after POR.
- To know the System Diagnostics result, the host can read device data in Production Line Test mode through the I²C interface.
- Since the host can read data through I²C lines, there is no need to interface GPOs to the host.

The following tests are performed on all the buttons.

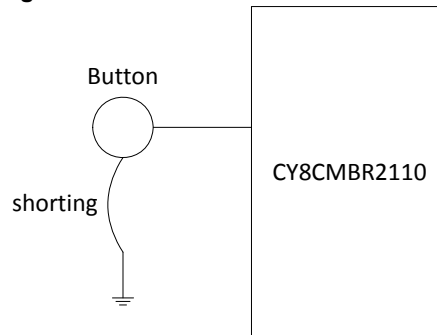
Button Shorted to Ground

If any button is shorted to ground, it is disabled. For an accurate detection of Button Shorted to Ground, the resistance between the CSx pin and ground should be less than the limits specified in Table 6.

Table 6. Maximum Resistance between CSx and GND for Proper System Diagnostics Operation

| Power supply (V _{DD}) (V) | Max resistance between CSx and GND (Ω) |
|-------------------------------------|--|
| 5.5 | 680 |
| 5 | 760 |
| 1.8 | 1700 |

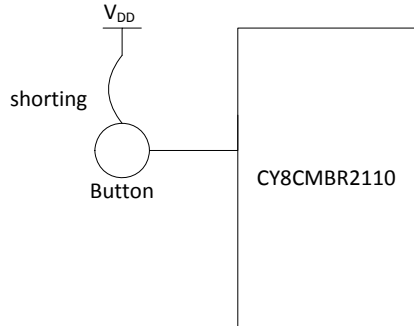
Figure 25. Button Shorted to Ground



Button Shorted to V_{DD}

If any button is shorted to V_{DD}, it is disabled.

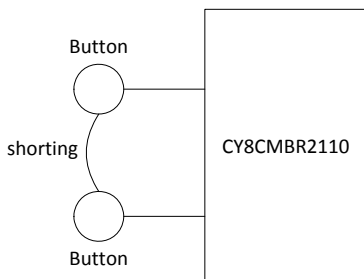
Figure 26. Button Shorted to V_{DD}



Button to Button Short

If two or more buttons are shorted to each other, all of these buttons are disabled.

Figure 27. Button to Button Short



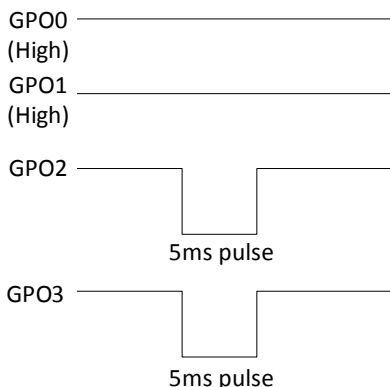
Improper Value of C_{MOD}

- Recommended value of C_{MOD} is 2 nF to 2.4 nF.
- If the value of C_{MOD} is less than 1 nF or greater than 4 nF, all the buttons are disabled.

Button C_P > 40 pF

If the parasitic capacitance (C_P) of any button is more than 40 pF, that button is disabled.

Figure 28. Example Showing CS0 and CS1 Passing the POST and CS2 and CS3 Failing



In Figure 28, CS0 and CS1 are enabled; CS2 and CS3 are disabled because they failed the POST. Therefore, a 5-ms pulse is observed on GPO2 and GPO3.

I²C Communication

I²C is the interface used to communicate between the CY8CMBR2110 (I²C slave) and the host (I²C master). It uses a simple two-wire synchronous communication protocol. These two wires are:

1. Serial Clock (SCL) – This line is used to synchronize the slave with the master.
2. Serial Data (SDA) – This line is used to send data between the master and the slave.

The CY8CMBR2110 can be a part of a one-slave or a multi-slave environment. See Figure 29 and Figure 30.

Figure 29. I²C Communication between One Master and One Slave

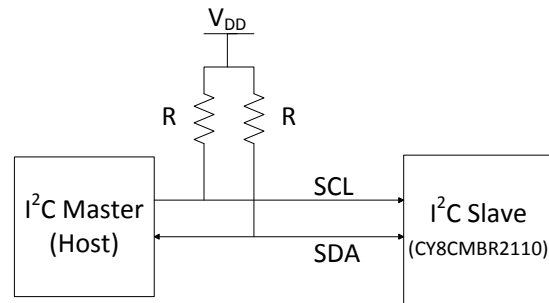
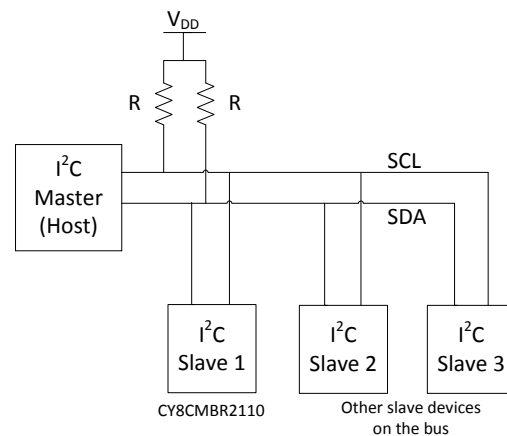


Figure 30. I²C Communication between One Master and Multiple Slaves



The CY8CMBR2110 I²C interface has the following features:

1. Bit rate up to 100 kbps
2. Configurable I²C slave address (0–127), with default slave address as '37h'.
3. Hardware address compare
4. No bus-stalling – No clock stretching
5. I²C buffer mode (32-byte hardware buffer)
6. Register-based access to I²C master for read and write operations.

I²C Slave address

To uniquely identify each device in a multi-device state, an I²C slave address is used. This address is a 7-bit value, which allows up to 127 slaves on the bus simultaneously. When the bus master wants to communicate with a slave on the bus, it sends a start condition followed by the I²C address of the relevant slave. The start condition alerts all slaves on the bus when a new transaction starts. The slave with the specified I²C address acknowledges the master. All the other slaves ignore all further traffic on the bus until the next start condition is detected.

Start and Stop Conditions

The master initiates the communication by issuing a START condition on the bus and terminates the communication by issuing a STOP condition. The bus is considered busy between these two conditions. See Figure 31.

A START condition is shown by changing the level of SDA line (from high to low), when the SCL line is high.

A STOP condition is shown by changing the level of SDA line (from low to high), when the SCL line is high.

Figure 31. I²C START and STOP Conditions

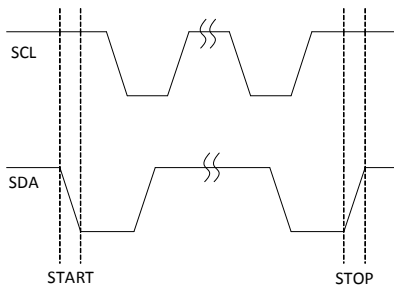
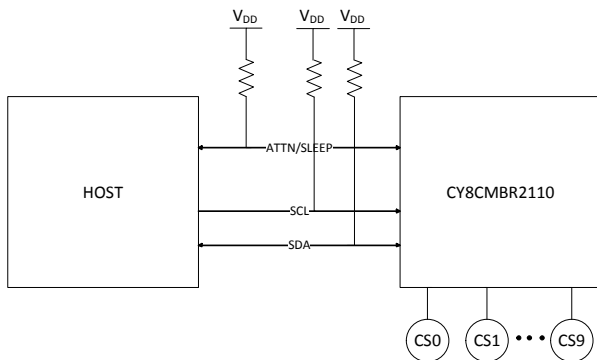


Figure 32. I²C Interface between Host and Device



I²C Communication Guidelines for CY8CMBR2110

1. The Attention/Sleep line should be pulled low by either the host or the device, before initiating any I²C communication.
2. The host needs to wait for 350 ms (if Noise Immunity level is “Normal”) or 1000 ms (if Noise Immunity level is “High”) after device power-on, before initiating any I²C communication. Else, the device NACKs any such communication.
3. The host needs to wait for a minimum of 60 ms after any I²C transaction before initiating a new transaction.
4. Host needs to wait for 350 ms (if Noise Immunity level is “Normal”) or 1000 ms (if Noise Immunity level is “High”) after “Save to flash” and “Software reset” commands are issued before initiating any further transaction.
5. In run time the device should be in Operating mode.
6. The host should not initiate a new START condition for the device, without a STOP condition for the previous I²C communication (also called REPEAT START condition).
7. Host needs to maintain a minimum of 60 ms between any two I²C transactions
 - a. If the host does not maintain this time while reading, then it gets the same data as read in previous transaction.
 - b. If the host writes to the same register twice within this time, then the old data is lost.
 - c. If the host writes to different registers within this time (reg x in first write and reg y in second write) then the data is not lost.

Write Operation

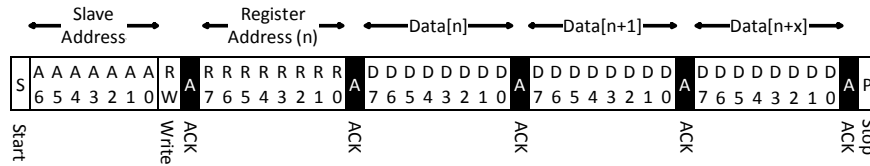
For a write operation, the following steps are performed:

1. The Host sends the START condition to the device on the SDA line.
2. The Host specifies the slave address, followed by R/W bit to specify a write operation. The device ACKs the Host.
3. The Host specifies the register address to which it has to write. The device ACKs the Host.
4. The Host starts sending the data to the device, which is written to the register address specified by the host. This is followed by an ACK from the device.
5. If the write operation includes more bytes, each following byte is written to the successive register address. Each successive byte is followed by an ACK from the device.
6. After the write operation is complete, the Host sends the STOP condition to the device. This marks the end of the communication. See Figure 33 on page 20.

Notes

1. The Host must not write to a Read Only register.
2. The Host can write a maximum of 32 bytes in one I²C transaction.

Figure 33. Host Writing x Bytes to the Device



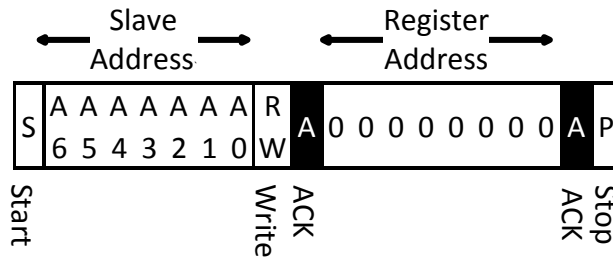
Setting the Device Data Pointer

The Host sets the device data pointer to specify the starting point for future read operations. To set the device pointer, perform the following steps:

1. The Host sends the START condition to the device on the SDA line.
2. The Host specifies the slave address on the SDA line, followed by the Read/Write bit to specify a write operation. The device ACKs the Host.

3. The Host specifies a register address (this register address is always 00). Any future read operations start from this address in the device. The device ACKs the Host.
4. The Host sends the STOP condition to the device. This marks the end of the communication. See [Figure 34](#).

Figure 34. Host Setting the Device Data Pointer



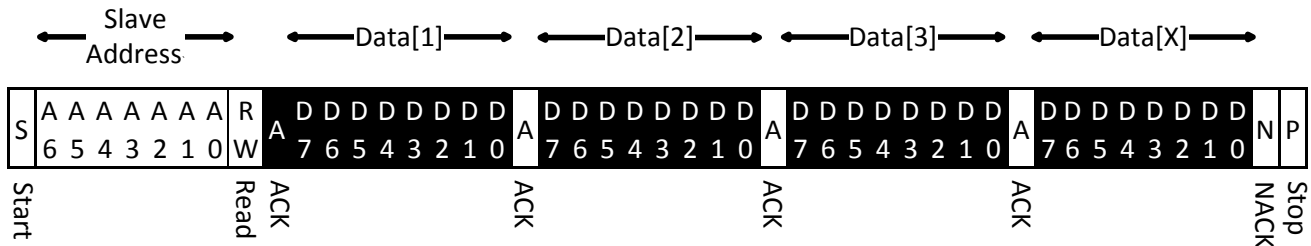
Read Operation

For a read operation, perform the following steps:

1. The Host sends the START condition to the device on the SDA line.
2. The Host specifies the slave address, followed by the Read/Write bit to specify a read operation. The device ACKs the Host.

3. The device retrieves the byte from the register address 00 and sends it to the Host. The Host ACKs the device.
4. Each successive byte is retrieved from the successive register address and sent to the Host, followed by ACKs from the Host.
5. After the host has received the required bytes, it NACKs the device.
6. The Host sends the STOP condition to the device. This marks the end of the communication. See [Figure 35](#).

Figure 35. Host Reading x Bytes from the Device



Legend

| |
|---------------------|
| CY8CMBR2110 to Host |
| HOST to CY8CMBR2110 |

For I²C electrical specifications of the device, refer to the [I2C Specifications](#).

Power Consumption and Operating Modes

CY8CMBR2110 can meet low-power requirements of battery-powered applications. To design for the lowest operating current, do the following:

- Ground all unused CapSense inputs (CSx).
- Minimize C_P using the design guidelines in [Getting Started with CapSense](#), section 3.7.1.
- Reduce supply voltage (valid range: 1.71 V to 5.5 V).
- Reduce the sensitivity of CSx buttons.
- Configure the design to be optimized for power consumption.
- Use 'High' Noise Immunity level only if needed.
- Use a higher Button Scan Rate or Deep Sleep operating mode.

To know more about the steps to reduce power consumption, refer to section 5 in the [CY8CMBR2110 Design Guide](#).

Low-Power Sleep Mode

The following flowchart describes the Low-Power Sleep mode operation.

- The Button Scan Rate is equal to the sum of the time the device scans and sleeps.
- The register settings define a Button Scan Rate offset.
- The offset is added to a constant to get the Button Scan Rate.

- The constant is given in [Table 7](#).
- The range of scan rate is 25 to 561 ms.

Figure 36. Low Power Sleep Mode Operation

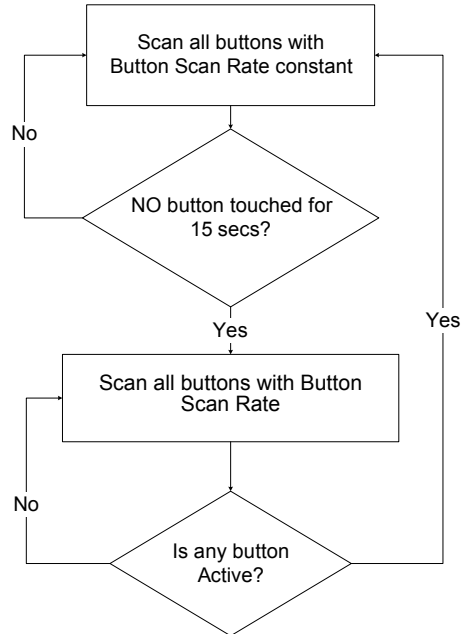


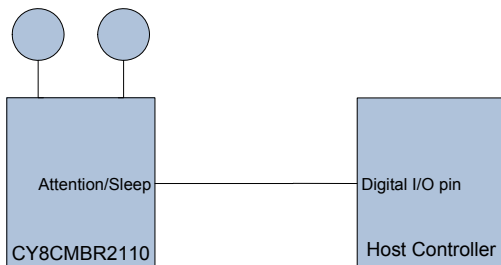
Table 7. Button Scan Rate Constant

| Button Count | Button Scan Rate Constant | | | |
|--------------|--------------------------------|-----------------------------|------------------------------------|-----------------------------|
| | Response Time Optimized Design | | Power Consumption Optimized Design | |
| | Noise Immunity Level "Normal" | Noise Immunity Level "High" | Noise Immunity Level "Normal" | Noise Immunity Level "High" |
| ≤ 5 | 25 ms | 35 ms | 35 ms | 55 ms |
| > 5 | 35 ms | 55 ms | 35 ms | 55 ms |

Deep Sleep Mode

- To enable the Deep Sleep mode, connect the Attention/Sleep line to the host as shown in [Figure 37](#); the host should perform the following steps:
 - Pull the Attention/Sleep line low
 - Set the Deep Sleep bit in the Host_Mode register (in Operating Mode) high
 - Wait for 50 ms
 - Pull the Attention/Sleep line high

Figure 37. Attention/Sleep pin Connection to Enable Deep Sleep Mode



- In Deep Sleep mode, all blocks are turned off and the device power consumption is 0.1 μA.
- There is no CapSense scanning in Deep Sleep mode.
- After the device enters Deep Sleep mode, the 'Deep Sleep' bit is automatically cleared.
- The Attention/Sleep line should be pulled low for the device to wake up from Deep Sleep.
- When device comes out of Deep Sleep mode, the CapSense system is re-initialized. The typical time for re-initialization is 20 ms (Normal Noise Immunity level) or 50 ms (High Noise Immunity level). Any button touch within this time is not reported.
- The Deep Sleep bit cannot be set by EZ-Click Customizer Tool and must be set by an external I²C communication to the device.

Response Time

Response time is the minimum amount of time the button should be touched for the device to detect as a valid button touch.

It is given by the following equations:

1. If Noise Immunity Level is “Normal”

$$RT_{CBT} = \text{Button Scan Rate constant} + [\text{Button Scan Rate constant} \times \{\text{Round}_{down}((\text{Debounce} - 1)/3) + 1\}]$$

$$RT_{FBT} = \text{Button Scan Rate} + [\text{Button Scan Rate constant} \times \{\text{Round}_{down}((\text{Debounce} - 1)/3) + 1\}]$$

2. If Noise Immunity level is “High”.

$$RT_{CBT} = \text{Button Scan Rate constant} + [\text{Button Scan Rate constant} \times \text{Debounce}]$$

$$RT_{FBT} = \text{Button Scan Rate} + [\text{Button Scan Rate constant} \times \text{Debounce}]$$

Where

RT_{CBT} is Response time for consecutive button touch after first button touch

RT_{FBT} is Response time for First button touch

Debounce for CS1-CS9 can be from 1 to 255

Debounce for CS0 can be from 1 to 255

Round_{down} is the greatest integer less than or equal to $((\text{Debounce} - 1)/3)$

Refer to [Table 7 on page 21](#) to obtain Button Scan Rate constant.

For example, consider an eight-button, Response Time-optimized design with the Button Scan Rate offset set to 391 ms. The Noise Immunity level is set to Normal.

Let us assume that CS0 is not used in the design and the Debounce value for each button (CS1–CS8) is set as 3. The Button Scan Rate constant for such a design is 35 ms (see [Table 5 on page 17](#)), which results in a Button Scan Rate to be $(35 + 391 \text{ ms})$ 426 ms.

The response time for such a design is given as:

$$RT_{CBT} = 35 + [35 \times \{\text{Round}_{down}((3 - 1)/3) + 1\}] = 70 \text{ ms}$$

$$RT_{FBT} = 426 + [35 \times \{\text{Round}_{down}((3 - 1)/3) + 1\}] = 461 \text{ ms}$$

Device Modes

The register map is divided into five modes.

- Operating mode
- LED Configuration mode
- Device Configuration mode
- Production Line Test mode
- Debug Data mode

The following sections give an overview of each mode. Each register mode consists of different sets of registers. Refer to the [Appendix - Register Map](#) section for description of all the registers in detail.

Operating Mode

The Host must use this mode after configuring the device in run time. The following can be configured in this mode:

1. Host control GPO logic levels
2. Deep Sleep mode entry
3. Software Reset
4. Device mode change

Host can read the following device information in this mode:

1. CapSense current and latched status
2. Current configuration (factory default or user configuration)
3. Flash checksum
4. RAM checksum
5. Device ID and firmware revision

LED Configuration Mode

The Host must use this mode to configure the device and revert back to the Operating mode after configuration.

The Host can configure the following in this mode:

1. Analog voltage output settings
2. Power-on LED effects
3. Button Touch LED effects
4. LED ON Time
5. Standby Mode LED brightness
6. Device Mode change

Device Configuration Mode

The Host must use this mode to configure the device and then revert back to operating mode after configuration is done. Host can configure the following in this mode:

1. I²C address
2. FSS group buttons
3. Toggle ON/OFF option

4. Button Sensitivity, Debounce, Finger Threshold
5. Buzzer settings
6. Automatic threshold settings
7. Button Scan rate settings (power settings)
8. Noise Immunity settings
9. Button Auto Reset time
10. Design Optimization settings
11. Save settings to flash
12. Load factory default configuration
13. Device mode change

Production Line Test Mode

The Host must use this mode only during the design validation and production testing stage of product development.

The Host can configure the following in this mode:

1. Host-controlled GPO logic levels
2. Changing device mode

The Host can read the following device information in this mode, which helps in Production Line Test:

1. System Diagnostics data
 - Button short to ground
 - Button short to another button
 - Button short to V_{DD}
 - Button Parasitic capacitance > 40 pF
 - Improper value of C_{MOD} value connected
2. All buttons SNR values
3. Valid button count
4. CapSense current status

Debug Data Mode

The Host must use this mode only during the design validation stage of product development.

The Host can configure the following in this mode:

1. Host-controlled GPO logic levels
2. Parameter type and button number, which the host wants to debug
3. Changing device mode

The Host can read the following device information in this mode, which helps in design validation:

1. CapSense Raw data (Raw count, baseline and signal)
2. CapSense button SNR
3. Button parasitic capacitance
4. CapSense current status

Steps to Configure CY8CMBR2110

To configure the CY8CMBR2110, follow these steps:

1. Change Device mode to LED Configuration mode.
2. Wait for 55 ms.
3. Write to all the configuration registers in the LED Configuration mode.
4. Wait for 55 ms.
5. Change Device mode to Device Configuration mode.
6. Wait for 55 ms.
7. Write to all the configuration registers in the Device Configuration mode.
8. Calculate checksum and enter this value in the registers.

Checksum (Checksum_MSB (0x1E) and Checksum_LSB (0x1F) in the Device Configuration mode): Checksum is the sum of values of the registers (0x01–0x1F) in the LED Configuration mode and the registers (0x01–0x1D) in the Device Configuration mode. Checksum also takes the values of any reserved register bits. The host should not write to these bits and should add 0 for any such bit, while calculating checksum.

Checksum_Flash_xxx registers (in the Operating mode) indicate the checksum stored in the flash. Checksum_RAM_xxx registers (in the Operating mode) indicate the checksum calculated by the device and stored in the RAM.

9. Wait for 55 ms.
10. Read the Checksum matched bit in the Host_Mode register (in the Device Configuration mode) and verify that it is set to 1. If this bit is not set, start again from the first step and reconfigure the device. The host should keep a backup of the configuration data if this is needed.

Checksum matched bit: The CY8CMBR2110 calculates the checksum and compares that with the Checksum register value entered by the host. If both the values match, the Checksum matched bit in the Host_Mode register (in the Device Configuration mode) is set to 1. If the values do not match (indicating a possible I²C write error) this bit is cleared to 0. The host can read the Checksum_RAM_xxx register (in the Operating mode) to know the device calculated checksum.

11. If the Checksum matched bit is set to 1, then set the Save to Flash bit in the Host_mode register.

Save to Flash bit: On a Save to Flash, the following sequence is executed:

- The device copies the 64-byte data (LED Configuration mode and Device Configuration mode) to the flash.
- A software reset is done.
- After software reset, the device is in Operating mode.

Any configuration changes are not applicable unless a Save to Flash is done, which is useful when the device has to be configured only once for all future operations. To ensure a flawless Save to Flash, the device power supply must be stable, with V_{DD} fluctuations limited to ±5% of the V_{DD}.

12. After a Save to Flash, wait for (T_{SAVE_FLASH} + Device initialization) time. T_{SAVE_FLASH} is mentioned in the Flash Write Time Specifications. The device initialization time is 350 ms (normal Noise Immunity) or 1000 ms (high Noise Immunity).

13. Read the Factory defaults loaded bit in Device_Stat register (in Operating mode).

Factory Defaults Loaded bit: After every reset, the device loads the RAM with the flash content and verifies the RAM checksum with the flash checksum to ensure there is no flash corruption. If the checksum differs, then the device identifies it as a flash corruption and loads the factory default value in the RAM, and sets the Factory Defaults Loaded bit. This resets any register value previously changed by the host. Factory default values of each register are mentioned in the Register Map.

If the factory defaults are loaded, the I²C address of the device also changes from the current address (set by the host) to the default address, 37h. The host must then check for the default I²C address on the I²C bus to communicate with the CY8CMBR2110.

14. Setting the Factory Defaults Loaded bit corrupts the flash and the host needs to reconfigure the device from the first step. If this bit is clear, then the device is successfully configured.

CY8CMBR2110 Reset

You can reset the CY8CMBR2110 either through hardware or software using the following options:

- **Hardware Reset:** For this option, toggle power on the CY8CMBR2110 pins. There are two types of hardware reset:
 - **Power reset** – Turn OFF the external power supply on the device V_{DD} line and turn ON again (after power down, ensure that the V_{DD} is less than 100 mV, before powering backup). On a power reset, there is a high-going pulse of 16 ms on the HostControlGPO1 pin.
 - **XRES reset** – Pull the device XRES pin HIGH and then pull LOW. On an XRES reset, there is no pulse on HostControlGPO1 pin. In all other respects, XRES reset is identical to power reset.

On a hardware reset, the LED Configuration mode and Device Configuration mode register values are loaded from the flash to the RAM. All the device blocks are initialized, System Diagnostics is done, and an initial 5-ms pulse is sent on all the GPOx associated with any failing CSx. This is done within 350 ms (normal Noise Immunity) or 1000 ms (high Noise Immunity). Power-on LED Effects (if enabled) are then seen on all the remaining GPOs. After this, the device is in the Operating mode and normal operation begins.

- **Software Reset:** This is done by writing 1 to the Software Reset bit in the Host_Mode register (in Operating mode). On a software reset, the LED Configuration mode and Device Configuration mode register values are loaded from the flash to the RAM. The device auto-clears the Software Reset bit and all the device blocks are initialized. This is done within 350 ms (normal Noise Immunity) or 1000 ms (high Noise Immunity). After this, the device is in the Operating mode and normal operation begins. System Diagnostics is not done and Power-on LED Effects do not occur. If the user has configured the device for Power-on LED Effects and saved the settings to flash, a hardware reset must be done to see the Power-on LED Effects.

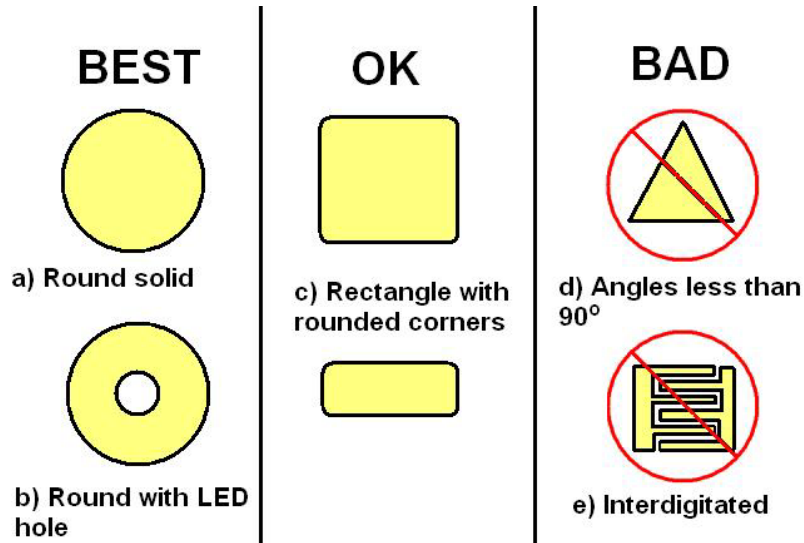
Layout Guidelines and Best Practices

Table 8. Layout Guidelines and Best Practices

| Sl. No. | Category | Min | Max | Recommendations/Remarks |
|---------|--|----------------------------------|---------|--|
| 1 | Button Shape | – | – | Solid round pattern, round with LED hole, rectangle with round corners |
| 2 | Button Size | 5 mm | 15 mm | Refer to the Design Toolbox |
| 3 | Button-Button spacing | Equal to Button Ground Clearance | – | 8 mm (Y dimension in Figure 39 on page 26) |
| 4 | Button Ground Clearance | 0.5 mm | 2 mm | Refer to the Design Toolbox (X dimension in Figure 39 on page 26) |
| 5 | Ground Flood - Top layer | – | – | Hatched ground 7 mil trace and 45 mil grid (15% filling) |
| 6 | Ground Flood - Bottom layer | – | – | Hatched ground 7 mil trace and 70 mil grid (10% filling) |
| 7 | Trace Length from button pad to CapSense controller pins | – | 450 mm | Refer to the Design Toolbox |
| 8 | Trace Width | 0.17 mm | 0.20 mm | 0.17 mm (7 mil) |
| 9 | Trace Routing | – | – | Traces should be routed on the non-button side. If any non-CapSense trace crosses CapSense trace, ensure that intersection is orthogonal. |
| 10 | Via Position for the buttons | – | – | Via should be placed near the edge of the button to reduce trace length thereby increasing sensitivity |
| 11 | Via Hole Size for button traces | – | – | 10 mil |
| 12 | No. of via on button trace | 1 | 2 | 1 |
| 13 | Distance of CapSense series resistor from button pin | – | 10 mm | Place CapSense series resistors close to the device for noise suppression. Place CapSense resistors, which have highest priority, first. |
| 14 | Distance between any CapSense trace to ground Flood | 10 mil | 20 mil | 20 mil |
| 15 | Device placement | – | – | Mount the Device on the layer opposite to button. The CapSense trace length between the Device and buttons should be minimum (see trace length above) |
| 16 | Placement of components in two layer PCB | – | – | Top Layer – buttons Bottom layer – device, other components and traces. |
| 17 | Placement of components in four layer PCB | – | – | Top Layer – buttons Second Layer – CapSense traces and V_{DD} (avoid V_{DD} traces below the buttons) Third Layer – hatched ground Bottom layer – CapSense controller, other components and non CapSense traces |
| 18 | Overlay thickness | 0 mm | 5 mm | Refer to the Design Toolbox |
| 19 | Overlay material | – | – | Should be non-conductive material. Glass, ABS Plastic, Formica, wood and so on. There should be no air gap between PCB and overlay. Use adhesive to stick the PCB and overlay. |
| 20 | Overlay adhesives | – | – | Adhesive should be non conductive and dielectrically homogenous. 467MP and 468MP adhesives made by 3M are recommended. |
| 21 | LED back lighting | – | – | Cut a hole in the button pad and use rear mountable LEDs. Refer to the PCB layout in the following section. |
| 22 | Board thickness | – | – | Standard board thickness for CapSense FR4 based designs is 1.6 mm. |

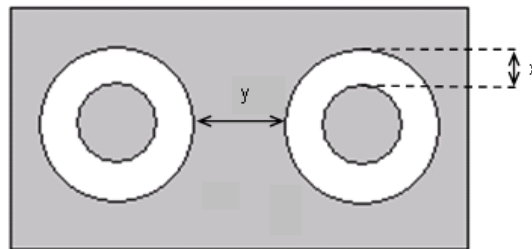
CapSense Button Shapes

Figure 38. CapSense Button Shapes



Button Layout Design

Figure 39. Button Layout Design

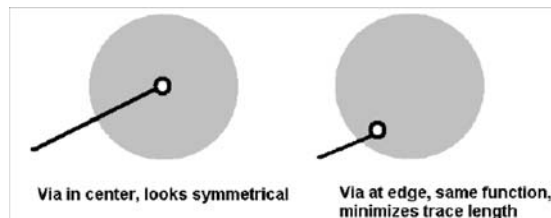


x: Button to ground clearance (Refer to [Layout Guidelines and Best Practices on page 25](#))

y: Button to button clearance (Refer to [Layout Guidelines and Best Practices on page 25](#))

Recommended via-hole Placement

Figure 40. Recommended via-hole Placement



Example PCB Layout Design with Ten CapSense Buttons and Ten LEDs

Figure 41. Top Layer

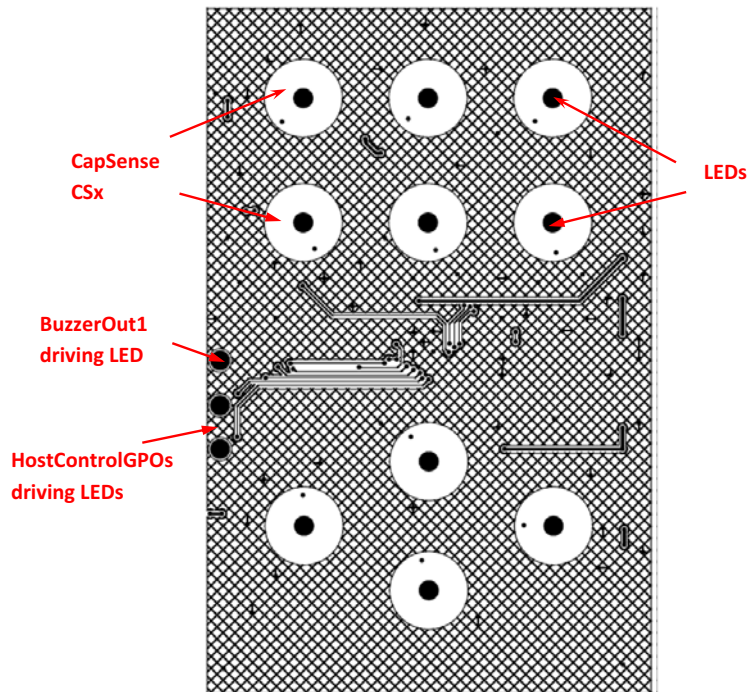
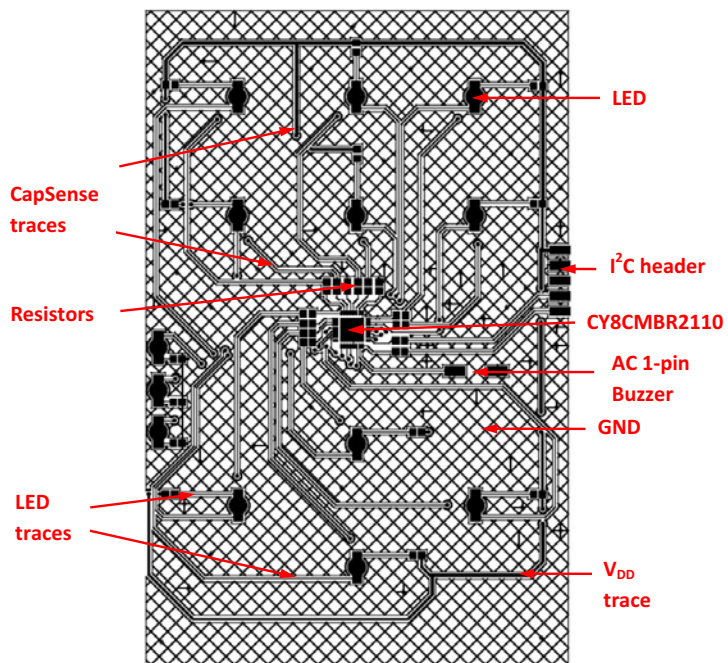


Figure 42. Bottom Layer



Electrical Specifications

This section presents the DC and AC electrical specifications of the CY8CMBR2110 device.

Absolute Maximum Ratings

Exceeding maximum ratings may shorten the useful life of the device.

Table 9. Absolute Maximum Ratings

| Parameter | Description | Min | Typ | Max | Unit | Conditions |
|------------------|---|-----------------------|-----|-----------------------|------|--|
| T _{STG} | Storage temperature | -55 | +25 | +125 | °C | Higher storage temperatures reduce data retention time. Recommended storage temperature is +25 °C ± 25 °C. Extended duration storage at temperatures above 85 °C degrades reliability. |
| V _{DD} | Supply voltage relative to V _{SS} | -0.5 | - | +6.0 | V | |
| V _{IO} | DC voltage on CapSense inputs and digital output pins | V _{SS} - 0.5 | - | V _{DD} + 0.5 | V | |
| I _{MIG} | Maximum current into any GPO pin | -25 | - | +50 | mA | |
| ESD | Electrostatic discharge voltage | 2000 | - | - | V | Human body model ESD |
| LU | Latch-up current | - | - | 200 | mA | In accordance with JESD78 standard |

Operating Temperature

Table 10. Operating Temperature

| Parameter | Description | Min | Typ | Max | Unit | Notes |
|----------------|-----------------------------|-----|-----|------|------|--|
| T _A | Ambient temperature | -40 | - | +85 | °C | |
| T _C | Commercial Temperature | 0 | - | +70 | °C | |
| T _J | Operational Die Temperature | -40 | - | +100 | °C | The temperature rise from ambient to junction is package specific. Refer to Table 21 on page 35 . The user must limit the power consumption to comply with this requirement. |

DC Electrical Characteristics
DC Chip Level Specifications

The following table lists guaranteed maximum and minimum specifications for the entire voltage and temperature ranges.

Table 11. DC Chip-Level Specifications

| Parameter | Description | Min | Typ | Max | Unit | Notes |
|---------------------------------|-------------------------|------|-------|-------|---------------|---|
| V_{DD} ^{[1],[2],[3]} | Supply voltage | 1.71 | – | 5.5 | V | |
| I_{DD} | Supply current | – | 3.4 | 4.0 | mA | $V_{DD} = 3.0\text{ V}$, $T_A = 25\text{ °C}$ |
| I_{DA} | Active current | – | 3.4 | 4.0 | mA | $V_{DD} = 3.0\text{ V}$, $T_A = 25\text{ °C}$, continuous button scan |
| I_{DS} | Deep sleep current | – | 0.1 | 1.05 | μA | $V_{DD} = 3.0\text{ V}$, $T_A = 25\text{ °C}$ |
| I_{DL} | Low power sleep current | – | 9.52 | 14.20 | μA | $V_{DD} = 3.0\text{ V}$, $T_A = 25\text{ °C}$ |
| I_{AV1} | Average current | – | 90.5 | – | μA | 4 buttons used, 180 button touches per hour, average button touch time of 1000 ms, buzzer disabled, Button Touch LED Effects disabled, $10\text{ pF} < C_P$ of all buttons $< 20\text{ pF}$, Button Scan Rate = 541 ms, with power consumption optimized, Normal Noise Immunity level, Medium CSx sensitivity |
| I_{AV2} | Average current | – | 111.2 | – | μA | 8 buttons used, 200 button touches per hour, average button touch time of 500 ms, buzzer disabled, average Button Touch LED Effects time of 1000 ms, $10\text{ pF} < C_P$ of all buttons $< 20\text{ pF}$, Button Scan Rate = 541 ms, with Response Time optimized, Normal Noise Immunity level, Medium CSx sensitivity |
| I_{AV3} | Average current | – | 148.2 | – | μA | 10 buttons used, 200 button touches per hour, average button touch time of 500 ms, buzzer disabled, average Button Touch LED Effects time of 1000 ms, $10\text{ pF} < C_P$ of all buttons $< 20\text{ pF}$, Button Scan Rate = 362 ms, with Response Time optimized, Normal Noise Immunity level, Medium CSx sensitivity |

Notes

8. When V_{DD} remains in the range of 1.75 V to 1.9 V for more than 50 μs , the slew rate (when moving from the 1.75 V to 1.9 V range to greater than 2 V) must be slower than 1 V/500 μs . This helps to avoid triggering POR. The only other restriction on slew rates for any other voltage range or transition is the SRPOWER_UP parameter.
9. After power down, ensure that V_{DD} falls below 100 mV before powering back up
10. For proper CapSense block functionality, if the drop in V_{DD} exceeds 5% of the base V_{DD} , the rate at which V_{DD} drops should not exceed 200 mV/s. Base V_{DD} can be between 1.8 V and 5.5 V.

DC General Purpose I/O Specifications

These tables list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 3.0 V to 5.5 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 85\text{ }^{\circ}\text{C}$, 2.4 V to 3.0 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 85\text{ }^{\circ}\text{C}$, or 1.71 V to 2.4 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 85\text{ }^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V and 3.3 V at 25 °C and are for design guidance only.

Table 12. 3.0 V to 5.5 V DC General Purpose I/O Specifications

| Parameter | Description | Min | Typ | Max | Unit | Notes |
|------------------|--|------------------------|-----|------|------|--|
| V _{OH1} | High output voltage on GPO0–GPO9 (except GPO5) | V _{DD} – 0.20 | – | – | V | I _{OH} ≤ 10 μA, maximum of 10-mA source current in all I/Os |
| V _{OH2} | High output voltage on GPO0–GPO9 (except GPO5) | V _{DD} – 0.90 | – | – | V | I _{OH} = 1 mA, maximum of 20-mA source current in all I/Os |
| V _{OH3} | High output voltage on GPO5, BuzzerOut0, BuzzerOut1, HostControlGPO0, HostControlGPO1 pins | V _{DD} – 0.20 | – | – | V | I _{OH} ≤ 10 μA, maximum of 10-mA source current in all I/Os |
| V _{OH4} | High output voltage on GPO5, BuzzerOut0, BuzzerOut1, HostControlGPO0, HostControlGPO1 pins | V _{DD} – 0.90 | – | – | V | I _{OH} = 5 mA, maximum of 20 mA source current in all I/Os |
| V _{OL} | Low output voltage | – | – | 0.75 | V | I _{OL} = 25 mA, V _{DD} > 3.3 V, maximum of 60-mA sink current on GPO0, GPO1, GPO2, GPO3, GPO4, BuzzerOut0, HostControlGPO0 pins and 60-mA sink current on GPO5, GPO6, GPO7, GPO8, GPO9, BuzzerOut1, HostControlGPO1 pins |
| V _{IL} | Input low voltage | – | – | 0.80 | V | |
| V _{IH} | Input high voltage | 2.00 | – | – | V | |

Table 13. 2.4 V to 3.0 V DC General Purpose I/O Specifications

| Parameter | Description | Min | Typ | Max | Unit | Notes |
|------------------|--|------------------------|-----|------|------|--|
| V _{OH1} | High output voltage on GPO0–GPO9 (except GPO5) | V _{DD} – 0.20 | – | – | V | I _{OH} ≤ 10 μA, maximum of 10-mA source current in all I/Os |
| V _{OH2} | High output voltage on GPO0–GPO9 (except GPO5) | V _{DD} – 0.40 | – | – | V | I _{OH} = 0.2 mA, maximum of 10-mA source current in all I/Os |
| V _{OH3} | High output voltage on GPO5, BuzzerOut0, BuzzerOut1, HostControlGPO0, HostControlGPO1 pins | V _{DD} – 0.20 | – | – | V | I _{OH} ≤ 10 μA, maximum of 10-mA source current in all I/Os |
| V _{OH4} | High output voltage on GPO5, BuzzerOut0, BuzzerOut1, HostControlGPO0, HostControlGPO1 pins | V _{DD} – 0.50 | – | – | V | I _{OH} = 2 mA, maximum of 10-mA source current in all I/Os |
| V _{OL} | Low output voltage | – | – | 0.75 | V | I _{OL} = 10 mA, maximum of 30-mA sink current on GPO0, GPO1 GPO2, GPO3, GPO4, BuzzerOut0, HostControlGPO0 pins and 30 mA sink current on GPO5, GPO6, GPO7, GPO8, GPO9, BuzzerOut1, HostControlGPO1 pins |
| V _{IL} | Input low voltage | – | – | 0.72 | V | |
| V _{IH} | Input high voltage | 1.40 | – | – | V | |

Table 14. 1.71 V to 2.4 V DC General Purpose I/O Specifications

| Parameter | Description | Min | Typ | Max | Unit | Notes |
|------------------|--|------------------------|-----|-----------------------|------|---|
| V _{OH1} | High output voltage on GPO0–GPO9 (except GPO5) | V _{DD} – 0.20 | – | – | V | I _{OH} = 10 μA, maximum of 10-mA source current in all I/Os |
| V _{OH2} | High output voltage on GPO0–GPO9 (except GPO5) | V _{DD} – 0.50 | – | – | V | I _{OH} = 0.5 mA, maximum of 10-mA source current in all I/Os |
| V _{OH3} | High output voltage on GPO5, BuzzerOut0, BuzzerOut1, HostControlGPO0, HostControlGPO1 pins | V _{DD} – 0.20 | – | – | V | I _{OH} = 100 μA, maximum of 10-mA source current in all I/Os |
| V _{OH4} | High output voltage on GPO5, BuzzerOut0, BuzzerOut1, HostControlGPO0, HostControlGPO1 pins | V _{DD} – 0.50 | – | – | V | I _{OH} = 2 mA, maximum of 10-mA source current in all I/Os |
| V _{OL} | Low output voltage | – | – | 0.4 | V | I _{OL} = 5 mA, maximum of 30-mA sink current on GPO0, GPO1 GPO2, GPO3, GPO4, BuzzerOut0, HostControlGPO0 pins and 20 mA sink current on GPO5, GPO6, GPO7, GPO8, GPO9, BuzzerOut1, HostControlGPO1 pins |
| V _{IL} | Input low voltage | – | – | 0.3 x V _{DD} | V | |
| V _{IH} | Input high voltage | 0.65 x V _{DD} | – | – | V | |

DC I²C Specifications

This table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 3.0 V to 5.5 V and –40 °C ≤ T_A ≤ 85 °C, 2.4 V to 3.0 V and –40 °C ≤ T_A ≤ 85 °C, & 1.71 V to 2.4 V and –40 °C ≤ T_A ≤ 85 °C, respectively. Typical parameters apply to 5 V and 3.3 V at 25 °C and are for design guidance only.

Table 15. 3.0 V to 5.5 V DC General Purpose IO Specifications

| Symbol | Description | Min | Typ | Max | Unit | Notes |
|--------------------|------------------|------------------------|-----|------------------------|------|----------------------------------|
| V _{IL12C} | Input low level | – | – | 0.25 x V _{DD} | V | 3.1 V ≤ V _{DD} ≤ 5.5 V |
| | | – | – | 0.3 x V _{DD} | V | 2.5 V ≤ V _{DD} ≤ 3.0 V |
| | | – | – | 0.3 x V _{DD} | V | 1.71 V ≤ V _{DD} ≤ 2.4 V |
| V _{IH12C} | Input high level | 0.65 x V _{DD} | – | – | V | 1.71 V ≤ V _{DD} ≤ 5.5 V |

AC Electrical Specifications

AC Chip-Level Specifications

The following table lists guaranteed maximum and minimum specifications for the entire voltage and temperature ranges.

Table 16. AC Chip-Level Specifications

| Parameter | Description | Min | Max | Unit | Notes |
|------------------------|---|-----|-----|------|---|
| SR _{POWER_UP} | Power supply slew rate | - | 250 | V/ms | V _{DD} slew rate during power up. |
| T _{XRST} | External reset pulse width at power-up | 1 | | ms | Applicable after device power supply is active |
| T _{XRST2} | External reset pulse width after power-up | 10 | | μs | Applicable after device V _{DD} has reached max value |

AC General Purpose I/O Specifications

The following table lists guaranteed maximum and minimum specifications for the entire voltage and temperature ranges.

Table 17. AC General Purpose I/O Specifications

| Parameter | Description | Min | Typ | Max | Unit | Notes |
|--------------------|---|-----|-----|-----|------|---|
| T _{Rise1} | Rise Time, Strong Mode on GPO0–GPO9 (except GPO5), Cload = 50 pF | 15 | – | 80 | ns | V _{DD} = 3.0 to 3.6 V, 10% to 90% |
| T _{Rise2} | Rise Time, Strong Mode on GPO5, BuzzerOut0, BuzzerOut1, HostControlGPO0, HostControlGPO1 pins, Cload = 50 pF | 10 | – | 50 | ns | V _{DD} = 3.0 to 3.6 V, 10% to 90% |
| T _{Rise3} | Rise Time, Strong Mode Low Supply on GPO0–GPO9 (except GPO5), Cload = 50 pF | 15 | – | 80 | ns | V _{DD} = 1.71 to 3.0 V, 10% to 90% |
| T _{Rise4} | Rise Time, Strong Mode Low Supply on GPO5, BuzzerOut0, BuzzerOut1, HostControlGPO0, HostControlGPO1 pins, Cload = 50 pF | 10 | – | 80 | ns | V _{DD} = 1.71 to 3.0 V, 10% to 90% |
| T _{Fall1} | Fall Time, Strong Mode, Cload = 50 pF on all GPOs, BuzzerOut pins, HostControlGPO pins | 10 | – | 50 | ns | V _{DD} = 3.0 to 3.6 V, 90% to 10% |
| T _{Fall2} | Fall Time, Strong Mode Low Supply, Cload = 50 pF on all GPOs, BuzzerOut pins, HostControlGPO pins | 10 | – | 70 | ns | V _{DD} = 1.71 to 3.0 V, 90% to 10% |

Flash Write Time Specifications

Unless otherwise specified in the following table, all limits guaranteed for V_{DD} = 5.0 V.

Table 18. Flash Write Time Specifications

| Parameter | Description | Min | Typ | Max | Unit | Notes |
|--------------------------|------------------------------|-----|-----|-----|------|------------------------------|
| T _{SAVE_FLASH1} | Time taken to write to flash | – | 45 | 120 | ms | T _A = 0 °C–100 °C |
| T _{SAVE_FLASH2} | Time taken to write to flash | – | 70 | 240 | ms | T _A = –40 °C–0 °C |

CapSense Specifications

Table 19. CapSense Specifications

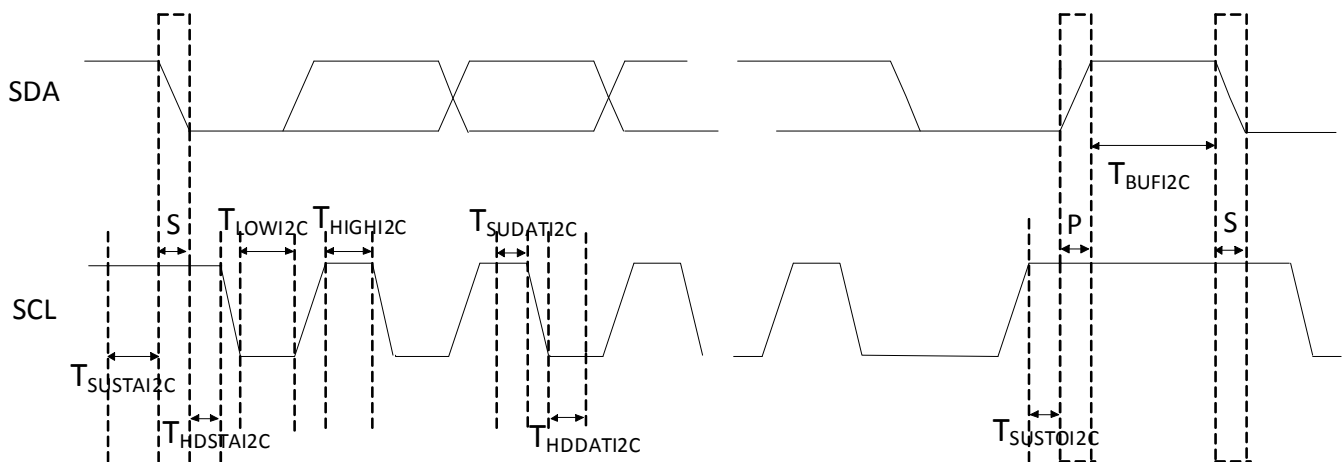
| Parameter | Description | Min | Max | Unit | Notes |
|-----------|--|------|-----------------------|----------|--|
| C_P | Parasitic capacitance | 5.0 | $(C_P+C_F)<40^{[11]}$ | pF | C_P is the total capacitance seen by the pin when no finger is present. C_P is sum of C_{BUTTON} , C_{TRACE} , and capacitance of the vias and C_{PIN} . |
| C_F | Finger capacitance | 0.25 | $(C_P+C_F)<40^{[11]}$ | pF | C_F is the capacitance added by the finger touch. |
| C_{PIN} | Capacitive load on pins as input | 0.5 | 7 | pF | |
| C_{MOD} | External modulating capacitor | 2 | 2.4 | nF | Mandatory for CapSense to work |
| R_S | Series resistor between pin and the button | – | 616 | Ω | Reduces the RF noise. |

I²C Specifications

Table 20. I²C Specifications

| Parameter | Description | Min | Max | Unit |
|----------------|--|-----|-----|---------|
| F_{SCL2C} | SCL clock frequency | 0 | 100 | kHz |
| $T_{SUSTA12C}$ | Setup time for a START condition | 4.7 | – | μ s |
| $T_{HDSTA12C}$ | Hold time for a START condition. After this period, the first clock pulse is generated | 4.0 | – | μ s |
| T_{LOW12C} | LOW period of the SCL clock | 4.7 | – | μ s |
| $T_{HIGH12C}$ | HIGH period of the SCL clock | 4.0 | – | μ s |
| $T_{HDDAT12C}$ | Data hold time | 0 | – | μ s |
| $T_{SUDAT12C}$ | Data setup time | 250 | – | ns |
| $T_{SUSTO12C}$ | Setup time for a STOP condition | 4.0 | – | μ s |
| T_{BUFI2C} | Bus-free time between a STOP and START condition | 4.7 | – | μ s |

Figure 43. Definition of Timing on the I²C Bus



S – Start condition
P – Stop condition

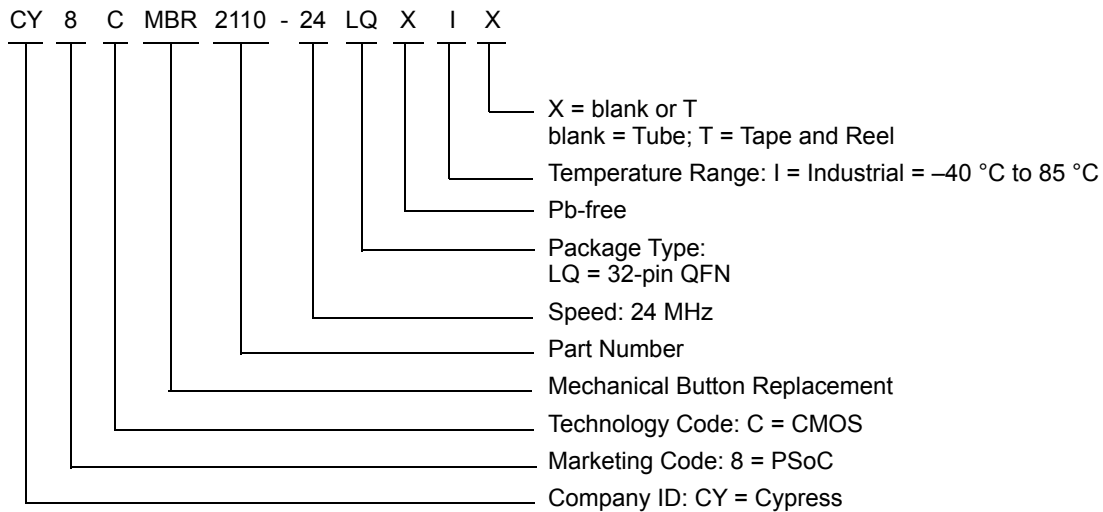
Note

11. The max value of parasitic capacitance is 40 pF when the temperature is above 0 °C, and 38 pF at –45 °C.

Ordering Information

| Ordering Code | Package Type | Operating Temperature | CapSense Inputs | GPO's | XRES Pin |
|---------------------|---|-----------------------|-----------------|-------|----------|
| CY8CMBR2110-24LQXI | 32 Pad (5 × 5 × 0.6 mm) QFN | Industrial | 10 | 10 | Yes |
| CY8CMBR2110-24LQXIT | 32 Pad (5 × 5 × 0.6 mm) QFN (tape and reel) | Industrial | 10 | 10 | Yes |

Ordering Code Definitions



Package Information

Thermal Impedance

Table 21. Thermal Impedances per Package

| Package | Typical θ_{JA} ^[12] |
|----------------------------|---------------------------------------|
| 32-Pin QFN ^[13] | 20 °C/W |

Solder Reflow Specifications

Table 22 shows the solder reflow temperature limits that must not be exceeded.

Table 22. Solder Reflow Specifications

| Package | Minimum Peak Temperature (T _C) | Maximum Time above T _C - 5 °C |
|------------|--|--|
| 32-Pin QFN | 260 °C | 30 seconds |

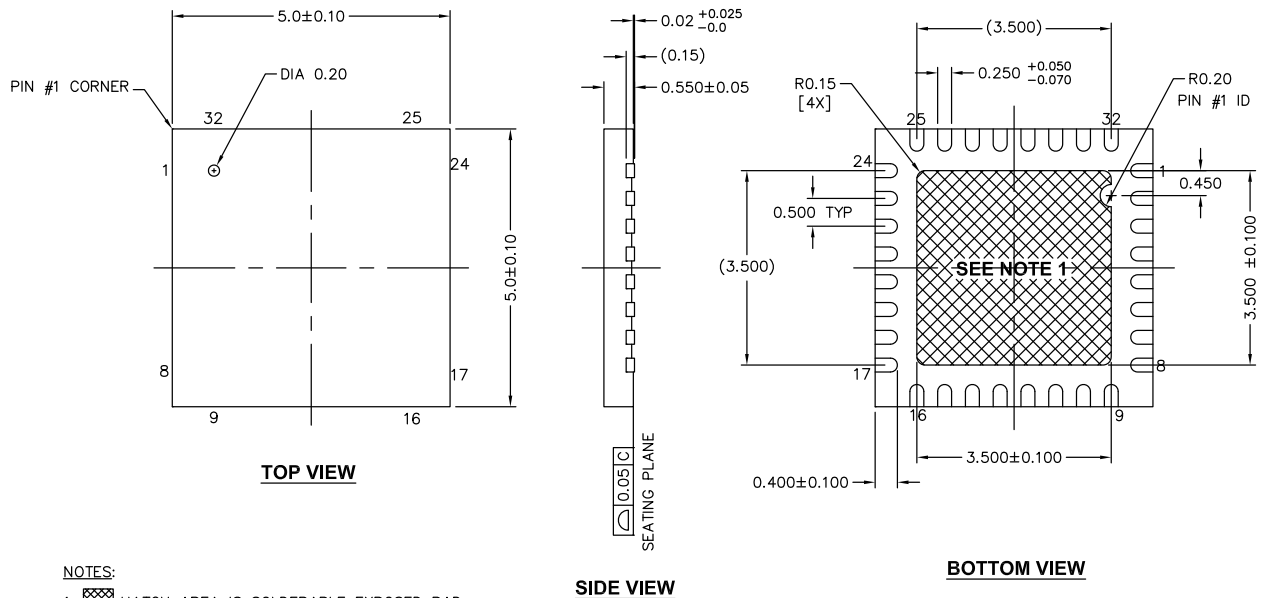
Notes

12. $T_J = T_A + \text{Power} \times \theta_{JA}$.

13. To achieve the thermal impedance specified for the QFN package, the center thermal pad must be soldered to the PCB ground plane.

Package Diagram

Figure 44. 32-pin QFN (5 × 5 × 0.55 mm) LQ32 3.5 × 3.5 E-Pad (Sawn) Package Outline, 001-42168



001-42168 *E

Appendix - Register Map

1. Operating Mode

| Address | Name | Bit7 | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 | Host Access ^[14] |
|---------|----------------------|------------------------|-------------------------|-------------------|-------------------------|----------------|------------------|-------------|-------------|-----------------------------|
| Op,00h | HOST_MODE | | | | Deep Sleep | Software Reset | Device_Mode[2:0] | | | RW:00 |
| Op,01h | HOST_CONTROL_OUTPUT | Host Control GPO3 | Host Control GPO2 | Host Control GPO1 | Host Control GPO0 | | | | | RW:00 |
| Op,02h | Reserved | | | | | | | | | #:?? |
| Op,03h | DEVICE_STAT | | Factory Defaults loaded | | | | | | | R:00 |
| Op,04h | BUTTON_CURRENT_STAT0 | CS7 Status | CS6 Status | CS5 Status | CS4 Status | CS3 Status | CS2 Status | CS1 Status | CS0 Status | R:00 |
| Op,05h | BUTTON_CURRENT_STAT1 | | | | | | | CS9 Status | CS8 Status | R:00 |
| Op,06h | Reserved | | | | | | | | | #:?? |
| Op,07h | BUTTON_LATCH_STAT0 | CS7 latched | CS6 latched | CS5 latched | CS4 latched | CS3 latched | CS2 latched | CS1 latched | CS0 latched | R:00 |
| Op,08h | BUTTON_LATCH_STAT1 | | | | | | | CS9 latched | CS8 latched | R:00 |
| Op,09h | Reserved | | | | | | | | | #:?? |
| Op,0Ah | Reserved | | | | | | | | | #:?? |
| Op,0Bh | Reserved | | | | | | | | | #:?? |
| Op,0Ch | Reserved | | | | | | | | | #:?? |
| Op,0Dh | Reserved | | | | | | | | | #:?? |
| Op,0Eh | Reserved | | | | | | | | | #:?? |
| Op,0Fh | Reserved | | | | | | | | | #:?? |
| Op,10h | Reserved | | | | | | | | | #:?? |
| Op,11h | Reserved | | | | | | | | | #:?? |
| Op,12h | Reserved | | | | | | | | | #:?? |
| Op,13h | Reserved | | | | | | | | | #:?? |
| Op,14h | Reserved | | | | | | | | | #:?? |
| Op,15h | Reserved | | | | | | | | | #:?? |
| Op,16h | Reserved | | | | | | | | | #:?? |
| Op,17h | Reserved | | | | | | | | | #:?? |
| Op,18h | Reserved | | | | | | | | | #:?? |
| Op,19h | Reserved | | | | | | | | | #:?? |
| Op,1Ah | CS_FLASH_MSB | | | | Checksum_Flash_MSB[7:0] | | | | | R:00 |
| Op,1Bh | CS_FLASH_LSB | | | | Checksum_Flash_LSB[7:0] | | | | | R:3B |
| Op,1Ch | CS_RAM_MSB | | | | Checksum_RAM_MSB[7:0] | | | | | R:00 |
| Op,1Dh | CS_RAM_LSB | | | | Checksum_RAM_LSB[7:0] | | | | | R:3B |
| Op,1Eh | DEVICE_ID | Device_ID[7:0] | | | | | | | | R:A1 |
| Op,1Fh | FW_REV | Firmware_revision[7:0] | | | | | | | | R:01 |

Note

14. Host Access is AB:XY

where:

AB = Read/Write access for the register

XY = Initial value of register on device power-on

For example:

RW:00 = The register is both Read/Write accessible, with initial value 00h.

R:A1 = The register is Read only, with initial value A1h.

#:?? = The register is reserved (no definite value stored)

The shaded areas represent reserved register bits.

1.1 HOST_MODE
Host Mode register
Individual Register Names and Addresses:
HOST_MODE: Op, 00h

| | | | | | | | | |
|------------|---|---|---|------------------------|------------------------|------------------|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | WC ^[15] : 0 | WC ^[15] : 0 | RW: 0 | | |
| Bit Name | | | | Deep Sleep | Software Reset | Device Mode[2:0] | | |

This register is used to set the device into deep sleep mode, do device software reset, and set the device operation mode. To know more about Software reset, refer to [CY8CMBR2110 Reset on page 24](#).

| Bit | Name | Description |
|---------------|----------------|--|
| 4 | Deep Sleep | This bit decides the device Deep Sleep entry and is auto-cleared by the CapSense controller after the device exits from Deep Sleep. To know more about Deep Sleep, refer to Power Consumption and Operating Modes on page 21 . |
| | | 0 Device is in normal sleep 1 Initiate deep sleep mode |
| 3 | Software Reset | This bit resets the CapSense controller |
| | | 0 No impact 1 Resets the CapSense controller |
| 2:0 | Device Mode | These bits decide the CapSense controller's device mode |
| | | 000 Operating mode |
| | | 001 LED configuration mode |
| | | 010 Device configuration mode |
| | | 011 Production line test mode |
| | | 100 Debug Data mode |
| | | 101 Not valid |
| | | 110 Not valid |
| 111 Not valid | | |

Note

15. Device clears the Write Clear (WC) bit automatically after the required operation.

1.2 HOST_CONTROL_OUTPUT

Host Control Output register

Individual Register Names and Addresses:

HOST_CONTROL_OUTPUT: Op, 01h

| | | | | | | | | |
|------------|-------------------|-------------------|-------------------|-------------------|---|---|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | RW: 0 | | | | | | | |
| Bit Name | Host Control GPO3 | Host Control GPO2 | Host Control GPO1 | Host Control GPO0 | | | | |

This register is used to control the logic levels of the Host Controlled GPOs. To know more, refer to [Host Controlled GPOs on page 17](#).

| Bit | Name | Description |
|-----|-------------------|--|
| 7 | Host Control GPO3 | This bit controls the logic level of the host control GPO3 |
| | | 0 Host control GPO3 is driven logic low |
| | | 1 Host control GPO3 is driven logic high |
| 6 | Host Control GPO2 | This bit controls the logic level of the host control GPO2 |
| | | 0 Host control GPO2 is driven logic low |
| | | 1 Host control GPO2 is driven logic high |
| 5 | Host Control GPO1 | This bit controls the logic level of the host control GPO1 |
| | | 0 Host control GPO1 is driven logic low |
| | | 1 Host control GPO1 is driven logic high |
| 4 | Host Control GPO0 | This bit controls the logic level of the host control GPO0 |
| | | 0 Host control GPO0 is driven logic low |
| | | 1 Host control GPO0 is driven logic high |

1.3 DEVICE_STAT

Device Status register

Individual Register Names and Addresses:

DEVICE_STAT: Op, 03h

| | | | | | | | | |
|------------|---|-------------------------|---|---|---|---|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | R: 0 | | | | | | |
| Bit Name | | Factory Defaults loaded | | | | | | |

This register is used to read whether the factory defaults or the user configuration is loaded at power-up.

| Bit | Name | Description |
|-----|-------------------------|---|
| 6 | Factory defaults loaded | This bit decides whether factory defaults or the user configuration is loaded at power up |
| | | 0 User configuration is loaded at power-up of device |
| | | 1 Factory default configuration is loaded at power-up of device |

1.4 BUTTON_CURRENT_STATx

CapSense Button Current Status registers

Individual Register Names and Addresses:

| BUTTON_CURRENT_STAT0: Op, 04h | | | | BUTTON_CURRENT_STAT1: Op, 05h | | | | |
|-------------------------------|------|------|------|-------------------------------|------|------|------|------|
| BUTTON_CURRENT_STAT0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 |
| Bit Name | CS7 | CS6 | CS5 | CS4 | CS3 | CS2 | CS1 | CS0 |

| | | | | | | | | |
|----------------------|---|---|---|---|---|---|------|------|
| BUTTON_CURRENT_STAT1 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | | | | R: 0 | R: 0 |
| Bit Name | | | | | | | CS9 | CS8 |

Reading from these registers gives the button ON/OFF status.

| Bit | Name | Description |
|-----|------|--|
| x | CSx | This bit gives the button ON/OFF status 0 Button OFF 1 Button ON |

1.5 BUTTON_LATCH_STATx

CapSense Button Latched Status registers

Individual Register Names and Addresses:

| BUTTON_LATCH_STAT0: Op, 07h | | | | BUTTON_LATCH_STAT1: Op, 08h | | | | |
|-----------------------------|------|------|------|-----------------------------|------|------|------|------|
| BUTTON_LATCH_STAT0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 |
| Bit Name | CS7 | CS6 | CS5 | CS4 | CS3 | CS2 | CS1 | CS0 |

| | | | | | | | | |
|--------------------|---|---|---|---|---|---|------|------|
| BUTTON_LATCH_STAT1 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | | | | R: 0 | R: 0 |
| Bit Name | | | | | | | CS9 | CS8 |

Reading from these registers gives the button latched status. To know more about button latched status, refer to [Latch Status Read on page 14](#).

1.6 CHECKSUM_FLASH_xxx
FLASH Settings Checksum registers
Individual Register Names and Addresses:
CHECKSUM_FLASH_MSB: Op, 1Ah
CHECKSUM_FLASH_LSB: Op, 1Bh

| | | | | | | | | |
|--------------------|-------------------------|---|---|---|---|---|---|---|
| CHECKSUM_FLASH_MSB | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | R: 00 | | | | | | | |
| Bit Name | CheckSum_Flash_MSB[7:0] | | | | | | | |

| | | | | | | | | |
|--------------------|-------------------------|---|---|---|---|---|---|---|
| CHECKSUM_FLASH_LSB | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | R: 3Bh | | | | | | | |
| Bit Name | CheckSum_Flash_LSB[7:0] | | | | | | | |

Reading 2 bytes from registers 1Ah, 1Bh gives the checksum of settings stored in the flash. Checksum is the sum of all the registers stored in flash for the Device Configuration (Reg 0x01-0x1D) and LED Configuration modes (Reg 0x01-0x1F). After the settings are saved to flash, the default settings change to the new value stored in flash.

1.7 CHECKSUM_RAM_xxx
RAM Settings Checksum registers
Individual Register Names and Addresses:
CHECKSUM_RAM_MSB: Op, 1Ch
CHECKSUM_RAM_LSB: Op, 1Dh

| | | | | | | | | |
|------------------|-----------------------|---|---|---|---|---|---|---|
| CHECKSUM_RAM_MSB | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | R: 00 | | | | | | | |
| Bit Name | CheckSum_RAM_MSB[7:0] | | | | | | | |

| | | | | | | | | |
|------------------|-----------------------|---|---|---|---|---|---|---|
| CHECKSUM_RAM_LSB | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | R: 3Bh | | | | | | | |
| Bit Name | CheckSum_RAM_LSB[7:0] | | | | | | | |

Reading 2 bytes from registers 1Ch, 1Dh gives the checksum of settings stored in the RAM. Checksum is the sum of all the registers in RAM for the Device Configuration (Reg 0x01-0x1D) and LED Configuration (Reg 0x01-0x1F) modes.

1.8 DEVICE_ID

Device Identity register

Individual Register Names and Addresses:

DEVICE_ID: Op, 1Eh

| | | | | | | | | |
|------------|----------------|---|---|---|---|---|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | R: A1 | | | | | | | |
| Bit Name | Device ID[7:0] | | | | | | | |

Reading 1 byte from this register gives the unique device ID through which the device can be identified. Device ID for this device is "0xA1".

1.9 FW_REV

Firmware Revision register

Individual Register Names and Addresses:

FW_REV: Op, 1Fh

| | | | | | | | | |
|------------|----------------|---|---|---|---|---|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | R: 01 | | | | | | | |
| Bit Name | Device ID[7:0] | | | | | | | |

Reading 1 byte from this register gives the firmware revision.

2. LED Configuration Mode

| Address | Name | Bit7 | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 | Host Access ^[16] |
|---------|------------------------------|-------------------------------|------------------------------|-----------------------------------|--------------------|---------------------------------|-----------------------------|------------------------------|-------|-----------------------------|
| Lc,00h | HOST_MODE | | | | | | Device_Mode[2:0] | | | RW:01 |
| Lc,01h | LED_CONFIG | Last Button LED Effect Enable | Analog Voltage Output enable | Standby Mode LED Brightness [5:4] | LED ON Time enable | Button Touch LED Effects enable | Power On LED effects enable | Power On LED effect sequence | | RW:00 |
| Lc,02h | LED_FAD_PERIOD1 | Period[7:0] | | | | | | | | RW:00 |
| Lc,03h | LED_FAD_PERIOD2 | Period[7:0] | | | | | | | | RW:00 |
| Lc,04h | LED_FAD_PERIOD3 | Period[7:0] | | | | | | | | RW:00 |
| Lc,05h | LED_FAD_PERIOD4 | Period[7:0] | | | | | | | | RW:00 |
| Lc,06h | GPO000_LED_DIM_CONFIG1 | Ramp_Up_Time[7:6] | | High_Brightness[5:3] | | LED_Scenario_Repeat[2:0] | | | RW:00 | |
| Lc,07h | GPO000_LED_DIM_CONFIG2 | Ramp_Down_Time[7:6] | | Low_Brightness[5:3] | | Breathing effect | High_Time | Low_Time | RW:00 | |
| Lc,08h | GPO123_LED_DIM_CONFIG1 | Ramp_Up_Time[7:6] | | High_Brightness[5:3] | | LED_Scenario_Repeat[2:0] | | | RW:00 | |
| Lc,09h | GPO123_LED_DIM_CONFIG2 | Ramp_Down_Time[7:6] | | Low_Brightness[5:3] | | Breathing effect | High_Time | Low_Time | RW:00 | |
| Lc,0Ah | GPO456_LED_DIM_CONFIG1 | Ramp_Up_Time[7:6] | | High_Brightness[5:3] | | LED_Scenario_Repeat[2:0] | | | RW:00 | |
| Lc,0Bh | GPO456_LED_DIM_CONFIG2 | Ramp_Down_Time[7:6] | | Low_Brightness[5:3] | | Breathing effect | High_Time | Low_Time | RW:00 | |
| Lc,0Ch | GPO789_LED_DIM_CONFIG1 | Ramp_Up_Time[7:6] | | High_Brightness[5:3] | | LED_Scenario_Repeat[2:0] | | | RW:00 | |
| Lc,0Dh | GPO789_LED_DIM_CONFIG2 | Ramp_Down_Time[7:6] | | Low_Brightness[5:3] | | Breathing effect | High_Time | Low_Time | RW:00 | |
| Lc,0Eh | Reserved | | | | | | | | | #:?? |
| Lc,0Fh | Reserved | | | | | | | | | #:?? |
| Lc,10h | Reserved | | | | | | | | | #:?? |
| Lc,11h | Reserved | | | | | | | | | #:?? |
| Lc,12h | GPO000_PWRON_LED_DIM_CONFIG1 | Ramp_Up_Time[7:6] | | High_Brightness[5:3] | | LED_Scenario_Repeat[2:0] | | | RW:00 | |
| Lc,13h | GPO000_PWRON_LED_DIM_CONFIG2 | Ramp_Down_Time[7:6] | | Low_Brightness[5:3] | | High_Time[2:1] | | Low_Time | RW:00 | |
| Lc,14h | GPO123_PWRON_LED_DIM_CONFIG1 | Ramp_Up_Time[7:6] | | High_Brightness[5:3] | | LED_Scenario_Repeat[2:0] | | | RW:00 | |
| Lc,15h | GPO123_PWRON_LED_DIM_CONFIG2 | Ramp_Down_Time[7:6] | | Low_Brightness[5:3] | | High_Time[2:1] | | Low_Time | RW:00 | |
| Lc,16h | GPO456_PWRON_LED_DIM_CONFIG1 | Ramp_Up_Time[7:6] | | High_Brightness[5:3] | | LED_Scenario_Repeat[2:0] | | | RW:00 | |
| Lc,17h | GPO456_PWRON_LED_DIM_CONFIG2 | Ramp_Down_Time[7:6] | | Low_Brightness[5:3] | | High_Time[2:1] | | Low_Time | RW:00 | |
| Lc,18h | GPO789_PWRON_LED_DIM_CONFIG1 | Ramp_Up_Time[7:6] | | High_Brightness[5:3] | | LED_Scenario_Repeat[2:0] | | | RW:00 | |
| Lc,19h | GPO789_PWRON_LED_DIM_CONFIG2 | Ramp_Down_Time[7:6] | | Low_Brightness[5:3] | | High_Time[2:1] | | Low_Time | RW:00 | |
| Lc,1Ah | Reserved | | | | | | | | | #:?? |
| Lc,1Bh | Reserved | | | | | | | | | #:?? |
| Lc,1Ch | Reserved | | | | | | | | | #:?? |
| Lc,1Dh | Reserved | | | | | | | | | #:?? |
| Lc,1Eh | Reserved | | | | | | | | | #:?? |
| Lc,1Fh | Reserved | | | | | | | | | #:?? |

Note

16. Host Access is AB:XY

where:

AB = Read/Write access for the register

XY = Initial value of register on device power-on

For example:

RW:00 = The register is both Read/Write accessible, with initial value 00h.

R:A1 = The register is Read only, with initial value A1h.

#:?? = The register is reserved (no definite value stored)

The shaded areas represent reserved register bits.

2.1 HOST_MODE

Host Mode register

Individual Register Names and Addresses:

HOST_MODE: Lc, 00h

| | | | | | | | | |
|------------|---|---|---|---|---|------------------|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | | | RW: 1 | | |
| Bit Name | | | | | | Device Mode[2:0] | | |

This register is used to set the device operation mode.

| Bit | Name | Description |
|-----|-------------|---|
| 2:0 | Device Mode | These bits decide the CapSense controller device mode |
| | | 000 Operating mode |
| | | 001 LED configuration mode |
| | | 010 Device configuration mode |
| | | 011 Production line test mode |
| | | 100 Debug Data mode |
| | | 101 Not valid |
| | | 110 Not valid |
| | | 111 Not valid |

2.2 LED_CONFIG

LED Effects Configuration register

Individual Register Names and Addresses:

LED_CONFIG: Lc, 01h

| | | | | | | | | |
|------------|-------------------------------|------------------------------|----------------------------------|---|--------------------|---------------------------------|-----------------------------|-------------------------------|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | RW: 0 | RW: 0 | RW: 0 | | RW: 0 | RW: 0 | RW: 0 | RW: 0 |
| Bit Name | Last Button LED Effect enable | Analog Voltage Output Enable | Standby Mode LED brightness[5:4] | | LED On time Enable | Button Touch LED effects Enable | Power on LED effects enable | Power on LED effects Sequence |

This register is used to enable/disable [Button Touch LED Effects](#) and [Power-on LED Effects](#), and decides the power-on LED effect sequence, [LED ON Time](#) enable/disable, sets the [Standby Mode LED Brightness](#), analog voltage output enable/disable, and [Last Button LED Effect](#) enable/disable.

| Bit | Name | Description | | | | | | | | | | |
|------|---------------------------------|---|----------------------------------|----------------|------|----|------|-----|------|-----|------|-----|
| 7 | Last Button LED Effect enable | This bit decides whether LED effects should continue on all the GPOs or only on the last button touched | | | | | | | | | | |
| | | 0 LED effects on any button touched based on the settings | | | | | | | | | | |
| | | 1 LED effects only on the last button touched | | | | | | | | | | |
| 6 | Analog Voltage Output enable | This bit decides whether Output pins can be used as open drain switches | | | | | | | | | | |
| | | 0 Output pins cannot be used for Analog output voltage | | | | | | | | | | |
| | | 1 Output pins can be used for Analog output voltage | | | | | | | | | | |
| 5:4 | Standby Mode LED Brightness | These bits set the Standby Mode LED brightness | | | | | | | | | | |
| | | <table border="1"> <thead> <tr> <th>Standby Mode LED Brightness Bits</th> <th>LED Brightness</th> </tr> </thead> <tbody> <tr> <td>0b00</td> <td>0%</td> </tr> <tr> <td>0b01</td> <td>20%</td> </tr> <tr> <td>0b10</td> <td>30%</td> </tr> <tr> <td>0b11</td> <td>50%</td> </tr> </tbody> </table> | Standby Mode LED Brightness Bits | LED Brightness | 0b00 | 0% | 0b01 | 20% | 0b10 | 30% | 0b11 | 50% |
| | | Standby Mode LED Brightness Bits | LED Brightness | | | | | | | | | |
| | | 0b00 | 0% | | | | | | | | | |
| | | 0b01 | 20% | | | | | | | | | |
| 0b10 | 30% | | | | | | | | | | | |
| 0b11 | 50% | | | | | | | | | | | |
| | | | | | | | | | | | | |
| | | | | | | | | | | | | |
| | | | | | | | | | | | | |
| 3 | LED On time Enable | This bit enables the LED ON time after button is released | | | | | | | | | | |
| | | 0 LED ON time disabled | | | | | | | | | | |
| | | 1 LED ON time enabled and LED ON time value is taken from the LED_FAD_PERIOD1 register. | | | | | | | | | | |
| 2 | Button Touch LED effects enable | This bit enables or disables the Button Touch LED effects. If this bit is not set, settings from register 0x06 – 0x0D are ignored. | | | | | | | | | | |
| | | 0 Disable the Button Touch LED effects | | | | | | | | | | |
| | | 1 Enable the Button Touch LED effects | | | | | | | | | | |
| 1 | Power on LED effects enable | This bit enables or disables the Power-on LED effects. If this bit is not set, settings from register 0x12 – 0x19 are ignored. | | | | | | | | | | |
| | | 0 Disable the Power-on LED effects | | | | | | | | | | |
| | | 1 Enable the Power-on LED effects | | | | | | | | | | |
| 0 | Power on LED effect sequence | This bit decides the Power-on LED Effects sequence on GPOs. | | | | | | | | | | |
| | | 0 Power on LED effects on all GPOs appear concurrently | | | | | | | | | | |
| | | 1 Power on LED effects on all GPOs appear sequentially. The sequence is GPO0>GPO1>.....GPO9 | | | | | | | | | | |

2.3 LED_FAD_PERIODx

LED Effects Global Timing registers

Individual Register Names and Addresses:

LED_FAD_PERIOD1: Lc, 02h

LED_FAD_PERIOD2: Lc, 03h

LED_FAD_PERIOD3: Lc, 04h

LED_FAD_PERIOD4: Lc, 05h

| | | | | | | | | |
|------------|-------------|---|---|---|---|---|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | RW: 00 | | | | | | | |
| Bit Name | PERIOD[7:0] | | | | | | | |

This register is used to set the LED effect timings. Each step increment in this register corresponds to increment of 20 ms in the LED effect timings.

2.4 GPOxxx_LED_DIM_CONFIG1

LED Effects configuration registers

Individual Register Names and Addresses:

GPO000_LED_DIM_CONFIG1:Lc,06h

GPO123_LED_DIM_CONFIG1:Lc,08h

GPO456_LED_DIM_CONFIG1:Lc,0Ah

GPO789_LED_DIM_CONFIG1:Lc,0Ch

| | | | | | | | | |
|------------|-----------------------|---|----------------------|---|---|--------------------------|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | RW:00 | | RW: 00 | | | RW: 00 | | |
| Bit Name | T _{RU} [7:6] | | HIGH_BRIGHTNESS[5:3] | | | LED_SCENARIO_REPEAT[2:0] | | |

This register is used to set the ramp up time, high brightness intensity, and the LED scenario repeat rate for the LED effects. The following table gives the list of registers and the corresponding GPOs whose LED Effects are controlled by the register settings.

| Register Name | GPOs with Defined Effect in the Register |
|------------------------|--|
| GPO000_LED_DIM_CONFIG1 | GPO0 |
| GPO123_LED_DIM_CONFIG1 | GPO1, GPO2, GPO3 |
| GPO456_LED_DIM_CONFIG1 | GPO4, GPO5, GPO6 |
| GPO789_LED_DIM_CONFIG1 | GPO7, GPO8, GPO9 |

| Bit | Name | Description | | | | | | | | | | | | | | | | | | |
|--------------------------|--------------------------|--|--------------------------|--------------------------|-------|-----------------|-------|-----------------|-------|-----------------|-------|-----------------|-------|-----|-------|-----|-------|-----|-------|----|
| 7:6 | T _{RU} [7:6] | <p>These bits decide the global setting time that will be used as ramp up time</p> <table border="1"> <thead> <tr> <th>T_{RU}[7:6]</th> <th>Ramp Up Time</th> </tr> </thead> <tbody> <tr> <td>0b00</td> <td>LED_FAD_PERIOD1</td> </tr> <tr> <td>0b01</td> <td>LED_FAD_PERIOD2</td> </tr> <tr> <td>0b10</td> <td>LED_FAD_PERIOD3</td> </tr> <tr> <td>0b11</td> <td>LED_FAD_PERIOD4</td> </tr> </tbody> </table> | T _{RU} [7:6] | Ramp Up Time | 0b00 | LED_FAD_PERIOD1 | 0b01 | LED_FAD_PERIOD2 | 0b10 | LED_FAD_PERIOD3 | 0b11 | LED_FAD_PERIOD4 | | | | | | | | |
| T _{RU} [7:6] | Ramp Up Time | | | | | | | | | | | | | | | | | | | |
| 0b00 | LED_FAD_PERIOD1 | | | | | | | | | | | | | | | | | | | |
| 0b01 | LED_FAD_PERIOD2 | | | | | | | | | | | | | | | | | | | |
| 0b10 | LED_FAD_PERIOD3 | | | | | | | | | | | | | | | | | | | |
| 0b11 | LED_FAD_PERIOD4 | | | | | | | | | | | | | | | | | | | |
| 5:3 | HIGH_BRIGHTNESS[5:3] | <p>These bits decide what should be the high brightness state intensity</p> <table border="1"> <thead> <tr> <th>HIGH_BRIGHTNESS[5:3]</th> <th>Ramp Up Target Intensity</th> </tr> </thead> <tbody> <tr> <td>0b000</td> <td>100%</td> </tr> <tr> <td>0b001</td> <td>90%</td> </tr> <tr> <td>0b010</td> <td>80%</td> </tr> <tr> <td>0b011</td> <td>65%</td> </tr> <tr> <td>0b100</td> <td>50%</td> </tr> <tr> <td>0b101</td> <td>40%</td> </tr> <tr> <td>0b110</td> <td>20%</td> </tr> <tr> <td>0b111</td> <td>0%</td> </tr> </tbody> </table> | HIGH_BRIGHTNESS[5:3] | Ramp Up Target Intensity | 0b000 | 100% | 0b001 | 90% | 0b010 | 80% | 0b011 | 65% | 0b100 | 50% | 0b101 | 40% | 0b110 | 20% | 0b111 | 0% |
| HIGH_BRIGHTNESS[5:3] | Ramp Up Target Intensity | | | | | | | | | | | | | | | | | | | |
| 0b000 | 100% | | | | | | | | | | | | | | | | | | | |
| 0b001 | 90% | | | | | | | | | | | | | | | | | | | |
| 0b010 | 80% | | | | | | | | | | | | | | | | | | | |
| 0b011 | 65% | | | | | | | | | | | | | | | | | | | |
| 0b100 | 50% | | | | | | | | | | | | | | | | | | | |
| 0b101 | 40% | | | | | | | | | | | | | | | | | | | |
| 0b110 | 20% | | | | | | | | | | | | | | | | | | | |
| 0b111 | 0% | | | | | | | | | | | | | | | | | | | |
| 2:0 | LED_SCENARIO_REPEAT[2:0] | <p>These bits decide how many times the LED effects should be repeated after the corresponding button is released.</p> <table border="1"> <thead> <tr> <th>LED_SCENARIO_REPEAT[2:0]</th> <th>LED Scenario Repeat Rate</th> </tr> </thead> <tbody> <tr> <td>0b000</td> <td>0</td> </tr> <tr> <td>0b001</td> <td>1</td> </tr> <tr> <td>0b010</td> <td>2</td> </tr> <tr> <td>0b011</td> <td>4</td> </tr> <tr> <td>0b100</td> <td>6</td> </tr> <tr> <td>0b101</td> <td>10</td> </tr> <tr> <td>0b110</td> <td>15</td> </tr> <tr> <td>0b111</td> <td>20</td> </tr> </tbody> </table> | LED_SCENARIO_REPEAT[2:0] | LED Scenario Repeat Rate | 0b000 | 0 | 0b001 | 1 | 0b010 | 2 | 0b011 | 4 | 0b100 | 6 | 0b101 | 10 | 0b110 | 15 | 0b111 | 20 |
| LED_SCENARIO_REPEAT[2:0] | LED Scenario Repeat Rate | | | | | | | | | | | | | | | | | | | |
| 0b000 | 0 | | | | | | | | | | | | | | | | | | | |
| 0b001 | 1 | | | | | | | | | | | | | | | | | | | |
| 0b010 | 2 | | | | | | | | | | | | | | | | | | | |
| 0b011 | 4 | | | | | | | | | | | | | | | | | | | |
| 0b100 | 6 | | | | | | | | | | | | | | | | | | | |
| 0b101 | 10 | | | | | | | | | | | | | | | | | | | |
| 0b110 | 15 | | | | | | | | | | | | | | | | | | | |
| 0b111 | 20 | | | | | | | | | | | | | | | | | | | |

2.5 GPOxxx_LED_DIM_CONFIG2

LED Effects configuration registers

Individual Register Names and Addresses:

GPO000_LED_DIM_CONFIG2:Lc, 07h GPO123_LED_DIM_CONFIG2:Lc,09h GPO456_LED_DIM_CONFIG2:Lc,0Bh
 GPO789_LED_DIM_CONFIG2:Lc,0Dh

| | | | | | | | | |
|------------|-----------------------|---|---------------------|---|---|------------------|----------------|----------------|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | RW: 00 | | RW: 00 | | | RW: 0 | RW: 0 | RW: 0 |
| Bit Name | T _{RD} [7:6] | | LOW_BRIGHTNESS[5:3] | | | Breathing effect | T _H | T _L |

These registers are used to set the ramp down time, low brightness intensity, the high brightness time, and the low brightness time for the LED effects. These registers also control the LED Breathing effect. The following table gives information about which GPO's LED effects are controlled by which register settings.

| Register Name | GPOs with Defined Effect in the Register |
|------------------------|--|
| GPO000_LED_DIM_CONFIG2 | GPO0 |
| GPO123_LED_DIM_CONFIG2 | GPO1, GPO2, GPO3 |
| GPO456_LED_DIM_CONFIG2 | GPO4, GPO5, GPO6 |
| GPO789_LED_DIM_CONFIG2 | GPO7, GPO8, GPO9 |

| Bit | Name | Description | | | | | | | | | | | | | | | | | | |
|-----------------------|---|--|-----------------------|---|-------|---|-------|-----------------|-------|-----------------|-------|-----------------|-------|-----|-------|-----|-------|-----|-------|------|
| 7:6 | T _{RD} [7:6] | <p>These bits decide the global setting time that will be used as ramp down time</p> <table border="1"> <thead> <tr> <th>T_{RD}[7:6]</th> <th>Ramp Down Time</th> </tr> </thead> <tbody> <tr> <td>0b00</td> <td>LED_FAD_PERIOD1</td> </tr> <tr> <td>0b01</td> <td>LED_FAD_PERIOD2</td> </tr> <tr> <td>0b10</td> <td>LED_FAD_PERIOD3</td> </tr> <tr> <td>0b11</td> <td>LED_FAD_PERIOD4</td> </tr> </tbody> </table> | T _{RD} [7:6] | Ramp Down Time | 0b00 | LED_FAD_PERIOD1 | 0b01 | LED_FAD_PERIOD2 | 0b10 | LED_FAD_PERIOD3 | 0b11 | LED_FAD_PERIOD4 | | | | | | | | |
| T _{RD} [7:6] | Ramp Down Time | | | | | | | | | | | | | | | | | | | |
| 0b00 | LED_FAD_PERIOD1 | | | | | | | | | | | | | | | | | | | |
| 0b01 | LED_FAD_PERIOD2 | | | | | | | | | | | | | | | | | | | |
| 0b10 | LED_FAD_PERIOD3 | | | | | | | | | | | | | | | | | | | |
| 0b11 | LED_FAD_PERIOD4 | | | | | | | | | | | | | | | | | | | |
| 5:3 | LOW_BRIGHTNESS[5:3] | <p>These bits decide what should be the low brightness state intensity</p> <table border="1"> <thead> <tr> <th>LOW_BRIGHTNESS[5:3]</th> <th>Ramp Down Target Intensity</th> </tr> </thead> <tbody> <tr> <td>0b000</td> <td>0%</td> </tr> <tr> <td>0b001</td> <td>10%</td> </tr> <tr> <td>0b010</td> <td>20%</td> </tr> <tr> <td>0b011</td> <td>30%</td> </tr> <tr> <td>0b100</td> <td>40%</td> </tr> <tr> <td>0b101</td> <td>60%</td> </tr> <tr> <td>0b110</td> <td>80%</td> </tr> <tr> <td>0b111</td> <td>100%</td> </tr> </tbody> </table> | LOW_BRIGHTNESS[5:3] | Ramp Down Target Intensity | 0b000 | 0% | 0b001 | 10% | 0b010 | 20% | 0b011 | 30% | 0b100 | 40% | 0b101 | 60% | 0b110 | 80% | 0b111 | 100% |
| LOW_BRIGHTNESS[5:3] | Ramp Down Target Intensity | | | | | | | | | | | | | | | | | | | |
| 0b000 | 0% | | | | | | | | | | | | | | | | | | | |
| 0b001 | 10% | | | | | | | | | | | | | | | | | | | |
| 0b010 | 20% | | | | | | | | | | | | | | | | | | | |
| 0b011 | 30% | | | | | | | | | | | | | | | | | | | |
| 0b100 | 40% | | | | | | | | | | | | | | | | | | | |
| 0b101 | 60% | | | | | | | | | | | | | | | | | | | |
| 0b110 | 80% | | | | | | | | | | | | | | | | | | | |
| 0b111 | 100% | | | | | | | | | | | | | | | | | | | |
| 2 | Breathing effect | <p>This bit decides whether LED effects should be repeated while the button is kept touched</p> <table border="1"> <tbody> <tr> <td>0</td> <td>LED effects are not repeated while the button is kept touched</td> </tr> <tr> <td>1</td> <td>LED effects are repeated while the button is kept touched</td> </tr> </tbody> </table> | 0 | LED effects are not repeated while the button is kept touched | 1 | LED effects are repeated while the button is kept touched | | | | | | | | | | | | | | |
| 0 | LED effects are not repeated while the button is kept touched | | | | | | | | | | | | | | | | | | | |
| 1 | LED effects are repeated while the button is kept touched | | | | | | | | | | | | | | | | | | | |

| Bit | Name | Description | | | | | | |
|-------|----------------------|---|-------|----------------------|---|-----------------|---|-----------------|
| 1 | T_H | This bit decides the global setting time that will be used as high brightness time. <table border="1" style="margin-left: 20px;"> <thead> <tr> <th>T_H</th> <th>High Brightness Time</th> </tr> </thead> <tbody> <tr> <td>0</td> <td>LED_FAD_PERIOD1</td> </tr> <tr> <td>1</td> <td>LED_FAD_PERIOD2</td> </tr> </tbody> </table> | T_H | High Brightness Time | 0 | LED_FAD_PERIOD1 | 1 | LED_FAD_PERIOD2 |
| T_H | High Brightness Time | | | | | | | |
| 0 | LED_FAD_PERIOD1 | | | | | | | |
| 1 | LED_FAD_PERIOD2 | | | | | | | |
| 0 | T_L | This bit decides the global setting time that will be used as low brightness time. <table border="1" style="margin-left: 20px;"> <thead> <tr> <th>T_L</th> <th>Low Brightness Time</th> </tr> </thead> <tbody> <tr> <td>0</td> <td>LED_FAD_PERIOD1</td> </tr> <tr> <td>1</td> <td>LED_FAD_PERIOD2</td> </tr> </tbody> </table> | T_L | Low Brightness Time | 0 | LED_FAD_PERIOD1 | 1 | LED_FAD_PERIOD2 |
| T_L | Low Brightness Time | | | | | | | |
| 0 | LED_FAD_PERIOD1 | | | | | | | |
| 1 | LED_FAD_PERIOD2 | | | | | | | |

2.6 GPOxxx_PWRON_LED_DIM_CONFIG1

Power-on LED Effects configuration registers

Individual Register Names and Addresses:

GPO000_PWRON_LED_DIM_CONFIG1:Lc, 12h GPO123_PWRON_LED_DIM_CONFIG1:Lc, 14h
 GPO456_PWRON_LED_DIM_CONFIG1:Lc, 16h GPO789_PWRON_LED_DIM_CONFIG1:Lc, 18h

| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------|---------------|---|----------------------|---|---|--------------------------|---|---|
| Access: FD | RW: 00 | | RW: 00 | | | RW: 00 | | |
| Bit Name | $T_{RU}[7:6]$ | | HIGH_BRIGHTNESS[5:3] | | | LED_SCENARIO_REPEAT[2:0] | | |

These registers are used to set the ramp up time, high brightness intensity and the LED scenario repeat rate for Power-on LED Effects. The following table gives information about what GPO's power-on LED effects are controlled by which register settings.

| Register Name | GPOs with Defined Effect in the Register |
|------------------------------|--|
| GPO000_PWRON_LED_DIM_CONFIG1 | GPO0 |
| GPO123_PWRON_LED_DIM_CONFIG1 | GPO1, GPO2, GPO3 |
| GPO456_PWRON_LED_DIM_CONFIG1 | GPO4, GPO5, GPO6 |
| GPO789_PWRON_LED_DIM_CONFIG1 | GPO7, GPO8, GPO9 |

| Bit | Name | Description | | | | | | | | | | |
|---------------|-----------------|--|---------------|--------------|------|-----------------|------|-----------------|------|-----------------|------|-----------------|
| 7:6 | $T_{RU}[7:6]$ | These bits decide the global setting time that will be used as ramp up time. <table border="1" style="margin-left: 20px;"> <thead> <tr> <th>$T_{RU}[7:6]$</th> <th>Ramp Up Time</th> </tr> </thead> <tbody> <tr> <td>0b00</td> <td>LED_FAD_PERIOD1</td> </tr> <tr> <td>0b01</td> <td>LED_FAD_PERIOD2</td> </tr> <tr> <td>0b10</td> <td>LED_FAD_PERIOD3</td> </tr> <tr> <td>0b11</td> <td>LED_FAD_PERIOD4</td> </tr> </tbody> </table> | $T_{RU}[7:6]$ | Ramp Up Time | 0b00 | LED_FAD_PERIOD1 | 0b01 | LED_FAD_PERIOD2 | 0b10 | LED_FAD_PERIOD3 | 0b11 | LED_FAD_PERIOD4 |
| $T_{RU}[7:6]$ | Ramp Up Time | | | | | | | | | | | |
| 0b00 | LED_FAD_PERIOD1 | | | | | | | | | | | |
| 0b01 | LED_FAD_PERIOD2 | | | | | | | | | | | |
| 0b10 | LED_FAD_PERIOD3 | | | | | | | | | | | |
| 0b11 | LED_FAD_PERIOD4 | | | | | | | | | | | |

| Bit | Name | Description | | | | | | | | | | | | | | | | | | |
|--------------------------|--------------------------|---|--------------------------|--------------------------|-------|------|-------|-----|-------|-----|-------|-----|-------|-----|-------|-----|-------|-----|-------|----|
| 5:3 | HIGH_BRIGHTNESS[5:3] | <p>These bits decide what should be the high brightness state intensity.</p> <table border="1"> <thead> <tr> <th>HIGH_BRIGHTNESS[5:3]</th> <th>Ramp Up Target Intensity</th> </tr> </thead> <tbody> <tr><td>0b000</td><td>100%</td></tr> <tr><td>0b001</td><td>90%</td></tr> <tr><td>0b010</td><td>80%</td></tr> <tr><td>0b011</td><td>65%</td></tr> <tr><td>0b100</td><td>50%</td></tr> <tr><td>0b101</td><td>40%</td></tr> <tr><td>0b110</td><td>20%</td></tr> <tr><td>0b111</td><td>0%</td></tr> </tbody> </table> | HIGH_BRIGHTNESS[5:3] | Ramp Up Target Intensity | 0b000 | 100% | 0b001 | 90% | 0b010 | 80% | 0b011 | 65% | 0b100 | 50% | 0b101 | 40% | 0b110 | 20% | 0b111 | 0% |
| HIGH_BRIGHTNESS[5:3] | Ramp Up Target Intensity | | | | | | | | | | | | | | | | | | | |
| 0b000 | 100% | | | | | | | | | | | | | | | | | | | |
| 0b001 | 90% | | | | | | | | | | | | | | | | | | | |
| 0b010 | 80% | | | | | | | | | | | | | | | | | | | |
| 0b011 | 65% | | | | | | | | | | | | | | | | | | | |
| 0b100 | 50% | | | | | | | | | | | | | | | | | | | |
| 0b101 | 40% | | | | | | | | | | | | | | | | | | | |
| 0b110 | 20% | | | | | | | | | | | | | | | | | | | |
| 0b111 | 0% | | | | | | | | | | | | | | | | | | | |
| 2:0 | LED_SCENARIO_REPEAT[2:0] | <p>These bits decide on how many times the Power-on LED effects should be repeated.</p> <table border="1"> <thead> <tr> <th>LED_SCENARIO_REPEAT[2:0]</th> <th>LED Scenario Repeat Rate</th> </tr> </thead> <tbody> <tr><td>0b000</td><td>0</td></tr> <tr><td>0b001</td><td>1</td></tr> <tr><td>0b010</td><td>2</td></tr> <tr><td>0b011</td><td>4</td></tr> <tr><td>0b100</td><td>6</td></tr> <tr><td>0b101</td><td>10</td></tr> <tr><td>0b110</td><td>15</td></tr> <tr><td>0b111</td><td>20</td></tr> </tbody> </table> | LED_SCENARIO_REPEAT[2:0] | LED Scenario Repeat Rate | 0b000 | 0 | 0b001 | 1 | 0b010 | 2 | 0b011 | 4 | 0b100 | 6 | 0b101 | 10 | 0b110 | 15 | 0b111 | 20 |
| LED_SCENARIO_REPEAT[2:0] | LED Scenario Repeat Rate | | | | | | | | | | | | | | | | | | | |
| 0b000 | 0 | | | | | | | | | | | | | | | | | | | |
| 0b001 | 1 | | | | | | | | | | | | | | | | | | | |
| 0b010 | 2 | | | | | | | | | | | | | | | | | | | |
| 0b011 | 4 | | | | | | | | | | | | | | | | | | | |
| 0b100 | 6 | | | | | | | | | | | | | | | | | | | |
| 0b101 | 10 | | | | | | | | | | | | | | | | | | | |
| 0b110 | 15 | | | | | | | | | | | | | | | | | | | |
| 0b111 | 20 | | | | | | | | | | | | | | | | | | | |

2.7 GPOxxx_PWRON_LED_DIM_CONFIG2

Power on LED Effects configuration registers

Individual Register Names and Addresses:

GPO000_PWRON_LED_DIM_CONFIG2:Lc, 13h GPO123_PWRON_LED_DIM_CONFIG2:Lc, 15h
 GPO456_PWRON_LED_DIM_CONFIG2:Lc, 17h GPO789_PWRON_LED_DIM_CONFIG2:Lc, 19h

| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
|------------|-----------------------|---|---------------------|---|---|----------------------|---|----------------|
| Access: FD | RW: 00 | | RW: 00 | | | RW: 00 | | RW: 0 |
| Bit Name | T _{RD} [7:6] | | LOW_BRIGHTNESS[5:3] | | | T _H [2:1] | | T _L |

These registers are used to set the ramp down time, low brightness intensity, the high brightness time, and the low brightness time in the power-on LED effect architecture. The following table gives information of what GPO's power-on LED effects are controlled by which register settings.

| Register Name | GPOs with Defined Effect in the Register |
|------------------------------|--|
| GPO000_PWRON_LED_DIM_CONFIG2 | GPO0 |
| GPO123_PWRON_LED_DIM_CONFIG2 | GPO1, GPO2, GPO3 |
| GPO456_PWRON_LED_DIM_CONFIG2 | GPO4, GPO5, GPO6 |
| GPO789_PWRON_LED_DIM_CONFIG2 | GPO7, GPO8, GPO9 |

| Bit | Name | Description | | | | | | | | | | | | | | | | | | |
|-----------------------|----------------------------|--|-----------------------|----------------------------|-------|-----------------|-------|-----------------|-------|-----------------|-------|-----------------|-------|-----|-------|-----|-------|-----|-------|------|
| 7:6 | T _{RD} [7:6] | <p>These bits decide which global setting time is used as ramp down time.</p> <table border="1"> <thead> <tr> <th>T_{RD}[7:6]</th> <th>Ramp Down Time</th> </tr> </thead> <tbody> <tr> <td>0b00</td> <td>LED_FAD_PERIOD1</td> </tr> <tr> <td>0b01</td> <td>LED_FAD_PERIOD2</td> </tr> <tr> <td>0b10</td> <td>LED_FAD_PERIOD3</td> </tr> <tr> <td>0b11</td> <td>LED_FAD_PERIOD4</td> </tr> </tbody> </table> | T _{RD} [7:6] | Ramp Down Time | 0b00 | LED_FAD_PERIOD1 | 0b01 | LED_FAD_PERIOD2 | 0b10 | LED_FAD_PERIOD3 | 0b11 | LED_FAD_PERIOD4 | | | | | | | | |
| T _{RD} [7:6] | Ramp Down Time | | | | | | | | | | | | | | | | | | | |
| 0b00 | LED_FAD_PERIOD1 | | | | | | | | | | | | | | | | | | | |
| 0b01 | LED_FAD_PERIOD2 | | | | | | | | | | | | | | | | | | | |
| 0b10 | LED_FAD_PERIOD3 | | | | | | | | | | | | | | | | | | | |
| 0b11 | LED_FAD_PERIOD4 | | | | | | | | | | | | | | | | | | | |
| 5:3 | LOW_BRIGHTNESS[5:3] | <p>These bits decide the low-brightness state intensity.</p> <table border="1"> <thead> <tr> <th>LOW_BRIGHTNESS[5:3]</th> <th>Ramp Down Target Intensity</th> </tr> </thead> <tbody> <tr> <td>0b000</td> <td>0%</td> </tr> <tr> <td>0b001</td> <td>10%</td> </tr> <tr> <td>0b010</td> <td>20%</td> </tr> <tr> <td>0b011</td> <td>30%</td> </tr> <tr> <td>0b100</td> <td>40%</td> </tr> <tr> <td>0b101</td> <td>60%</td> </tr> <tr> <td>0b110</td> <td>80%</td> </tr> <tr> <td>0b111</td> <td>100%</td> </tr> </tbody> </table> | LOW_BRIGHTNESS[5:3] | Ramp Down Target Intensity | 0b000 | 0% | 0b001 | 10% | 0b010 | 20% | 0b011 | 30% | 0b100 | 40% | 0b101 | 60% | 0b110 | 80% | 0b111 | 100% |
| LOW_BRIGHTNESS[5:3] | Ramp Down Target Intensity | | | | | | | | | | | | | | | | | | | |
| 0b000 | 0% | | | | | | | | | | | | | | | | | | | |
| 0b001 | 10% | | | | | | | | | | | | | | | | | | | |
| 0b010 | 20% | | | | | | | | | | | | | | | | | | | |
| 0b011 | 30% | | | | | | | | | | | | | | | | | | | |
| 0b100 | 40% | | | | | | | | | | | | | | | | | | | |
| 0b101 | 60% | | | | | | | | | | | | | | | | | | | |
| 0b110 | 80% | | | | | | | | | | | | | | | | | | | |
| 0b111 | 100% | | | | | | | | | | | | | | | | | | | |
| 2:1 | T _H [2:1] | <p>These bits decide which global setting time is used as high-brightness time.</p> <table border="1"> <thead> <tr> <th>T_H[2:1]</th> <th>High Brightness Time</th> </tr> </thead> <tbody> <tr> <td>0b00</td> <td>LED_FAD_PERIOD1</td> </tr> <tr> <td>0b01</td> <td>LED_FAD_PERIOD2</td> </tr> <tr> <td>0b10</td> <td>LED_FAD_PERIOD3</td> </tr> <tr> <td>0b11</td> <td>LED_FAD_PERIOD4</td> </tr> </tbody> </table> | T _H [2:1] | High Brightness Time | 0b00 | LED_FAD_PERIOD1 | 0b01 | LED_FAD_PERIOD2 | 0b10 | LED_FAD_PERIOD3 | 0b11 | LED_FAD_PERIOD4 | | | | | | | | |
| T _H [2:1] | High Brightness Time | | | | | | | | | | | | | | | | | | | |
| 0b00 | LED_FAD_PERIOD1 | | | | | | | | | | | | | | | | | | | |
| 0b01 | LED_FAD_PERIOD2 | | | | | | | | | | | | | | | | | | | |
| 0b10 | LED_FAD_PERIOD3 | | | | | | | | | | | | | | | | | | | |
| 0b11 | LED_FAD_PERIOD4 | | | | | | | | | | | | | | | | | | | |
| 0 | T _L | <p>This bit decides which global setting time is used as low-brightness time.</p> <table border="1"> <thead> <tr> <th>T_L</th> <th>Low Brightness Time</th> </tr> </thead> <tbody> <tr> <td>0</td> <td>LED_FAD_PERIOD1</td> </tr> <tr> <td>1</td> <td>LED_FAD_PERIOD2</td> </tr> </tbody> </table> | T _L | Low Brightness Time | 0 | LED_FAD_PERIOD1 | 1 | LED_FAD_PERIOD2 | | | | | | | | | | | | |
| T _L | Low Brightness Time | | | | | | | | | | | | | | | | | | | |
| 0 | LED_FAD_PERIOD1 | | | | | | | | | | | | | | | | | | | |
| 1 | LED_FAD_PERIOD2 | | | | | | | | | | | | | | | | | | | |

3. Device Configuration Mode

| Address | Name | Bit7 | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 | Host Access ^[17] | |
|---------|-------------------|-----------------------------|---------------|-----------------------|------------------|---------------------------|------------------|---------------------|---------------|-----------------------------|-------|
| Dc,00h | HOST_MODE | | | Load factory defaults | Checksum matched | Save to flash | Device_Mode[2:0] | | | RW:12 | |
| Dc,01h | I2C_CFG | I2C_Address[6:0] | | | | | | | | | RW:37 |
| Dc,02h | DEV_FEATURES | | | | | Auto_reset[4:3] | | Automatic Threshold | EMC | | RW:02 |
| Dc,03h | FSS_GROUP0 | CS7_FSS | CS6_FSS | CS5_FSS | CS4_FSS | CS3_FSS | CS2_FSS | CS1_FSS | CS0_FSS | RW:00 | |
| Dc,04h | FSS_GROUP1 | | | | | | | CS9_FSS | CS8_FSS | RW:00 | |
| Dc,05h | Reserved | | | | | | | | | | #:?? |
| Dc,06h | TOGGLE0 | CS7_Toggle | CS6_Toggle | CS5_Toggle | CS4_Toggle | CS3_Toggle | CS2_Togg e | CS1_Toggle | CS0_Togg e | RW:00 | |
| Dc,07h | TOGGLE1 | | | | | | | CS9_Toggle | CS8_Togg e | RW:00 | |
| Dc,08h | Reserved | | | | | | | | | | #:?? |
| Dc,09h | SENSITIVITY0 | CS3_Sensitivity | | CS2_Sensitivity | | CS1_Sensitivity | | CS0_Sensitivity | | RW:00 | |
| Dc,0Ah | SENSITIVITY1 | CS7_Sensitivity | | CS6_Sensitivity | | CS5_Sensitivity | | CS4_Sensitivity | | RW:00 | |
| Dc,0Bh | SENSITIVITY2 | | | | | CS9_Sensitivity | | CS8_Sensitivity | | RW:00 | |
| Dc,0Ch | Reserved | | | | | | | | | | #:?? |
| Dc,0Dh | Reserved | | | | | | | | | | #:?? |
| Dc,0Eh | CS0_DEB | CS0_Debounce[7:0] | | | | | | | | | RW:01 |
| Dc,0Fh | CS1-CS9_DEB | CS1-CS9_Debounce[7:0] | | | | | | | | | RW:01 |
| Dc,10h | Reserved | | | | | | | | | | #:?? |
| Dc,11h | FINGER_THRESHOLD0 | CS1_Finger_Threshold[7:4] | | | | CS0_Finger_Threshold[3:0] | | | | RW:00 | |
| Dc,12h | FINGER_THRESHOLD1 | CS3_Finger_Threshold[7:4] | | | | CS2_Finger_Threshold[3:0] | | | | RW:00 | |
| Dc,13h | FINGER_THRESHOLD2 | CS5_Finger_Threshold[7:4] | | | | CS4_Finger_Threshold[3:0] | | | | RW:00 | |
| Dc,14h | FINGER_THRESHOLD3 | CS7_Finger_Threshold[7:4] | | | | CS6_Finger_Threshold[3:0] | | | | RW:00 | |
| Dc,15h | FINGER_THRESHOLD4 | CS9_Finger_Threshold[7:4] | | | | CS8_Finger_Threshold[3:0] | | | | RW:00 | |
| Dc,16h | Reserved | | | | | | | | | | #:?? |
| Dc,17h | Reserved | | | | | | | | | | #:?? |
| Dc,18h | Reserved | | | | | | | | | | #:?? |
| Dc,19h | Reserved | | | | | | | | | | #:?? |
| Dc,1Ah | SCANRATE | Power consumption optimized | ScanRate[6:0] | | | | | | | | RW:00 |
| Dc,1Bh | BUZZER_CONFIG | | Buzzer_Enable | Pins | Pin0 Idle State | | Frequency[2:0] | | | RW:00 | |
| Dc,1Ch | BUZ_OP_DURATION | BuzzerDelay_Value[6:0] | | | | | | | | | RW:00 |
| Dc,1Dh | CUSTOM_CFG1 | Customer_Check_Data[7:0] | | | | | | | | | RW:00 |
| Dc,1Eh | CHECKSUM_MSB | Checksum_MSB[7:0] | | | | | | | | | RW:00 |
| Dc,1Fh | CHECKSUM_LSB | Checksum_LSB[7:0] | | | | | | | | | RW:3B |

Note

17. Host Access is AB:XY

where:

AB = Read/Write access for the register

XY = Initial value of register on device power-on

For example:

RW:00 = The register is both Read/Write accessible, with initial value 00h.

R:A1 = The register is Read only, with initial value A1h.

#:?? = The register is reserved (no definite value stored)

The shaded areas represent reserved register bits

3.1 HOST_MODE

Host Mode register

Individual Register Names and Addresses:

HOST_MODE: Dc, 00h

| | | | | | | | | |
|------------|---|---|------------------------|------------------|------------------------|------------------|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | WC ^[18] : 0 | R: 1 | WC ^[18] : 0 | RW: 2 | | |
| Bit Name | | | Load factory defaults | Checksum matched | Save to flash | Device Mode[2:0] | | |

This register is used to save the configuration to flash, decide the device operation mode, and load factory defaults. This register also tells whether the checksum is matched; to know more about Checksum match, refer to [Steps to Configure CY8CMBR2110 on page 24](#).

| Bit | Name | Description |
|-----|-----------------------|---|
| 5 | Load factory defaults | This bit is used to load factory default setting in RAM. However user configured FLASH area does not get updated with these settings |
| | | 0 No impact |
| | | 1 Load factory defaults and bit is self cleared after loading factory defaults |
| 4 | Checksum matched | This bit is set or cleared based on the host sent checksum and the checksum calculated with the register data of device configuration mode and LED configuration mode |
| | | 0 Host sent checksum and checksum calculated did not match |
| | | 1 Host sent checksum and checksum calculated matched |
| 3 | Save to flash | This bit is used to store the current configuration into flash |
| | | 0 No impact |
| | | 1 stores the current configuration into flash |
| 2:0 | Device Mode | These bits decide the CapSense controller device mode |
| | | 000 Operating mode |
| | | 001 LED configuration mode |
| | | 010 Device configuration mode |
| | | 011 Production line test mode |
| | | 100 Debug Data mode |
| | | 101 Not valid |
| | | 110 Not valid |
| | | 111 Not valid |

Note

18. Device clears the Write Clear (WC) bit automatically after the required operation.

3.2 I2C_CFG

I²C configuration register

Individual Register Names and Addresses:

I2C_CFG: Dc, 01h

| | | | | | | | | |
|------------|------------------|---|---|---|---|---|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | | | | | |
| Bit Name | | | | | | | | |
| | RW: 37 | | | | | | | |
| | I2C_Address[6:0] | | | | | | | |

This register is used to set the I²C slave address. Slave address range is 0x00-0x7F.

| Bit | Name | Description |
|-----|------------------|---|
| 6:0 | I2C_Address[6:0] | These bits set the 7-bit I ² C slave address |

3.3 DEV_FEATURES

Device Features configuration register

Individual Register Names and Addresses:

DEV_FEATURES: Dc, 02h

| | | | | | | | | |
|------------|---|---|---|---|-----------------|---|---------------------|------|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | | | | | |
| Bit Name | | | | | | | | |
| | | | | | RW: 0 | | RW:1 | RW:0 |
| | | | | | ARST_Delay[4:3] | | Automatic Threshold | EMC |

This register is used to enable/disable automatic thresholds and noise immunity level, and set the Button Auto Reset period.

| Bit | Name | Description | | | | | | | | | | |
|-----------|--|--|-----------|--|------|---|------|----------|------|-------|------|--------|
| 3:2 | ARST[3:2] | These bits decide Button Auto Reset period. <table border="1" style="margin-left: 20px;"> <thead> <tr> <th>ARST[3:2]</th> <th>Button Auto Reset Period</th> </tr> </thead> <tbody> <tr> <td>0b00</td> <td>No limit</td> </tr> <tr> <td>0b01</td> <td>No limit</td> </tr> <tr> <td>0b10</td> <td>5 sec</td> </tr> <tr> <td>0b11</td> <td>20 sec</td> </tr> </tbody> </table> | ARST[3:2] | Button Auto Reset Period | 0b00 | No limit | 0b01 | No limit | 0b10 | 5 sec | 0b11 | 20 sec |
| ARST[3:2] | Button Auto Reset Period | | | | | | | | | | | |
| 0b00 | No limit | | | | | | | | | | | |
| 0b01 | No limit | | | | | | | | | | | |
| 0b10 | 5 sec | | | | | | | | | | | |
| 0b11 | 20 sec | | | | | | | | | | | |
| 1 | Automatic Threshold | This bit decides whether all thresholds are automatically calculated (Automatic threshold enabled) or if the user should give finger threshold input and all other thresholds are calculated based on the finger threshold by the CapSense controller <table border="1" style="margin-left: 20px;"> <tbody> <tr> <td>0</td> <td>Disables automatic threshold calculation in SmartSense Auto-Tuning</td> </tr> <tr> <td>1</td> <td>Enables automatic threshold calculation in SmartSense Auto-Tuning</td> </tr> </tbody> </table> | 0 | Disables automatic threshold calculation in SmartSense Auto-Tuning | 1 | Enables automatic threshold calculation in SmartSense Auto-Tuning | | | | | | |
| 0 | Disables automatic threshold calculation in SmartSense Auto-Tuning | | | | | | | | | | | |
| 1 | Enables automatic threshold calculation in SmartSense Auto-Tuning | | | | | | | | | | | |
| 0 | EMC | This bit decides the noise immunity level <table border="1" style="margin-left: 20px;"> <tbody> <tr> <td>0</td> <td>Noise immunity level is normal</td> </tr> <tr> <td>1</td> <td>Noise immunity level is high</td> </tr> </tbody> </table> | 0 | Noise immunity level is normal | 1 | Noise immunity level is high | | | | | | |
| 0 | Noise immunity level is normal | | | | | | | | | | | |
| 1 | Noise immunity level is high | | | | | | | | | | | |

3.4 FSS_GROUPx

CapSense FSS Group Setting registers

Individual Register Names and Addresses:

| FSS_GROUP0: Dc, 03h | | | | FSS_GROUP0: Dc, 04h | | | | |
|---------------------|---------|---------|---------|---------------------|---------|---------|---------|---------|
| FSS_GROUP0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | RW: 0 | RW: 0 | RW: 0 | RW: 0 | RW: 0 | RW: 0 | RW: 0 | RW: 0 |
| Bit Name | CS7_FSS | CS6_FSS | CS5_FSS | CS4_FSS | CS3_FSS | CS2_FSS | CS1_FSS | CS0_FSS |

| | | | | | | | | |
|------------|---|---|---|---|---|---|---------|---------|
| FSS_GROUP1 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | | | | RW: 0 | RW: 0 |
| Bit Name | | | | | | | CS9_FSS | CS8_FSS |

These registers are used to set the buttons on which FSS needs to be applied.

| Bit | Name | Description |
|-----|---------|---|
| x | CSx_FSS | This bit decides whether the button will be in the FSS group or not |
| | | 0 Button not in FSS group |
| | | 1 Button in FSS group |

3.5 TOGGLEx

Toggle Setting Registers

Individual Register Names and Addresses:

| TOGGLE0: Dc, 06h | | | | TOGGLE1: Dc, 07h | | | | |
|------------------|-------|-------|-------|------------------|-------|-------|-------|-------|
| TOGGLE0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | RW: 0 | RW: 0 | RW: 0 | RW: 0 | RW: 0 | RW: 0 | RW: 0 | RW: 0 |
| Bit Name | CS7 | CS6 | CS5 | CS4 | CS3 | CS2 | CS1 | CS0 |

| | | | | | | | | |
|------------|---|---|---|---|---|---|-------|-------|
| TOGGLE1 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | | | | RW: 0 | RW: 0 |
| Bit Name | | | | | | | CS9 | CS8 |

This register is used to decide if the CSx acts like a toggle switch.

| Bit | Name | Description |
|-----|---------|--|
| x | CSx_FSS | This bit decides whether GPOx should be toggled based on CSx status or not |
| | | 0 Toggle disabled |
| | | 1 Toggle enabled |

3.6 SENSITIVITYx

CapSense Button Sensitivity Setting registers

Individual Register Names and Addresses:

| SENSITIVITY0: Dc, 09h | | SENSITIVITY1: Dc, 0Ah | | | | SENSITIVITY2: Dc, 0Bh | | | |
|-----------------------|-----------------|-----------------------|-----------------|---|-----------------|-----------------------|-----------------|---|--|
| SENSITIVITY0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| Access: FD | RW: 0 | | RW: 0 | | RW: 0 | | RW: 0 | | |
| Bit Name | CS3_Sensitivity | | CS2_Sensitivity | | CS1_Sensitivity | | CS0_Sensitivity | | |
| SENSITIVITY1 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| Access: FD | RW: 0 | | RW: 0 | | RW: 0 | | RW: 0 | | |
| Bit Name | CS7_Sensitivity | | CS6_Sensitivity | | CS5_Sensitivity | | CS4_Sensitivity | | |
| SENSITIVITY2 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| Access: FD | | | | | RW: 0 | | RW: 0 | | |
| Bit Name | | | | | CS9_Sensitivity | | CS8_Sensitivity | | |

These registers set the CapSense Button Sensitivity.

| CSx_Sensitivity bits | Button Sensitivity |
|----------------------|--------------------|
| 0b00 | High Sensitivity |
| 0b01 | High Sensitivity |
| 0b10 | Medium Sensitivity |
| 0b11 | Low Sensitivity |

3.7 CS0_DEB

CS0 Debounce Setting register

Individual Register Names and Addresses:

| CS0_DEB: Dc, 0Eh | | | | | | | | |
|------------------|----------------|---|---|---|---|---|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | RW: 01 | | | | | | | |
| Bit Name | Debounce [7:0] | | | | | | | |

This register sets the CS0 debounce. Range of this register is 1-255.

3.8 CS1-CS9_DEB

CS1 to CS9 Debounce Setting register

Individual Register Names and Addresses:

| CS1-CS9_DEB: Dc, 0Fh | | | | | | | | |
|----------------------|----------------|---|---|---|---|---|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | RW: 01 | | | | | | | |
| Bit Name | Debounce [7:0] | | | | | | | |

This register sets the CS1 to CS9 buttons debounce. Range of this register is 1-255.

3.9 FINGER_THRESHOLDx

CapSense Button Finger Threshold Setting registers

Individual Register Names and Addresses:

| | | | | | | | | |
|---------------------------------|---------------------------------|---------------------------------|---|---|---------------------------|---|---|---|
| FINGER_THRESHOLD0:Dc,11h | FINGER_THRESHOLD1:Dc,12h | FINGER_THRESHOLD2:Dc,13h | | | | | | |
| FINGER_THRESHOLD3:Dc,14h | FINGER_THRESHOLD4:Dc,15h | | | | | | | |
| FINGER_THRESHOLDx | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | RW: 00 | | | | RW: 00 | | | |
| Bit Name | CSy_Finger_Threshold[7:4] | | | | CSx_Finger_Threshold[3:0] | | | |

These registers set the finger threshold of CapSense Buttons
 Finger Threshold of Button 'x' = 50 + (13 * CSx_Finger_Threshold[3:0])

3.10 SCANRATE

Scan Rate Settings register

Individual Register Names and Addresses:

| | | | | | | | | |
|--------------------------|-----------------------------|---|---------------|---|---|---|---|---|
| SCANRATE: Dc, 1Ah | | | | | | | | |
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | RW:00 | | RW:00 | | | | | |
| Bit Name | Power consumption optimized | | ScanRate[6:0] | | | | | |

This register decides the Button Scan Rate based on the power consumption optimized bit, the number of buttons, and user configured scan rate. Based on the scan rate input selected in bits 6:0, one of the following offsets is added to the scan rate constant in the user configured scan rate mode.

0,6,12,20,29,39,49,61,73,86,99,114,128,144,160,176,194,211, 229,248,267,287,307,327,348,369,391,413,436,459,482,506

If Bit7 is set to '1' then power consumption optimization is enabled else response time optimization is enabled.

3.11 BUZZER_CONFIG

Buzzer Output Configuration register

Individual Register Names and Addresses:

BUZZER_CONFIG: Dc, 1Bh

| | | | | | | | | |
|------------|---|-------|-------|-------|---|----------------|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | RW: 0 | RW: 0 | RW: 0 | | RW:00 | | |
| Bit Name | | EN | PINS | IDLE0 | | Frequency[2:0] | | |

This register is used to enable buzzer output, select the number of buzzer output pins, buzzer output pins idle state logic level, and the buzzer output frequency

| Bit | Name | Description | | | | | | | | | | | | | | | | | | | | | | | | | | | |
|-------|----------------|--|--------------------------|--------------------------|------------|-------|------|-----|-------|------|-----|-------|------|-------|-------|------|-----|-------|------|-----|-------|------|-----|-------|------|-------|-------|------|-----|
| 6 | EN | This bit is used to enable or disable the buzzer output | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | 0 Disable the buzzer output | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | 1 Enable the buzzer output | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 5 | PINS | This bit is used to select the number of buzzer output pins | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | 0 One buzzer output pin (AC 1-pin buzzer) | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | 1 Two buzzer output pins (AC 2-pin buzzer) | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 4 | IDLE0 | This bit decides the logic level of BuzzerOut0 in idle state | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | 0 BuzzerOut0 is driven logic'0' in idle state | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | 1 BuzzerOut0 is driven logic'1' in idle state | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 2:0 | Frequency[2:0] | These bits decide the frequency of the buzzer output. | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | <table border="1"> <thead> <tr> <th>Frequency[2:0]</th> <th>Buzzer Output Freq (KHZ)</th> <th>Duty Cycle</th> </tr> </thead> <tbody> <tr> <td>0b000</td> <td>4.00</td> <td>50%</td> </tr> <tr> <td>0b001</td> <td>4.00</td> <td>50%</td> </tr> <tr> <td>0b010</td> <td>2.67</td> <td>66.7%</td> </tr> <tr> <td>0b011</td> <td>2.00</td> <td>50%</td> </tr> <tr> <td>0b100</td> <td>1.60</td> <td>60%</td> </tr> <tr> <td>0b101</td> <td>1.33</td> <td>50%</td> </tr> <tr> <td>0b110</td> <td>1.14</td> <td>57.1%</td> </tr> <tr> <td>0b111</td> <td>1.00</td> <td>50%</td> </tr> </tbody> </table> | Frequency[2:0] | Buzzer Output Freq (KHZ) | Duty Cycle | 0b000 | 4.00 | 50% | 0b001 | 4.00 | 50% | 0b010 | 2.67 | 66.7% | 0b011 | 2.00 | 50% | 0b100 | 1.60 | 60% | 0b101 | 1.33 | 50% | 0b110 | 1.14 | 57.1% | 0b111 | 1.00 | 50% |
| | | Frequency[2:0] | Buzzer Output Freq (KHZ) | Duty Cycle | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | 0b000 | 4.00 | 50% | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | 0b001 | 4.00 | 50% | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | 0b010 | 2.67 | 66.7% | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | 0b011 | 2.00 | 50% | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | 0b100 | 1.60 | 60% | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | 0b101 | 1.33 | 50% | | | | | | | | | | | | | | | | | | | | | | | | | |
| | | 0b110 | 1.14 | 57.1% | | | | | | | | | | | | | | | | | | | | | | | | | |
| 0b111 | 1.00 | 50% | | | | | | | | | | | | | | | | | | | | | | | | | | | |

3.12 BUZ_OP_DURATION

Buzzer Output Duration register

Individual Register Names and Addresses:

BUZ_OP_DURATION: Dc, 1Ch

| | | | | | | | | |
|------------|---|-------------------------|---|---|---|---|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | RW: 00 | | | | | | |
| Bit Name | | BuzzerDelay_Values[6:0] | | | | | | |

The buzzer output is driven for the BuzzerDelay_Values[6:0] x Button Scan Rate constant. BuzzerDelay_Values can range from 1 to 127 if the buzzer is enabled. For the Button Scan Rate constant, see [Table 7 on page 21](#).

3.13 CUSTOM_CONFIG1

Host Custom Data Storage registers

Individual Register Names and Addresses:

CUSTOM_CONFIG1: Dc, 1Dh

| | | | | | | | | |
|------------|-----------|---|---|---|---|---|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | RW: 0 | | | | | | | |
| Bit Name | DATA[7:0] | | | | | | | |

This register can be used by customers to write their own data and save to flash.

3.14 CHECKSUM_xxx

Device Configuration Checksum registers

Individual Register Names and Addresses:

CHECKSUM_MSB: Dc, 1Eh

CHECKSUM_LSB: Dc, 1Fh

| | | | | | | | | |
|--------------|-------------------|---|---|---|---|---|---|---|
| CHECKSUM_MSB | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | RW: 00 | | | | | | | |
| Bit Name | CheckSum_MSB[7:0] | | | | | | | |

| | | | | | | | | |
|--------------|-------------------|---|---|---|---|---|---|---|
| CHECKSUM_LSB | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | RW: 3Bh | | | | | | | |
| BitName | CheckSum_LSB[7:0] | | | | | | | |

Checksum is addition of register values from 0x01- 0x1F in LED configuration mode, and 0x01-0x1D in the Device configuration mode.

4. Production Line Testing Mode

| Address | Name | Bit7 | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 | Host Access ^[19] |
|---------|----------------------|-------------------|-------------------|-------------------|-------------------|------------------------------------|------------------|-------------------------|-------------------------|-----------------------------|
| PI,00h | HOST_MODE | Host Control GPO3 | Host Control GPO2 | Host Control GPO1 | Host Control GPO0 | | Device_Mode[2:0] | | | RW:03 |
| PI,01h | Reserved | | | | | | | | | #:?? |
| PI,02h | Reserved | | | | | | | | | #:?? |
| PI,03h | BUTTON_COUNT | | | | | Number of working buttons detected | | | | R:00 |
| PI,04h | BUTTON_CURRENT_STAT0 | CS7 Status | CS6 Status | CS5 Status | CS4 Status | CS3 Status | CS2 Status | CS1 Status | CS0 Status | R:00 |
| PI,05h | BUTTON_CURRENT_STAT1 | | | | | | | CS9 Status | CS8 Status | R:00 |
| PI,06h | Reserved | | | | | | | | | #:?? |
| PI,07h | CSx_SHORT_GND0 | CS7 | CS6 | CS5 | CS4 | CS3 | CS2 | CS1 | CS0 | R:00 |
| PI,08h | CSx_SHORT_GND1 | | | | | | | CS9 | CS8 | R:00 |
| PI,09h | Reserved | | | | | | | | | #:?? |
| PI,0Ah | CSx_SHORT_CSy0 | CS7 | CS6 | CS5 | CS4 | CS3 | CS2 | CS1 | CS0 | R:00 |
| PI,0Bh | CSx_SHORT_CSy1 | | | | | | | CS9 | CS8 | R:00 |
| PI,0Ch | Reserved | | | | | | | | | #:?? |
| PI,0Dh | CSx_CP_>40pF_0 | CS7 | CS6 | CS5 | CS4 | CS3 | CS2 | CS1 | CS0 | R:00 |
| PI,0Eh | CSx_CP_>40pF_0 | | | | | | | CS9 | CS8 | R:00 |
| PI,0Fh | Reserved | | | | | | | | | #:?? |
| PI,10h | CSx_SHORT_VDD0 | CS7 | CS6 | CS5 | CS4 | CS3 | CS2 | CS1 | CS0 | R:00 |
| PI,11h | CSx_SHORT_VDD1 | | | | | | | CS9 | CS8 | R:00 |
| PI,12h | Reserved | | | | | | | | | #:?? |
| PI,13h | CMOD_VALUE | | | | | | | C _{MOD} < 1 nF | C _{MOD} > 4 nF | R:00 |
| PI,14h | CS01_SNR | CS1_SNR[3:0] | | | | CS0_SNR[3:0] | | | | R:00 |
| PI,15h | CS23_SNR | CS3_SNR[3:0] | | | | CS2_SNR[3:0] | | | | R:00 |
| PI,16h | CS45_SNR | CS5_SNR[3:0] | | | | CS4_SNR[3:0] | | | | R:00 |
| PI,17h | CS67_SNR | CS7_SNR[3:0] | | | | CS6_SNR[3:0] | | | | R:00 |
| PI,18h | CS89_SNR | CS9_SNR[3:0] | | | | CS8_SNR[3:0] | | | | R:00 |
| PI,19h | Reserved | | | | | | | | | #:?? |
| PI,1Ah | Reserved | | | | | | | | | #:?? |
| PI,1Bh | Reserved | | | | | | | | | #:?? |
| PI,1Ch | Reserved | | | | | | | | | #:?? |
| PI,1Dh | Reserved | | | | | | | | | #:?? |
| PI,1Eh | Reserved | | | | | | | | | #:?? |
| PI,1Fh | Reserved | | | | | | | | | #:?? |

Note

19. Host Access is AB:XY

where:

AB = Read/Write access for the register

XY = Initial value of register on device power-on

For example:

RW:00 = The register is both Read/Write accessible, with initial value 00h.

R:A1 = The register is Read only, with initial value A1h.

#:?? = The register is reserved (no definite value stored)

The shaded areas represent reserved register bits

4.1 HOST_MODE

Host Mode register

Individual Register Names and Addresses:

HOST_MODE: PI, 00h

| | | | | | | | | |
|------------|-------------------|-------------------|-------------------|-------------------|---|---|------------------|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | RW: 0 | RW: 0 | RW: 0 | RW: 0 | | | RW: 3 | |
| Bit Name | Host Control GPO3 | Host Control GPO2 | Host Control GPO1 | Host Control GPO0 | | | Device Mode[2:0] | |

This register is used to control the logic levels of the host control GPOs, and decides the device operating mode.

| Bit | Name | Description |
|---------------|-------------------|--|
| 7 | Host Control GPO3 | This bit controls the logic level of the host control GPO3 |
| | | 0 Host control GPO3 is driven logic low |
| | | 1 Host control GPO3 is driven logic high |
| 6 | Host Control GPO2 | This bit controls the logic level of the host control GPO2 |
| | | 0 Host control GPO2 is driven logic low |
| | | 1 Host control GPO2 is driven logic high |
| 5 | Host Control GPO1 | This bit controls the logic level of the host control GPO1 |
| | | 0 Host control GPO1 is driven logic low |
| | | 1 Host control GPO1 is driven logic high |
| 4 | Host Control GPO0 | This bit controls the logic level of the host control GPO0 |
| | | 0 Host control GPO0 is driven logic low |
| | | 1 Host control GPO0 is driven logic high |
| 2:0 | Device Mode | These bits decide the CapSense controller device mode |
| | | 000 Operating mode |
| | | 001 LED configuration mode |
| | | 010 Device configuration mode |
| | | 011 Production line test mode |
| | | 100 Debug Data mode |
| | | 101 Not valid |
| | | 110 Not valid |
| 111 Not valid | | |

4.2 BUTTON_COUNT

Detected Button Count register

Individual Register Names and Addresses:

BUTTON_COUNT: PI, 03h

| | | | | | | | | |
|------------|---|---|---|---|---|-----------------------|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | | | R: 0 | | |
| Bit Name | | | | | | Working_Buttons [3:0] | | |

This register gives information about the number of working buttons detected. The Host can read this register and if the working button matches the host estimated count, then the System Diagnostics of all buttons has passed. If System Diagnostics of any button fails, then the button is disabled.

| Bit | Name | Description |
|-----|-----------------|---|
| 3:0 | Working buttons | These bits contain the number of working buttons detected and can be read by the host to detect whether System Diagnostics passes or fails. |

4.3 BUTTON_CURRENT_STATx

CapSense Button Current Status registers

Individual Register Names and Addresses:

BUTTON_CURRENT_STAT0: PI, 04h

BUTTON_CURRENT_STAT1: PI, 05h

| | | | | | | | | |
|----------------------|------|------|------|------|------|------|------|------|
| BUTTON_CURRENT_STAT0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 |
| Bit Name | CS7 | CS6 | CS5 | CS4 | CS3 | CS2 | CS1 | CS0 |

| | | | | | | | | |
|----------------------|---|---|---|---|---|---|------|------|
| BUTTON_CURRENT_STAT1 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | | | | R: 0 | R: 0 |
| Bit Name | | | | | | | CS9 | CS8 |

Reading from these registers gives the button ON/OFF status.

| Bit | Name | Description |
|-----|------|---|
| x | CSx | This bit gives the button ON/OFF status |
| | | 0 Button OFF |
| | | 1 Button ON |

4.4 CSx_SHORT_GNDx

CapSense Buttons Short to Ground Information registers

Individual Register Names and Addresses:

| CSx_SHORT_GND0: PI, 07h | | | | CSx_SHORT_GND1: PI, 08h | | | | |
|-------------------------|------|------|------|-------------------------|------|------|------|------|
| CSx_SHORT_GND0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 |
| Bit Name | CS7 | CS6 | CS5 | CS4 | CS3 | CS2 | CS1 | CS0 |

| | | | | | | | | |
|----------------|---|---|---|---|---|---|------|------|
| CSx_SHORT_GND1 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | | | | R: 0 | R: 0 |
| Bit Name | | | | | | | CS9 | CS8 |

This register gives information of any button that is shorted to ground. If any bit in the register is set to '1', then the corresponding button is connected to ground. CapSense buttons do not operate when they are connected to ground; these buttons are disabled.

4.5 CSx_SHORT_CSyz

CapSense Buttons Short to Other CapSense Button Information registers

Individual Register Names and Addresses:

| CSx_SHORT_CSy0: PI, 0Ah | | | | CSx_SHORT_CSy1: PI, 0Bh | | | | |
|-------------------------|------|------|------|-------------------------|------|------|------|------|
| CSx_SHORT_CSy0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 |
| Bit Name | CS7 | CS6 | CS5 | CS4 | CS3 | CS2 | CS1 | CS0 |

| | | | | | | | | |
|----------------|---|---|---|---|---|---|------|------|
| CSx_SHORT_CSy1 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | | | | R: 0 | R: 0 |
| Bit Name | | | | | | | CS9 | CS8 |

This register gives information of any button that is shorted to another button. If any two buttons are shorted to each other, then bits corresponding to both the buttons are set to '1' and the corresponding buttons are disabled.

4.6 CSx_CP_>40 pF_x

CapSense Buttons Parasitic Capacitance >40 pF Information registers

Individual Register Names and Addresses:

| CSx_CP_>40 pF_0: PI, 0Dh | | | | CSx_CP_>40 pF_1: PI, 0Eh | | | | |
|--------------------------|------|------|------|--------------------------|------|------|------|------|
| CSx_CP_>40 pF_0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 |
| Bit Name | CS7 | CS6 | CS5 | CS4 | CS3 | CS2 | CS1 | CS0 |

| | | | | | | | | |
|-----------------|---|---|---|---|---|---|------|------|
| CSx_CP_>40 pF_1 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | | | | R: 0 | R: 0 |
| Bit Name | | | | | | | CS9 | CS8 |

This register gives information of buttons whose parasitic capacitance (C_p) is >40 pF. If any button C_p is >40 pF, then the bit in the register is set and that button is disabled.

4.7 CSx_SHORT_VDDx

CapSense Buttons Short to V_{DD} Information registers

Individual Register Names and Addresses:

| CSx_SHORT_VDD0: PI, 10h | | | | CSx_SHORT_VDD1: PI, 11h | | | | |
|-------------------------|------|------|------|-------------------------|------|------|------|------|
| CSx_SHORT_VDD0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 |
| Bit Name | CS7 | CS6 | CS5 | CS4 | CS3 | CS2 | CS1 | CS0 |

| | | | | | | | | |
|----------------|---|---|---|---|---|---|------|------|
| CSx_SHORT_VDD1 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | | | | R: 0 | R: 0 |
| Bit Name | | | | | | | CS9 | CS8 |

This register gives information of any button that is shorted to V_{DD}. If any bit in the register is set to '1', then the corresponding button is connected to V_{DD}. CapSense buttons do not operate when they are connected to V_{DD}, and are disabled.

4.8 CMOD_VALUE

Incorrect C_{MOD} Value Information registers

Individual Register Names and Addresses:

| CMOD_VALUE: PI, 13h | | | | | | | | |
|---------------------|---|---|---|---|---|---|-------------------------|-------------------------|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | | | | R: 0 | R: 0 |
| Bit Name | | | | | | | C _{MOD} < 1 nF | C _{MOD} > 4 nF |

This register gives information if an incorrect value of C_{MOD} is connected. If the proper value of C_{MOD} is connected, then both bits '0' and '1' are set to '0'.

| Bit | Name | Description |
|-----|-------------------------|--|
| 0 | C _{MOD} > 4 nF | This bit gives information if C _{MOD} value detected is greater than the recommended range |
| | | 0 C _{MOD} is < 4 nF |
| | | 1 C _{MOD} is > 4 nF |
| 1 | C _{MOD} < 1 nF | This bit gives information if the C _{MOD} value detected is less than the recommended range |
| | | 0 C _{MOD} is > 1 nF |
| | | 1 C _{MOD} is < 1 nF |

4.9 CSxy_SNR

CapSense Button SNR Information registers

Individual Register Names and Addresses:

| CS01_SNR: PI, 14h | | CS23_SNR: PI, 15h | | | CS45_SNR: PI, 16h | | | |
|-------------------|--------------|-------------------|---|---|-------------------|---|---|---|
| CS67_SNR: PI, 17h | | CS89_SNR: PI, 18h | | | | | | |
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | RW: 00 | | | | RW: 00 | | | |
| Bit Name | CSy_SNR[7:4] | | | | CSx_SNR[3:0] | | | |

These registers give the signal to noise ratio information of the enabled buttons.

5. Debug Data Mode

| Address | Name | Bit7 | Bit6 | Bit5 | Bit4 | Bit3 | Bit2 | Bit1 | Bit0 | Host Access ^[20] |
|---------|----------------------|-------------------|-------------------|-------------------|-------------------|----------------|------------------|------------|------------|-----------------------------|
| Dd,00h | HOST_MODE | Host Control GPO3 | Host Control GPO2 | Host Control GPO1 | Host Control GPO0 | | Device_Mode[2:0] | | | RW:04 |
| Dd,01h | BUTTON_NUMBER | | | | | Sensor[4:0] | | | | RW:00 |
| Dd,02h | PARAMETER | | | | | Parameter[4:0] | | | | RW:00 |
| Dd,03h | Reserved | | | | | | | | | R:00 |
| Dd,04h | BUTTON_CURRENT_STAT0 | CS7 Status | CS6 Status | CS5 Status | CS4 Status | CS3 Status | CS2 Status | CS1 Status | CS0 Status | R:00 |
| Dd,05h | BUTTON_CURRENT_STAT1 | | | | | | | CS9 Status | CS8 Status | R:00 |
| Dd,06h | Reserved | | | | | | | | | #:?? |
| Dd,07h | READ0 | Data[7:0] | | | | | | | | R:?? |
| Dd,08h | READ1 | Data[7:0] | | | | | | | | R:?? |
| Dd,09h | READ2 | Data[7:0] | | | | | | | | R:?? |
| Dd,0Ah | READ3 | Data[7:0] | | | | | | | | R:?? |
| Dd,0Bh | READ4 | Data[7:0] | | | | | | | | R:?? |
| Dd,0Ch | READ5 | Data[7:0] | | | | | | | | R:?? |
| Dd,0Dh | READ6 | Data[7:0] | | | | | | | | R:?? |
| Dd,0Eh | READ7 | Data[7:0] | | | | | | | | R:?? |
| Dd,0Fh | READ8 | Data[7:0] | | | | | | | | R:?? |
| Dd,10h | READ9 | Data[7:0] | | | | | | | | R:?? |
| Dd,11h | READ10 | Data[7:0] | | | | | | | | R:?? |
| Dd,12h | READ11 | Data[7:0] | | | | | | | | R:?? |
| Dd,13h | READ12 | Data[7:0] | | | | | | | | R:?? |
| Dd,14h | READ13 | Data[7:0] | | | | | | | | R:?? |
| Dd,15h | READ14 | Data[7:0] | | | | | | | | R:?? |
| Dd,16h | READ15 | Data[7:0] | | | | | | | | R:?? |
| Dd,17h | READ16 | Data[7:0] | | | | | | | | R:?? |
| Dd,18h | READ17 | Data[7:0] | | | | | | | | R:?? |
| Dd,19h | READ18 | Data[7:0] | | | | | | | | R:?? |
| Dd,1Ah | READ19 | Data[7:0] | | | | | | | | R:?? |
| Dd,1Bh | READ20 | Data[7:0] | | | | | | | | R:?? |
| Dd,1Ch | READ21 | Data[7:0] | | | | | | | | R:?? |
| Dd,1Dh | READ22 | Data[7:0] | | | | | | | | R:?? |
| Dd,1Eh | READ23 | Data[7:0] | | | | | | | | R:?? |
| Dd,1Fh | READ24 | Data[7:0] | | | | | | | | R:?? |

Note

20. Host Access is AB:XY

where:

AB = Read/Write access for the register

XY = Initial value of register on device power-on

For example:

RW:00 = The register is both Read/Write accessible, with initial value 00h.

R:A1 = The register is Read only, with initial value A1h.

#:?? = The register is reserved (no definite value stored)

The shaded areas represent reserved register bits.

5.1 HOST_MODE

Host Mode register

Individual Register Names and Addresses:

HOST_MODE: Dd, 00h

| | | | | | | | | |
|------------|-------------------|-------------------|-------------------|-------------------|---|---|------------------|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | RW: 0 | RW: 0 | RW: 0 | RW: 0 | | | RW: 4 | |
| Bit Name | Host Control GPO3 | Host Control GPO2 | Host Control GPO1 | Host Control GPO0 | | | Device Mode[2:0] | |

This register is used to control the logic levels of the host control GPOs, and decide the device operating mode.

| Bit | Name | Description |
|---------------|-------------------|--|
| 7 | Host Control GPO3 | This bit controls the logic level of the host control GPO3 |
| | | 0 Host control GPO3 is driven logic low |
| | | 1 Host control GPO3 is driven logic high |
| 6 | Host Control GPO2 | This bit controls the logic level of the host control GPO2 |
| | | 0 Host control GPO2 is driven logic low |
| | | 1 Host control GPO2 is driven logic high |
| 5 | Host Control GPO1 | This bit controls the logic level of the host control GPO1 |
| | | 0 Host control GPO1 is driven logic low |
| | | 1 Host control GPO1 is driven logic high |
| 4 | Host Control GPO0 | This bit controls the logic level of the host control GPO0 |
| | | 0 Host control GPO0 is driven logic low |
| | | 1 Host control GPO0 is driven logic high |
| 2:0 | Device Mode | These bits decide the CapSense controller device mode |
| | | 000 Operating mode |
| | | 001 LED configuration mode |
| | | 010 Device configuration mode |
| | | 011 Production line test mode |
| | | 100 Debug Data mode |
| | | 101 Not valid |
| | | 110 Not valid |
| 111 Not valid | | |

5.2 BUTTON_NUMBER

Start Button Number of Debug Data register

Individual Register Names and Addresses:

BUTTON_NUMBER: Dd, 01h

| | | | | | | | | |
|------------|---|---|---|---|---|-------------|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | | | RW: 00 | | |
| Bit Name | | | | | | Button[4:0] | | |

This register decides the start button number from which the data in registers 0x07-0x1F are filled. For example, if the button number is selected to '4' and the parameter (register no 0x02) is selected to raw count, then from register 0x07 raw count of buttons CS4, CS5, CS6, CS7, CS8, and CS9 are filled (assumption is all buttons are enabled).

5.3 PARAMETER

Parameter of Debug Data register

Individual Register Names and Addresses:

PARAMETER: Dd, 02h

| | | | | | | | | |
|------------|---|---|---|---|---|----------------|---|---|
| | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | | | RW: 00 | | |
| Bit Name | | | | | | Parameter[2:0] | | |

This register decides the type of data that is filled from register 0x07. For example, if the button number is selected to '4' and the parameter (register no 0x02) is selected to raw count, then from register 0x07 the raw count of buttons CS4, CS5, CS6, CS7, CS8, and CS9 are filled (the assumption is all buttons are enabled).

| Parameter[2:0] | Parameter | Bytes Taken for Each Button |
|----------------|--|-----------------------------|
| 0 | C _P | 1 |
| 1 | Raw Counts (RC) | 2 |
| 2 | Difference Counts (Dif) | 2 |
| 3 | Raw Counts (RC), Base Line (BL) | 2 + 2 = 4 |
| 4 | All parameters of one button (RC, BL, DIF, C _P , SNR) | 2 + 2 + 2 + 1 + 1 = 8 |

For example, if the button number (register number 0x01) is selected to '3' and parameter is selected to Dif, then the Difference counts of the buttons CS3, CS4, CS5, CS6, CS7, CS8, and CS9 (assuming all the buttons are enabled) are filled sequentially from register 0x07 to 0x14 with MSB filled first, followed by LSB (since Dif data is of two bytes for each button). The following table shows how the registers are filled in this case.

| Register | Register Name | Value Written to Register |
|----------|---------------|---------------------------|
| 0x07 | Read0 | DIF3_MSB |
| 0x08 | Read1 | DIF3_LSB |
| 0x09 | Read2 | DIF4_MSB |
| 0x0A | Read3 | DIF4_LSB |
| 0x0B | Read4 | DIF5_MSB |
| 0x0C | Read5 | DIF5_LSB |
| 0x0D | Read6 | DIF6_MSB |
| 0x0E | Read7 | DIF6_LSB |
| 0x0F | Read8 | DIF7_MSB |

| Register | Register Name | Value Written to Register |
|----------|---------------|---------------------------|
| 0x10 | Read9 | DIF7_LSB |
| 0x11 | Read10 | DIF8_MSB |
| 0x12 | Read11 | DIF8_LSB |
| 0x13 | Read12 | DIF9_MSB |
| 0x14 | Read13 | DIF9_LSB |

There are 25 debug data read registers (0x07-0x1F). Hence, 25 bytes of space is available for one single read. Therefore, if the parameter 3 is selected, the Raw Count and Baseline data of a maximum of six buttons can be read at a time. If there are ten buttons enabled in the design, then the host needs to read CS0 - CS5 first, and then change the button number (register number 0x01) to '6' and read CS6 - CS9 information.

If parameter 4 is selected, all the parameters (Raw Count, Baseline, Difference Count, Parasitic Capacitance, and SNR) of the selected button (from register 0x01) are written sequentially into the debug data read registers.

5.4 BUTTON_CURRENT_STATx

CapSense Button Current status registers

Individual Register Names and Addresses:

| BUTTON_CURRENT_STAT0: Dd, 04h | | | | BUTTON_CURRENT_STAT1: Dd, 05h | | | | |
|-------------------------------|------|------|------|-------------------------------|------|------|------|------|
| BUTTON_CURRENT_STAT0 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 | R: 0 |
| Bit Name | CS7 | CS6 | CS5 | CS4 | CS3 | CS2 | CS1 | CS0 |
| BUTTON_CURRENT_STAT1 | 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |
| Access: FD | | | | | | | R: 0 | R: 0 |
| Bit Name | | | | | | | CS9 | CS8 |

Reading from these registers give the button ON/OFF status.

| Bit | Name | Description |
|-----|------|--|
| x | CSx | This bit gives the button ON/OFF status 0 Button OFF 1 Button ON |

Acronyms

| Acronym | Description |
|----------------|-----------------------------|
| AC | alternating current |
| AI | analog input |
| AIO | analog input/output |
| AIDO | analog input/digital output |
| ARST | Auto Reset |
| DI | digital input |
| DO | digital output |
| DIO | digital input/output |
| P | power pins |
| C _F | finger capacitance |
| C _P | parasitic capacitance |
| CS | CapSense |
| FSS | flanking sensor suppression |
| GPO | general purpose output |
| I/O | input/output |
| LED | light emitting diode |
| LSB | least significant bit |
| MSB | most significant bit |
| PCB | printed circuit board |
| POR | power-on reset |
| POST | power on self test |
| QFN | quad flat no-lead |
| RF | radio frequency |
| SNR | signal to noise ratio |

Document Conventions

Units of Measure

| Units | Description |
|-------|---|
| °C | degree Celsius |
| kΩ | kilohm |
| μA | microampere |
| μs | microsecond |
| mA | milliampere |
| mm | millimeter |
| mil | one thousandth of an inch (1 mil = 0.0254 mm) |
| ms | millisecond |
| mV | millivolt |
| nA | nanoampere |
| nF | nanofarad |
| ns | nanosecond |
| Ω | ohm |
| % | percent |
| pF | picofarad |
| V | volts |

Numeric Naming

Hexadecimal numbers are represented with all letters in uppercase with an appended lowercase 'h' (for example, '14h' or '3Ah'). Hexadecimal numbers may also be represented by a '0x' prefix, the C coding convention. Binary numbers have an appended lowercase 'b' (for example, '01010100b' or '01000011b'). Numbers not indicated by an 'h', 'b', or '0x' are decimal.

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|--|---------|-----------------|-----------------|---|
| Revision | ECN | Orig. of Change | Submission Date | Description of Change |
| ** | 3698907 | UDYG | 07/31/2012 | New datasheet |
| *A | 3733388 | UDYG | 09/04/2012 | Language edits. FMEA feature - required button resistance mentioned EZ-Click hyperlink fixed Move datasheet to final version |
| *B | 3959454 | SEEE | 04/09/2013 | Updated Configuring the CY8CMBR2110 (Added Configuring the Device using a Host Processor and Third-party Programmer). Updated Package Information : spec 001-42168 – Changed revision from *D to *E. |
| *C | 4888521 | DIMA | 08/18/2015 | Updated to new template. Completing Sunset Review. |
| *D | 5734095 | AESATMP7 | 05/12/2017 | Updated Cypress Logo and Copyright. |

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